



## XC5200 Series Field Programmable Gate Arrays

November 5, 1998 (Version 5.2)

Product Specification

### Features

- Low-cost, register/latch rich, SRAM based reprogrammable architecture
  - 0.5µm three-layer metal CMOS process technology
  - 256 to 1936 logic cells (3,000 to 23,000 "gates")
  - Price competitive with Gate Arrays
- System Level Features
  - System performance beyond 50 MHz
  - 6 levels of interconnect hierarchy
  - VersaRing™ I/O Interface for pin-locking
  - Dedicated carry logic for high-speed arithmetic functions
  - Cascade chain for wide input functions
  - Built-in IEEE 1149.1 JTAG boundary scan test circuitry on all I/O pins
  - Internal 3-state bussing capability
  - Four dedicated low-skew clock or signal distribution nets
- Versatile I/O and Packaging
  - Innovative VersaRing™ I/O interface provides a high logic cell to I/O ratio, with up to 244 I/O signals
  - Programmable output slew-rate control maximizes performance and reduces noise
  - Zero Flip-Flop hold time for input registers simplifies system timing
  - Independent Output Enables for external bussing

- Footprint compatibility in common packages within the XC5200 Series and with the XC4000 Series
- Over 150 device/package combinations, including advanced BGA, TQ, and VQ packaging available
- Fully Supported by Xilinx Development System
  - Automatic place and route software
  - Wide selection of PC and Workstation platforms
  - Over 100 3rd-party Alliance interfaces
  - Supported by shrink-wrap Foundation software

### Description

The XC5200 Field-Programmable Gate Array Family is engineered to deliver low cost. Building on experiences gained with three previous successful SRAM FPGA families, the XC5200 family brings a robust feature set to programmable logic design. The VersaBlock™ logic module, the VersaRing I/O interface, and a rich hierarchy of interconnect resources combine to enhance design flexibility and reduce time-to-market. Complete support for the XC5200 family is delivered through the familiar Xilinx software environment. The XC5200 family is fully supported on popular workstation and PC platforms. Popular design entry methods are fully supported, including ABEL, schematic capture, VHDL, and Verilog HDL synthesis. Designers utilizing logic synthesis can use their existing tools to design with the XC5200 devices.

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**Table 1: XC5200 Field-Programmable Gate Array Family Members**

| Device             | XC5202        | XC5204        | XC5206         | XC5210          | XC5215          |
|--------------------|---------------|---------------|----------------|-----------------|-----------------|
| Logic Cells        | 256           | 480           | 784            | 1,296           | 1,936           |
| Max Logic Gates    | 3,000         | 6,000         | 10,000         | 16,000          | 23,000          |
| Typical Gate Range | 2,000 - 3,000 | 4,000 - 6,000 | 6,000 - 10,000 | 10,000 - 16,000 | 15,000 - 23,000 |
| VersaBlock Array   | 8 x 8         | 10 x 12       | 14 x 14        | 18 x 18         | 22 x 22         |
| CLBs               | 64            | 120           | 196            | 324             | 484             |
| Flip-Flops         | 256           | 480           | 784            | 1,296           | 1,936           |
| I/Os               | 84            | 124           | 148            | 196             | 244             |
| TBUFs per Longline | 10            | 14            | 16             | 20              | 24              |

### XC5200 Family Compared to XC4000/Spartan™ and XC3000 Series

For readers already familiar with the XC4000/Spartan and XC3000 FPGA Families, this section describes significant differences between them and the XC5200 family. Unless otherwise indicated, comparisons refer to both XC4000/Spartan and XC3000 devices.

#### Configurable Logic Block (CLB) Resources

Each XC5200 CLB contains four independent 4-input function generators and four registers, which are configured as four independent Logic Cells™ (LCs). The registers in each XC5200 LC are optionally configurable as edge-triggered D-type flip-flops or as transparent level-sensitive latches.

The XC5200 CLB includes dedicated carry logic that provides fast arithmetic carry capability. The dedicated carry logic may also be used to cascade function generators for implementing wide arithmetic functions.

*XC4000 family:* XC5200 devices have no wide edge decoders. Wide decoders are implemented using cascade logic. Although sacrificing speed for some designs, lack of wide edge decoders reduces the die area and hence cost of the XC5200.

*XC4000/Spartan family:* XC5200 dedicated carry logic differs from that of the XC4000/Spartan family in that the sum is generated in an additional function generator in the adjacent column. This design reduces XC5200 die size and hence cost for many applications. Note, however, that a loadable up/down counter requires the same number of function generators in both families. XC3000 has no dedicated carry.

*XC4000/Spartan family:* XC5200 lookup tables are optimized for cost and hence cannot implement RAM.

#### Input/Output Block (IOB) Resources

The XC5200 family maintains footprint compatibility with the XC4000 family, but not with the XC3000 family.

To minimize cost and maximize the number of I/O per Logic Cell, the XC5200 I/O does not include flip-flops or latches.

For high performance paths, the XC5200 family provides direct connections from each IOB to the registers in the adjacent CLB in order to emulate IOB registers.

Each XC5200 I/O Pin provides a programmable delay element to control input set-up time. This element can be used to avoid potential hold-time problems. Each XC5200 I/O Pin is capable of 8-mA source and sink currents.

IEEE 1149.1-type boundary scan is supported in each XC5200 I/O.

**Table 2: Xilinx Field-Programmable Gate Array Families**

| Parameter               | XC5200 | Spartan | XC4000 | XC3000 |
|-------------------------|--------|---------|--------|--------|
| CLB function generators | 4      | 3       | 3      | 2      |
| CLB inputs              | 20     | 9       | 9      | 5      |
| CLB outputs             | 12     | 4       | 4      | 2      |
| Global buffers          | 4      | 8       | 8      | 2      |
| User RAM                | no     | yes     | yes    | no     |
| Edge decoders           | no     | no      | yes    | no     |
| Cascade chain           | yes    | no      | no     | no     |
| Fast carry logic        | yes    | yes     | yes    | no     |
| Internal 3-state        | yes    | yes     | yes    | yes    |
| Boundary scan           | yes    | yes     | yes    | no     |
| Slew-rate control       | yes    | yes     | yes    | yes    |

#### Routing Resources

The XC5200 family provides a flexible coupling of logic and local routing resources called the VersaBlock. The XC5200 VersaBlock element includes the CLB, a Local Interconnect Matrix (LIM), and direct connects to neighboring VersaBlocks.

The XC5200 provides four global buffers for clocking or high-fanout control signals. Each buffer may be sourced by means of its dedicated pad or from any internal source.

Each XC5200 TBUF can drive up to two horizontal and two vertical Longlines. There are no internal pull-ups for XC5200 Longlines.

#### Configuration and Readback

The XC5200 supports a new configuration mode called Express mode.

*XC4000/Spartan family:* The XC5200 family provides a global reset but not a global set.

XC5200 devices use a different configuration process than that of the XC3000 family, but use the same process as the XC4000 and Spartan families.

*XC3000 family:* Although their configuration processes differ, XC5200 devices may be used in daisy chains with XC3000 devices.

*XC3000 family:* The XC5200 PROGRAM pin is a single-function input pin that overrides all other inputs. The PROGRAM pin does not exist in XC3000.

**XC3000 family:** XC5200 devices support an additional programming mode: Peripheral Synchronous.

**XC3000 family:** The XC5200 family does not support Power-down, but offers a Global 3-state input that does not reset any flip-flops.

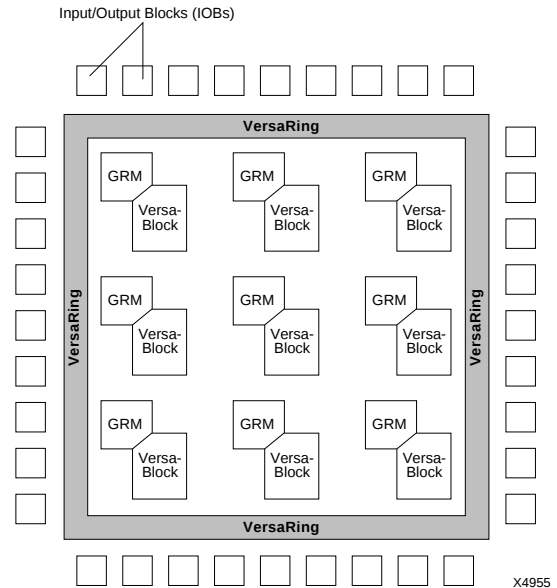
**XC3000 family:** The XC5200 family does not provide an on-chip crystal oscillator amplifier, but it does provide an internal oscillator from which a variety of frequencies up to 12 MHz are available.

## Architectural Overview

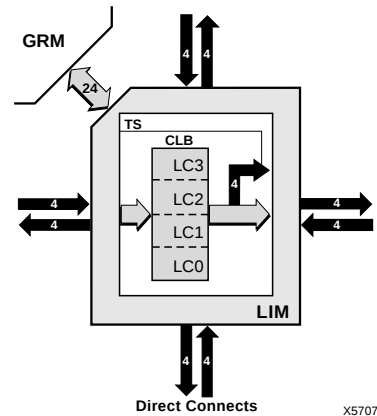
**Figure 1** presents a simplified, conceptual overview of the XC5200 architecture. Similar to conventional FPGAs, the XC5200 family consists of programmable IOBs, programmable logic blocks, and programmable interconnect. Unlike other FPGAs, however, the logic and local routing resources of the XC5200 family are combined in flexible VersaBlocks (**Figure 2**). General-purpose routing connects to the VersaBlock through the General Routing Matrix (GRM).

### VersaBlock: Abundant Local Routing Plus Versatile Logic

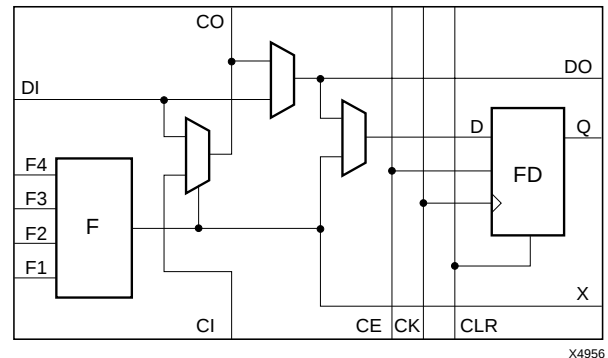
The basic logic element in each VersaBlock structure is the Logic Cell, shown in **Figure 3**. Each LC contains a 4-input function generator (F), a storage device (FD), and control logic. There are five independent inputs and three outputs to each LC. The independence of the inputs and outputs allows the software to maximize the resource utilization within each LC. Each Logic Cell also contains a direct feedthrough path that does not sacrifice the use of either the function generator or the register; this feature is a first for FPGAs. The storage device is configurable as either a D flip-flop or a latch. The control logic consists of carry logic for fast implementation of arithmetic functions, which can also be configured as a cascade chain allowing decode of very wide input functions.



**Figure 1: XC5200 Architectural Overview**

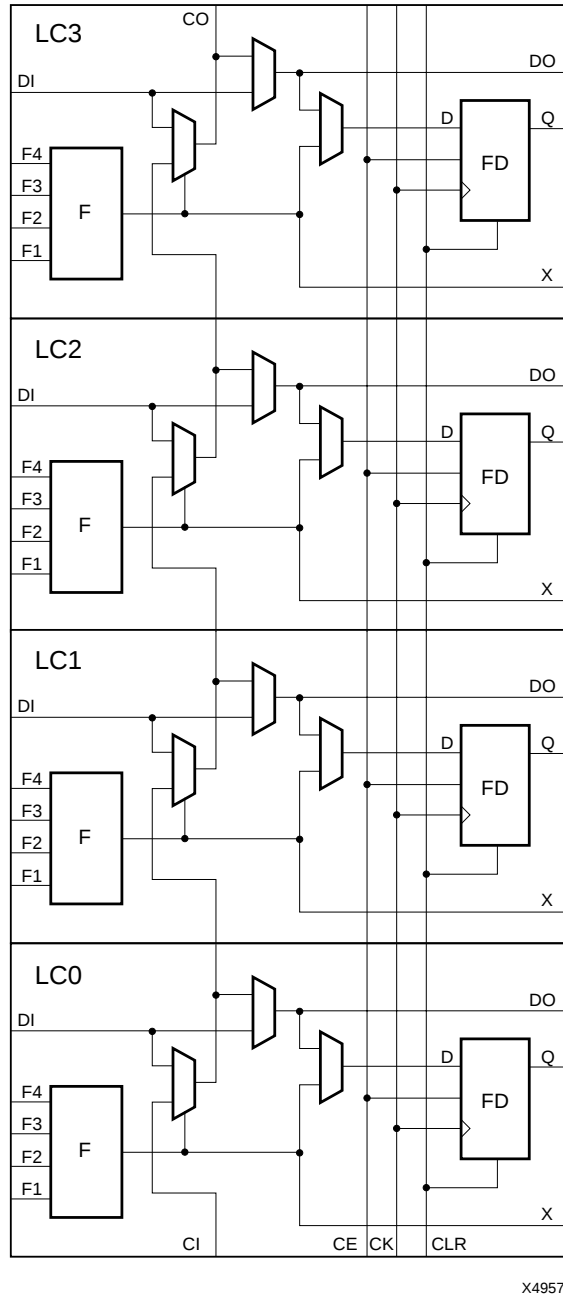


**Figure 2: VersaBlock**



**Figure 3: XC5200 Logic Cell (Four LCs per CLB)**

The XC5200 CLB consists of four LCs, as shown in [Figure 4](#). Each CLB has 20 independent inputs and 12 independent outputs. The top and bottom pairs of LCs can be configured to implement 5-input functions. The challenge of FPGA implementation software has always been to maximize the usage of logic resources. The XC5200 family addresses this issue by surrounding each CLB with two types of local interconnect — the Local Interconnect Matrix (LIM) and direct connects. These two interconnect resources, combined with the CLB, form the VersaBlock, represented in [Figure 2](#).



**Figure 4: Configurable Logic Block**

The LIM provides 100% connectivity of the inputs and outputs of each LC in a given CLB. The benefit of the LIM is that no general routing resources are required to connect feedback paths within a CLB. The LIM connects to the GRM via 24 bidirectional nodes.

The direct connects allow immediate connections to neighboring CLBs, once again without using any of the general interconnect. These two layers of local routing resource improve the granularity of the architecture, effectively making the XC5200 family a “sea of logic cells.” Each Versa-Block has four 3-state buffers that share a common enable line and directly drive horizontal and vertical Longlines, creating robust on-chip bussing capability. The VersaBlock allows fast, local implementation of logic functions, effectively implementing user designs in a hierarchical fashion. These resources also minimize local routing congestion and improve the efficiency of the general interconnect, which is used for connecting larger groups of logic. It is this combination of both fine-grain and coarse-grain architecture attributes that maximize logic utilization in the XC5200 family. This symmetrical structure takes full advantage of the third metal layer, freeing the placement software to pack user logic optimally with minimal routing restrictions.

### VersaRing I/O Interface

The interface between the IOBs and core logic has been redesigned in the XC5200 family. The IOBs are completely decoupled from the core logic. The XC5200 IOBs contain dedicated boundary-scan logic for added board-level testability, but do not include input or output registers. This approach allows a maximum number of IOBs to be placed around the device, improving the I/O-to-gate ratio and decreasing the cost per I/O. A “freeway” of interconnect cells surrounding the device forms the VersaRing, which provides connections from the IOBs to the internal logic. These incremental routing resources provide abundant connections from each IOB to the nearest VersaBlock, in addition to Longline connections surrounding the device. The VersaRing eliminates the historic trade-off between high logic utilization and pin placement flexibility. These incremental edge resources give users increased flexibility in preassigning (i.e., locking) I/O pins before completing their logic designs. This ability accelerates time-to-market, since PCBs and other system components can be manufactured concurrent with the logic design.

### General Routing Matrix

The GRM is functionally similar to the switch matrices found in other architectures, but it is novel in its tight coupling to the logic resources contained in the VersaBlocks. Advanced simulation tools were used during the development of the XC5200 architecture to determine the optimal level of routing resources required. The XC5200 family contains six levels of interconnect hierarchy — a series of

single-length lines, double-length lines, and Longlines all routed through the GRM. The direct connects, LIM, and logic-cell feedthrough are contained within each Versa-Block. Throughout the XC5200 interconnect, an efficient multiplexing scheme, in combination with three layer metal (TLM), was used to improve the overall efficiency of silicon usage.

### Performance Overview

The XC5200 family has been benchmarked with many designs running synchronous clock rates beyond 66 MHz. The performance of any design depends on the circuit to be implemented, and the delay through the combinatorial and sequential logic elements, plus the delay in the interconnect routing. A rough estimate of timing can be made by assuming 3-6 ns per logic level, which includes direct-connect routing delays, depending on speed grade. More accurate estimations can be made using the information in the Switching Characteristic Guideline section.

### Taking Advantage of Reconfiguration

FPGA devices can be reconfigured to change logic function while resident in the system. This capability gives the system designer a new degree of freedom not available with any other type of logic.

Hardware can be changed as easily as software. Design updates or modifications are easy, and can be made to products already in the field. An FPGA can even be reconfigured dynamically to perform different functions at different times.

Reconfigurable logic can be used to implement system self-diagnostics, create systems capable of being reconfigured for different environments or operations, or implement multi-purpose hardware for a given application. As an added benefit, using reconfigurable FPGA devices simplifies hardware design and debugging and shortens product time-to-market.

## Detailed Functional Description

### Configurable Logic Blocks (CLBs)

Figure 4 shows the logic in the XC5200 CLB, which consists of four Logic Cells (LC[3:0]). Each Logic Cell consists of an independent 4-input Lookup Table (LUT), and a D-Type flip-flop or latch with common clock, clock enable, and clear, but individually selectable clock polarity. Additional logic features provided in the CLB are:

- An independent 5-input LUT by combining two 4-input LUTs.
- High-speed carry propagate logic.
- High-speed pattern decoding.
- High-speed direct connection to flip-flop D-inputs.
- Individual selection of either a transparent, level-sensitive latch or a D flip-flop.
- Four 3-state buffers with a shared Output Enable.

### 5-Input Functions

Figure 5 illustrates how the outputs from the LUTs from LC0 and LC1 can be combined with a 2:1 multiplexer (F5\_MUX) to provide a 5-input function. The outputs from the LUTs of LC2 and LC3 can be similarly combined.

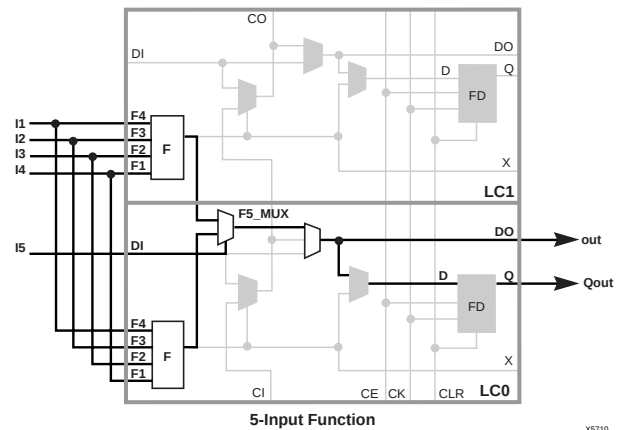
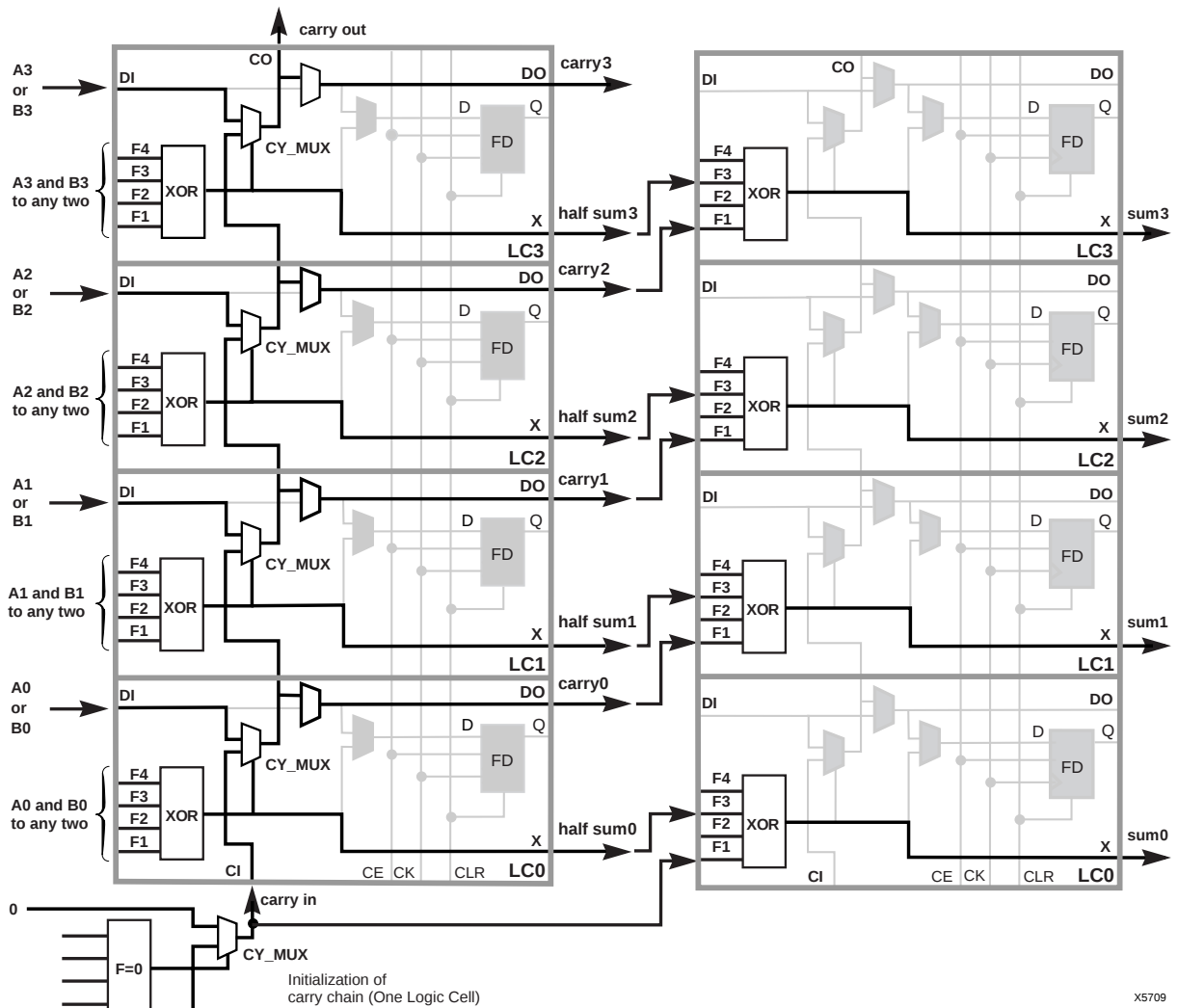


Figure 5: Two LUTs in Parallel Combined to Create a 5-input Function



X5709

**Figure 6: XC5200 CY\_MUX Used for Adder Carry Propagate**

### Carry Function

The XC5200 family supports a carry-logic feature that enhances the performance of arithmetic functions such as counters, adders, etc. A carry multiplexer (CY\_MUX) symbol is used to indicate the XC5200 carry logic. This symbol represents the dedicated 2:1 multiplexer in each LC that performs the one-bit high-speed carry propagate per logic cell (four bits per CLB).

While the carry propagate is performed inside the LC, an adjacent LC must be used to complete the arithmetic function. **Figure 6** represents an example of an adder function. The carry propagate is performed on the CLB shown,

which also generates the half-sum for the four-bit adder. An adjacent CLB is responsible for XORing the half-sum with the corresponding carry-out. Thus an adder or counter requires two LCs per bit. Notice that the carry chain requires an initialization stage, which the XC5200 family accomplishes using the carry initialize (CY\_INIT) macro and one additional LC. The carry chain can propagate vertically up a column of CLBs.

The XC5200 library contains a set of Relationally-Placed Macros (RPMs) and arithmetic functions designed to take advantage of the dedicated carry logic. Using and modifying these macros makes it much easier to implement cus-

tomized RPMs, freeing the designer from the need to become an expert on architectures.

results or other incoming data in flip-flops, and connect their outputs to the interconnect network as well. The CLB storage elements can also be configured as latches.

**Table 3: CLB Storage Element Functionality (active rising edge is shown)**

| Mode           | CK | CE | CLR | D | Q |
|----------------|----|----|-----|---|---|
| Power-Up or GR | X  | X  | X   | X | 0 |
| Flip-Flop      | X  | X  | 1   | X | 0 |
|                | —/ | 1* | 0*  | D | D |
| Latch          | 1  | 1* | 0*  | X | Q |
|                | 0  | 1* | 0*  | D | D |
| Both           | X  | 0  | 0*  | X | Q |

Legend:

X Don't care  
 —/ Rising edge  
 0\* Input is Low or unconnected (default value)  
 1\* Input is High or unconnected (default value)

### Data Inputs and Outputs

The source of a storage element data input is programmable. It is driven by the function F, or by the Direct In (DI) block input. The flip-flops or latches drive the Q CLB outputs.

Four fast feed-through paths from DI to DO are available, as shown in Figure 4. This bypass is sometimes used by the automated router to repower internal signals. In addition to the storage element (Q) and direct (DO) outputs, there is a combinatorial output (X) that is always sourced by the Lookup Table.

The four edge-triggered D-type flip-flops or level-sensitive latches have common clock (CK) and clock enable (CE) inputs. Any of the clock inputs can also be permanently enabled. Storage element functionality is described in Table 3.

### Clock Input

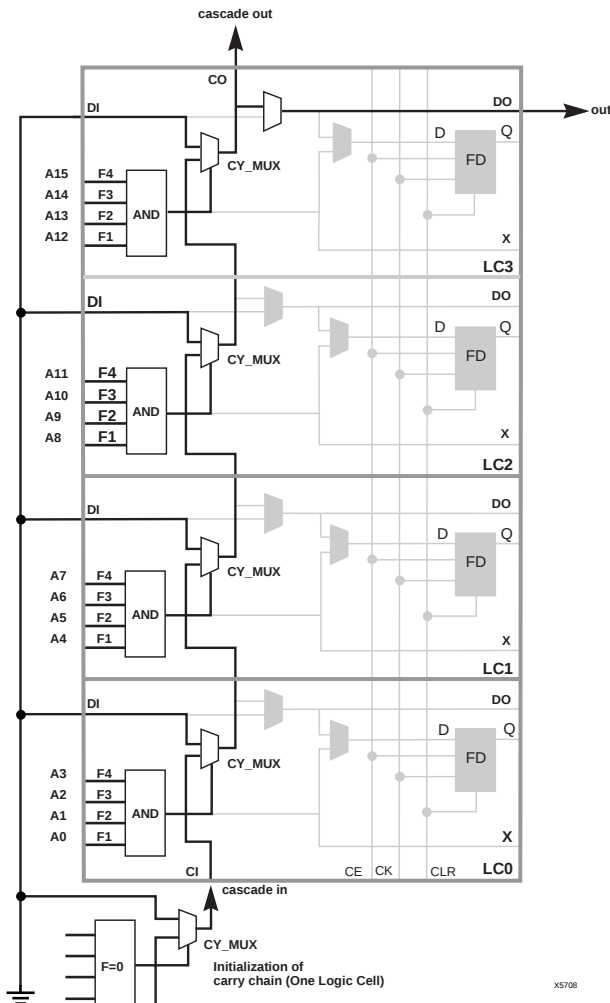
The flip-flops can be triggered on either the rising or falling clock edge. The clock pin is shared by all four storage elements with individual polarity control. Any inverter placed on the clock input is automatically absorbed into the CLB.

### Clock Enable

The clock enable signal (CE) is active High. The CE pin is shared by the four storage elements. If left unconnected for any, the clock enable for that storage element defaults to the active state. CE is not invertible within the CLB.

### Clear

An asynchronous storage element input (CLR) can be used to reset all four flip-flops or latches in the CLB. This input



**Figure 7: XC5200 CY\_MUX Used for Decoder Cascade Logic**

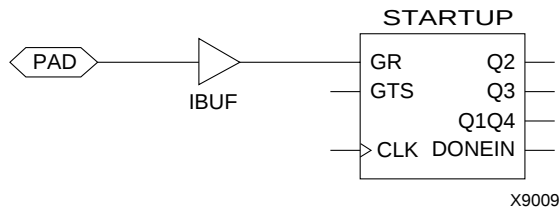
### Cascade Function

Each CY\_MUX can be connected to the CY\_MUX in the adjacent LC to provide cascaded decode logic. Figure 7 illustrates how the 4-input function generators can be configured to take advantage of these four cascaded CY\_MUXes. Note that AND and OR cascading are specific cases of a general decode. In AND cascading all bits are decoded equal to logic one, while in OR cascading all bits are decoded equal to logic zero. The flexibility of the LUT achieves this result. The XC5200 library contains gate macros designed to take advantage of this function.

### CLB Flip-Flops and Latches

The CLB can pass the combinatorial output(s) to the interconnect network, but can also store the combinatorial

can also be independently disabled for any flip-flop. CLR is active High. It is not invertible within the CLB.



**Figure 8: Schematic Symbols for Global Reset**

### Global Reset

A separate Global Reset line clears each storage element during power-up, reconfiguration, or when a dedicated Reset net is driven active. This global net (GR) does not compete with other routing resources; it uses a dedicated distribution network.

GR can be driven from any user-programmable pin as a global reset input. To use this global net, place an input pad and input buffer in the schematic or HDL code, driving the GR pin of the STARTUP symbol. (See [Figure 9](#).) A specific pin location can be assigned to this input using a LOC attribute or property, just as with any other user-programmable pad. An inverter can optionally be inserted after the input buffer to invert the sense of the Global Reset signal. Alternatively, GR can be driven from any internal node.

### Using FPGA Flip-Flops and Latches

The abundance of flip-flops in the XC5200 Series invites pipelined designs. This is a powerful way of increasing performance by breaking the function into smaller subfunctions and executing them in parallel, passing on the results through pipeline flip-flops. This method should be seriously considered wherever throughput is more important than latency.

To include a CLB flip-flop, place the appropriate library symbol. For example, FDCE is a D-type flip-flop with clock enable and asynchronous clear. The corresponding latch symbol is called LDCE.

In XC5200-Series devices, the flip-flops can be used as registers or shift registers without blocking the function generators from performing a different, perhaps unrelated task. This ability increases the functional capacity of the devices.

The CLB setup time is specified between the function generator inputs and the clock input CK. Therefore, the specified CLB flip-flop setup time includes the delay through the function generator.

### Three-State Buffers

The XC5200 family has four dedicated Three-State Buffers (TBUFs, or BUFTs in the schematic library) per CLB (see [Figure 9](#)). The four buffers are individually configurable through four configuration bits to operate as simple non-inverting buffers or in 3-state mode. When in 3-state mode the CLB output enable (TS) control signal drives the enable to all four buffers. Each TBUF can drive up to two horizontal and/or two vertical Longlines. These 3-state buffers can be used to implement multiplexed or bidirectional buses on the horizontal or vertical longlines, saving logic resources.

The 3-state buffer enable is an active-High 3-state (i.e. an active-Low enable), as shown in [Table 4](#).

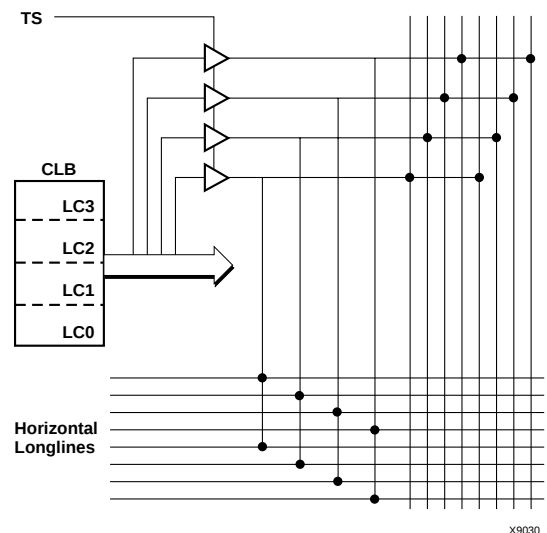
**Table 4: Three-State Buffer Functionality**

| IN | T | OUT |
|----|---|-----|
| X  | 1 | Z   |
| IN | 0 | IN  |

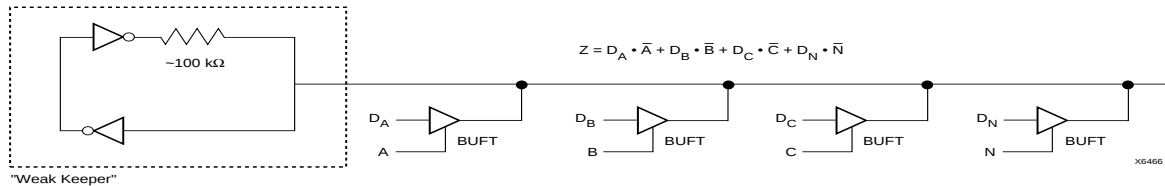
Another 3-state buffer with similar access is located near each I/O block along the right and left edges of the array.

The longlines driven by the 3-state buffers have a weak keeper at each end. This circuit prevents undefined floating levels. However, it is overridden by any driver. To ensure the longline goes high when no buffers are on, add an additional BUFT to drive the output High during all of the previously undefined states.

[Figure 10](#) shows how to use the 3-state buffers to implement a multiplexer. The selection is accomplished by the buffer 3-state signal.



**Figure 9: XC5200 3-State Buffers**

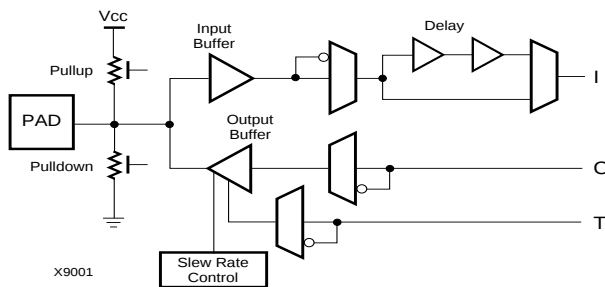


**Figure 10: 3-State Buffers Implement a Multiplexer**

### Input/Output Blocks

User-configurable input/output blocks (IOBs) provide the interface between external package pins and the internal logic. Each IOB controls one package pin and can be configured for input, output, or bidirectional signals.

The I/O block, shown in [Figure 11](#), consists of an input buffer and an output buffer. The output driver is an 8-mA full-rail CMOS buffer with 3-state control. Two slew-rate control modes are supported to minimize bus transients. Both the output buffer and the 3-state control are invertible. The input buffer has globally selected CMOS or TTL input thresholds. The input buffer is invertible and also provides a programmable delay line to assure reliable chip-to-chip set-up and hold times. Minimum ESD protection is 3 kV using the Human Body Model.



**Figure 11: XC5200 I/O Block**

### IOB Input Signals

The XC5200 inputs can be globally configured for either TTL (1.2V) or CMOS thresholds, using an option in the bit-stream generation software. There is a slight hysteresis of about 300mV.

The inputs of XC5200-Series 5-Volt devices can be driven by the outputs of any 3.3-Volt device, if the 5-Volt inputs are in TTL mode.

Supported sources for XC5200-Series device inputs are shown in [Table 5](#).

**Table 5: Supported Sources for XC5200-Series Device Inputs**

| Source                                | XC5200 Input Mode |                 |
|---------------------------------------|-------------------|-----------------|
|                                       | 5 V, TTL          | 5 V, CMOS       |
| Any device, Vcc = 3.3 V, CMOS outputs | ✓                 | Unreliable Data |
| Any device, Vcc = 5 V, TTL outputs    | ✓                 |                 |
| Any device, Vcc = 5 V, CMOS outputs   | ✓                 | ✓               |

### Optional Delay Guarantees Zero Hold Time

XC5200 devices do not have storage elements in the IOBs. However, XC5200 IOBs can be efficiently routed to CLB flip-flops or latches to store the I/O signals.

The data input to the register can optionally be delayed by several nanoseconds. With the delay enabled, the setup time of the input flip-flop is increased so that normal clock routing does not result in a positive hold-time requirement. A positive hold time requirement can lead to unreliable, temperature- or processing-dependent operation.

The input flip-flop setup time is defined between the data measured at the device I/O pin and the clock input at the CLB (not at the clock pin). Any routing delay from the device clock pin to the clock input of the CLB must, therefore, be subtracted from this setup time to arrive at the real setup time requirement relative to the device pins. A short specified setup time might, therefore, result in a negative setup time at the device pins, i.e., a positive hold-time requirement.

When a delay is inserted on the data line, more clock delay can be tolerated without causing a positive hold-time requirement. Sufficient delay eliminates the possibility of a data hold-time requirement at the external pin. The maximum delay is therefore inserted as the software default.

The XC5200 IOB has a one-tap delay element: either the delay is inserted (default), or it is not. The delay guarantees a zero hold time with respect to clocks routed through any of the XC5200 global clock buffers. (See ["Global Lines" on page 96](#) for a description of the global clock buffers in the XC5200.) For a shorter input register setup time, with

non-zero hold, attach a NODELAY attribute or property to the flip-flop or input buffer.

### IOB Output Signals

Output signals can be optionally inverted within the IOB, and pass directly to the pad. As with the inputs, a CLB flip-flop or latch can be used to store the output signal.

An active-High 3-state signal can be used to place the output buffer in a high-impedance state, implementing 3-state outputs or bidirectional I/O. Under configuration control, the output (OUT) and output 3-state (T) signals can be inverted. The polarity of these signals is independently configured for each IOB.

The XC5200 devices provide a guaranteed output sink current of 8 mA.

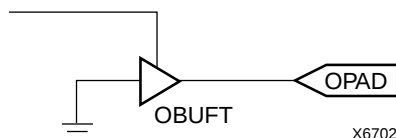
Supported destinations for XC5200-Series device outputs are shown in [Table 6](#). (For a detailed discussion of how to interface between 5 V and 3.3 V devices, see the 3V Products section of *The Programmable Logic Data Book*.)

An output can be configured as open-drain (open-collector) by placing an OBUFT symbol in a schematic or HDL code, then tying the 3-state pin (T) to the output signal, and the input pin (I) to Ground. (See [Figure 12](#).)

**Table 6: Supported Destinations for XC5200-Series Outputs**

| Destination                                                 | XC5200 Output Mode |
|-------------------------------------------------------------|--------------------|
|                                                             | 5 V, CMOS          |
| XC5200 device, $V_{CC}=3.3$ V, CMOS-threshold inputs        | ✓                  |
| Any typical device, $V_{CC} = 3.3$ V, CMOS-threshold inputs | some <sup>1</sup>  |
| Any device, $V_{CC} = 5$ V, TTL-threshold inputs            | ✓                  |
| Any device, $V_{CC} = 5$ V, CMOS-threshold inputs           | ✓                  |

1. Only if destination device has 5-V tolerant inputs



**Figure 12: Open-Drain Output**

### Output Slew Rate

The slew rate of each output buffer is, by default, reduced, to minimize power bus transients when switching non-critical signals. For critical signals, attach a FAST attribute or property to the output buffer or flip-flop.

For XC5200 devices, maximum total capacitive load for simultaneous fast mode switching in the same direction is 200 pF for all package pins between each Power/Ground pin pair. For some XC5200 devices, additional internal Power/Ground pin pairs are connected to special Power and Ground planes within the packages, to reduce ground bounce.

For slew-rate limited outputs this total is two times larger for each device type: 400 pF for XC5200 devices. This maximum capacitive load should not be exceeded, as it can result in ground bounce of greater than 1.5 V amplitude and more than 5 ns duration. This level of ground bounce may cause undesired transient behavior on an output, or in the internal logic. This restriction is common to all high-speed digital ICs, and is not particular to Xilinx or the XC5200 Series.

XC5200-Series devices have a feature called “Soft Start-up,” designed to reduce ground bounce when all outputs are turned on simultaneously at the end of configuration. When the configuration process is finished and the device starts up, the first activation of the outputs is automatically slew-rate limited. Immediately following the initial activation of the I/O, the slew rate of the individual outputs is determined by the individual configuration option for each IOB.

### Global Three-State

A separate Global 3-State line (not shown in [Figure 11](#)) forces all FPGA outputs to the high-impedance state, unless boundary scan is enabled and is executing an EXTEST instruction. This global net (GTS) does not compete with other routing resources; it uses a dedicated distribution network.

GTS can be driven from any user-programmable pin as a global 3-state input. To use this global net, place an input pad and input buffer in the schematic or HDL code, driving the GTS pin of the STARTUP symbol. A specific pin location can be assigned to this input using a LOC attribute or property, just as with any other user-programmable pad. An inverter can optionally be inserted after the input buffer to invert the sense of the Global 3-State signal. Using GTS is similar to Global Reset. See [Figure 8 on page 90](#) for details. Alternatively, GTS can be driven from any internal node.

### Other IOB Options

There are a number of other programmable options in the XC5200-Series IOB.

### Pull-up and Pull-down Resistors

Programmable IOB pull-up and pull-down resistors are useful for tying unused pins to Vcc or Ground to minimize power consumption and reduce noise sensitivity. The configurable pull-up resistor is a p-channel transistor that pulls

to Vcc. The configurable pull-down resistor is an n-channel transistor that pulls to Ground.

The value of these resistors is 20 k $\Omega$  – 100 k $\Omega$ . This high value makes them unsuitable as wired-AND pull-up resistors.

The pull-up resistors for most user-programmable IOBs are active during the configuration process. See [Table 13 on page 124](#) for a list of pins with pull-ups active before and during configuration.

After configuration, voltage levels of unused pads, bonded or unbonded, must be valid logic levels, to reduce noise sensitivity and avoid excess current. Therefore, by default, unused pads are configured with the internal pull-up resistor active. Alternatively, they can be individually configured with the pull-down resistor, or as a driven output, or to be driven by an external source. To activate the internal pull-up, attach the PULLUP library component to the net attached to the pad. To activate the internal pull-down, attach the PULLDOWN library component to the net attached to the pad.

### JTAG Support

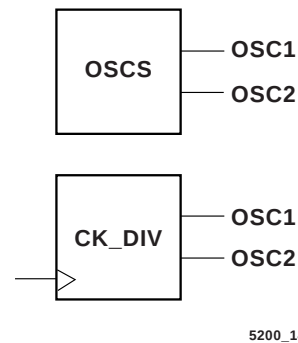
Embedded logic attached to the IOBs contains test structures compatible with IEEE Standard 1149.1 for boundary scan testing, simplifying board-level testing. More information is provided in ["Boundary Scan" on page 98](#).

### Oscillator

XC5200 devices include an internal oscillator. This oscillator is used to clock the power-on time-out, clear configuration memory, and source CCLK in Master configuration modes. The oscillator runs at a nominal 12 MHz frequency that varies with process, Vcc, and temperature. The output CCLK frequency is selectable as 1 MHz (default), 6 MHz, or 12 MHz.

The XC5200 oscillator divides the internal 12-MHz clock or a user clock. The user then has the choice of dividing by 4, 16, 64, or 256 for the "OSC1" output and dividing by 2, 8, 32, 128, 1024, 4096, 16384, or 65536 for the "OSC2" output. The division is specified via a "DIVIDEn\_BY=x" attribute on the symbol, where n=1 for OSC1, or n=2 for OSC2. These frequencies can vary by as much as -50% or + 50%.

The OSC5 macro is used where an internal oscillator is required. The CK\_DIV macro is applicable when a user clock input is specified (see [Figure 13](#)).



**Figure 13: XC5200 Oscillator Macros**

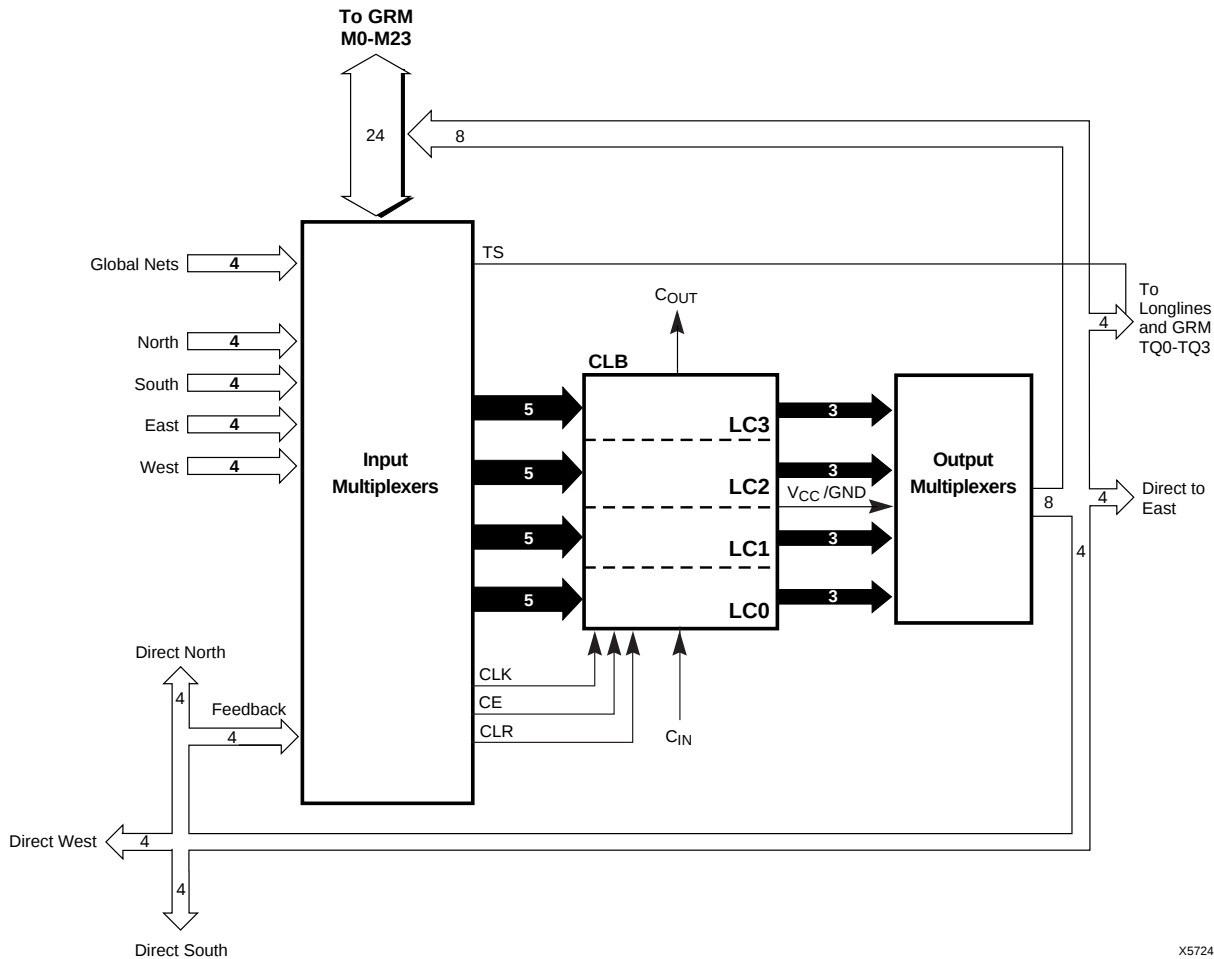
## VersaBlock Routing

The General Routing Matrix (GRM) connects to the VersaBlock via 24 bidirectional ports (M0-M23). Excluding direct connections, global nets, and 3-statable Longlines, all VersaBlock inputs and outputs connect to the GRM via these 24 ports. Four 3-statable unidirectional signals (TQ0-TQ3) drive out of the VersaBlock directly onto the horizontal and vertical Longlines. Two horizontal global nets and two vertical global nets connect directly to every CLB clock pin; they can connect to other CLB inputs via the GRM. Each CLB also has four unidirectional direct connects to each of its four neighboring CLBs. These direct connects can also feed directly back to the CLB (see [Figure 14](#)).

In addition, each CLB has 16 direct inputs, four direct connections from each of the neighboring CLBs. These direct connections provide high-speed local routing that bypasses the GRM.

### Local Interconnect Matrix

The Local Interconnect Matrix (LIM) is built from input and output multiplexers. The 13 CLB outputs (12 LC outputs plus a V<sub>cc</sub>/GND signal) connect to the eight VersaBlock outputs via the output multiplexers, which consist of eight fully populated 13-to-1 multiplexers. Of the eight VersaBlock outputs, four signals drive each neighboring CLB directly, and provide a direct feedback path to the input multiplexers. The four remaining multiplexer outputs can drive the GRM through four TBUFs (TQ0-TQ3). All eight multiplexer outputs can connect to the GRM through the bidirectional M0-M23 signals. All eight signals also connect to the input multiplexers and are potential inputs to that CLB.



X5724

**Figure 14: VersaBlock Details**

CLB inputs have several possible sources: the 24 signals from the GRM, 16 direct connections from neighboring VersaBlocks, four signals from global, low-skew buffers, and the four signals from the CLB output multiplexers. Unlike the output multiplexers, the input multiplexers are not fully populated; i.e., only a subset of the available signals can be connected to a given CLB input. The flexibility of LUT input swapping and LUT mapping compensates for this limitation. For example, if a 2-input NAND gate is required, it can be mapped into any of the four LUTs, and use any two of the four inputs to the LUT.

### Direct Connects

The unidirectional direct-connect segments are connected to the logic input/output pins through the CLB input and output multiplexer arrays, and thus bypass the general routing matrix altogether. These lines increase the routing channel utilization, while simultaneously reducing the delay incurred in speed-critical connections.

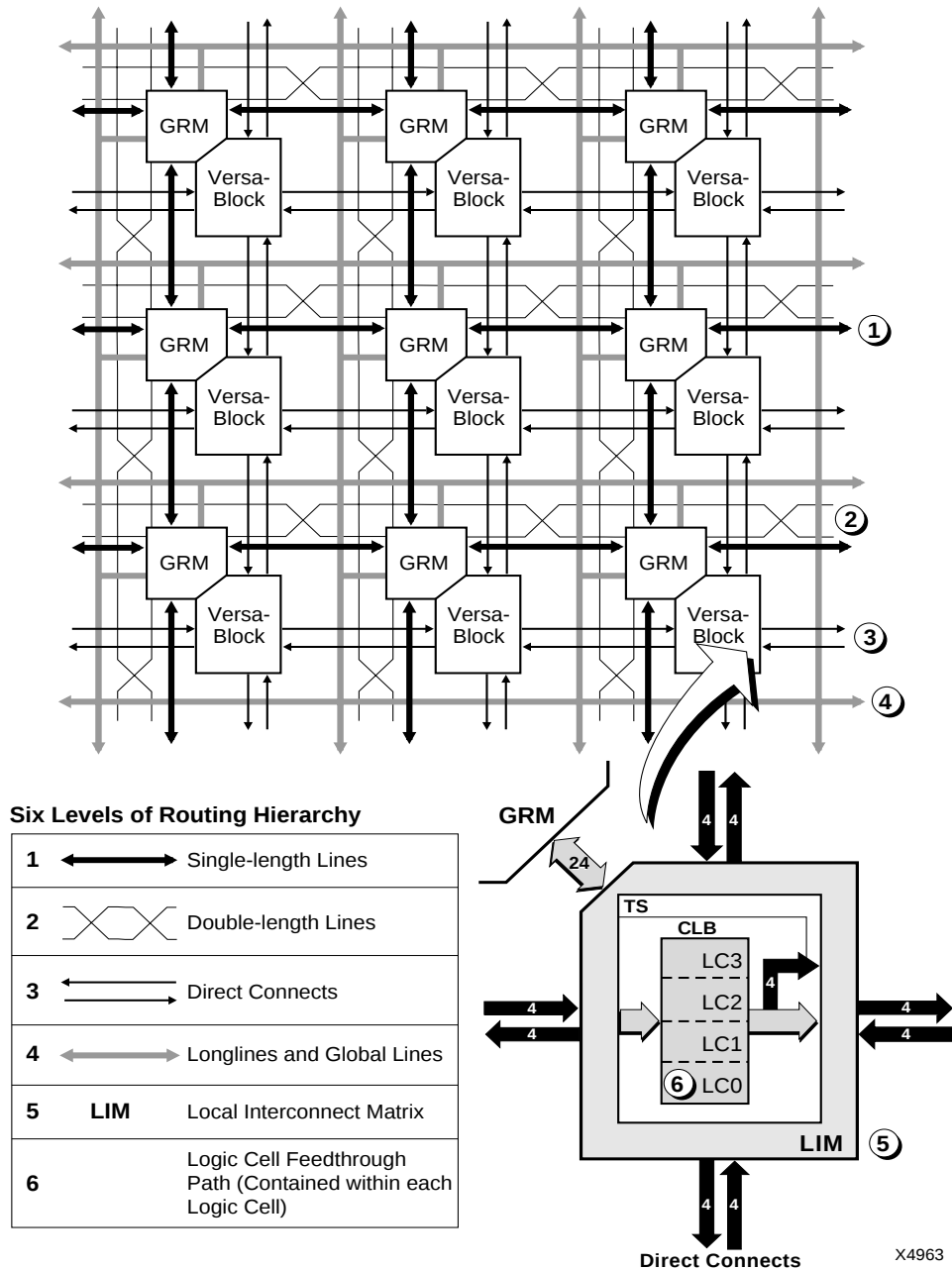
The direct connects also provide a high-speed path from the edge CLBs to the VersaRing input/output buffers, and thus reduce pin-to-pin set-up time, clock-to-out, and combinational propagation delay. Direct connects from the input buffers to the CLB DI pin (direct flip-flop input) are only available on the left and right edges of the device. CLB look-up table inputs and combinational/registered outputs have direct connects to input/output buffers on all four sides.

The direct connects are ideal for developing customized RPM cells. Using direct connects improves the macro performance, and leaves the other routing channels intact for improved routing. Direct connects can also route through a CLB using one of the four cell-feedthrough paths.

### General Routing Matrix

The General Routing Matrix, shown in [Figure 15](#), provides flexible bidirectional connections to the Local Interconnect

Matrix through a hierarchy of different-length metal segments in both the horizontal and vertical directions. A pro-



**Figure 15: XC5200 Interconnect Structure**

programmable interconnect point (PIP) establishes an electrical connection between two wire segments. The PIP, consisting of a pass transistor switch controlled by a memory element, provides bidirectional (in some cases, unidirectional) connection between two adjoining wires. A collection of PIPs inside the General Routing Matrix and in the Local Interconnect Matrix provides connectivity between various types of metal segments. A hierarchy of PIPs and

associated routing segments combine to provide a powerful interconnect hierarchy:

- Forty bidirectional single-length segments per CLB provide ten routing channels to each of the four neighboring CLBs in four directions.
- Sixteen bidirectional double-length segments per CLB provide four routing channels to each of four other (non-neighboring) CLBs in four directions.
- Eight horizontal and eight vertical bidirectional Longline

segments span the width and height of the chip, respectively.

Two low-skew horizontal and vertical unidirectional global-line segments span each row and column of the chip, respectively.

### Single- and Double-Length Lines

The single- and double-length bidirectional line segments make up the bulk of the routing channels. The double-length lines hop across every other CLB to reduce the propagation delays in speed-critical nets. Regenerating the signal strength is recommended after traversing three or four such segments. Xilinx place-and-route software automatically connects buffers in the path of the signal as necessary. Single- and double-length lines cannot drive onto Longlines and global lines; Longlines and global lines can, however, drive onto single- and double-length lines. As a general rule, Longline and global-line connections to the general routing matrix are unidirectional, with the signal direction from these lines toward the routing matrix.

### Longlines

Longlines are used for high-fan-out signals, 3-state busses, low-skew nets, and faraway destinations. Row and column splitter PIPs in the middle of the array effectively double the total number of Longlines by electrically dividing them into two separated half-lines. Longlines are driven by the 3-state buffers in each CLB, and are driven by similar buffers at the periphery of the array from the VersaRing I/O Interface.

Bus-oriented designs are easily implemented by using Longlines in conjunction with the 3-state buffers in the CLB and in the VersaRing. Additionally, weak keeper cells at the periphery retain the last valid logic level on the Longlines when all buffers are in 3-state mode.

Longlines connect to the single-length or double-length lines, or to the logic inside the CLB, through the General Routing Matrix. The only manner in which a Longline can be driven is through the four 3-state buffers; therefore, a Longline-to-Longline or single-line-to-Longline connection through PIPs in the General Routing Matrix is not possible. Again, as a general rule, long- and global-line connections to the General Routing Matrix are unidirectional, with the signal direction from these lines toward the routing matrix.

The XC5200 family has no pull-ups on the ends of the Longlines sourced by TBUFs, unlike the XC4000 Series. Consequently, wired functions (i.e., WAND and WORAND) and wide multiplexing functions requiring pull-ups for undefined states (i.e., bus applications) must be implemented in a different way. In the case of the wired functions, the same functionality can be achieved by taking advantage of the

carry/cascade logic described above, implementing a wide logic function in place of the wired function. In the case of 3-state bus applications, the user must insure that all states of the multiplexing function are defined. This process is as simple as adding an additional TBUF to drive the bus High when the previously undefined states are activated.

### Global Lines

Global buffers in Xilinx FPGAs are special buffers that drive a dedicated routing network called Global Lines, as shown in Figure 16. This network is intended for high-fanout clocks or other control signals, to maximize speed and minimize skewing while distributing the signal to many loads.

The XC5200 family has a total of four global buffers (BUFG symbol in the library), each with its own dedicated routing channel. Two are distributed vertically and two horizontally throughout the FPGA.

The global lines provide direct input only to the CLB clock pins. The global lines also connect to the General Routing Matrix to provide access from these lines to the function generators and other control signals.

Four clock input pads at the corners of the chip, as shown in Figure 16, provide a high-speed, low-skew clock network to each of the four global-line buffers. In addition to the dedicated pad, the global lines can be sourced by internal logic. PIPs from several routing channels within the VersaRing can also be configured to drive the global-line buffers.

Details of all the programmable interconnect for a CLB is shown in Figure 17.

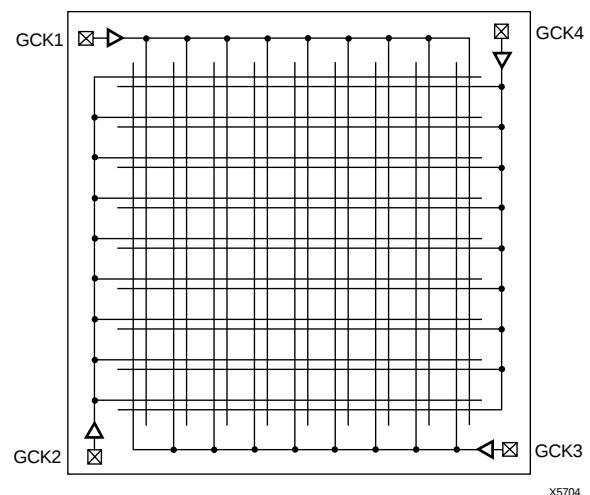


Figure 16: Global Lines

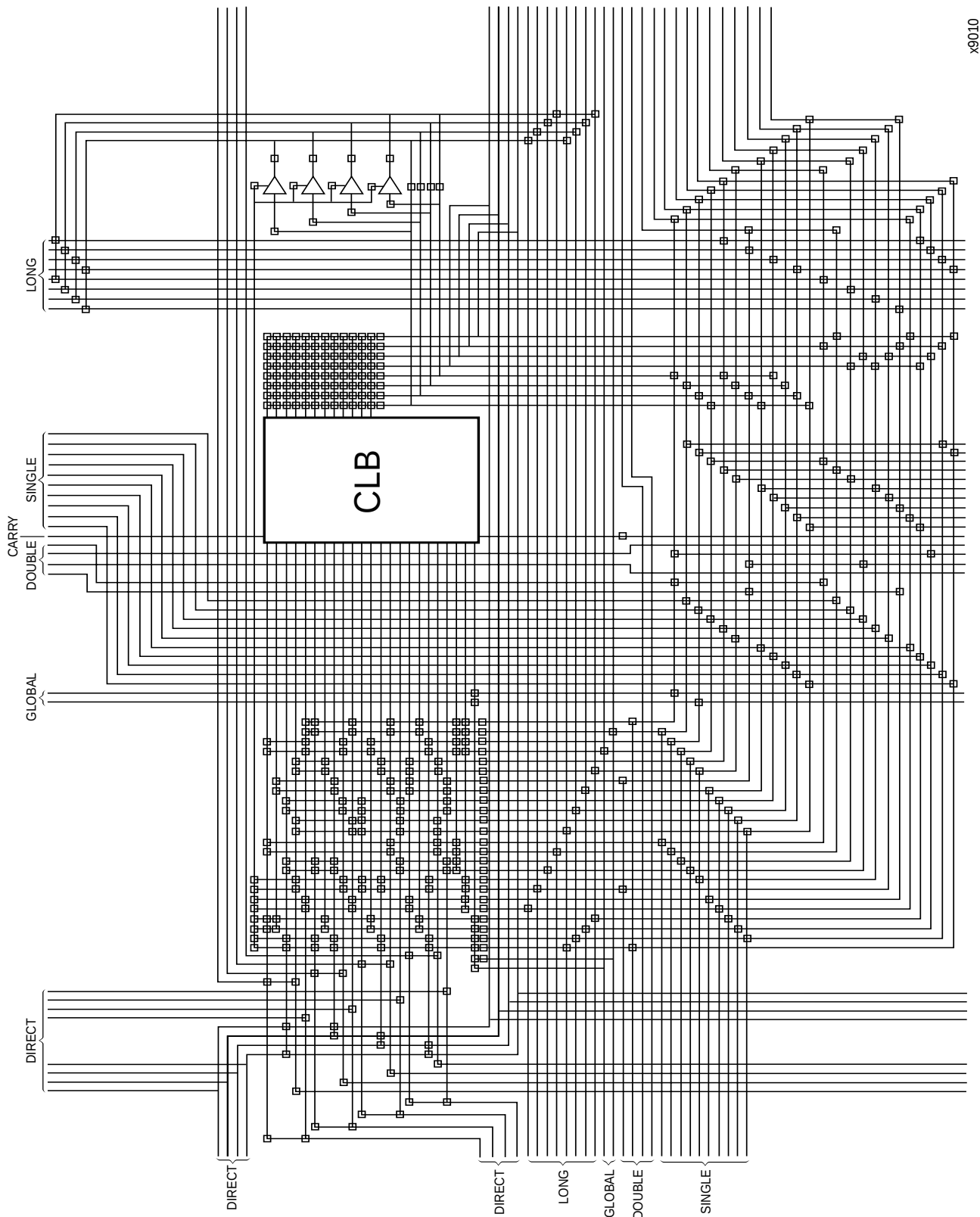
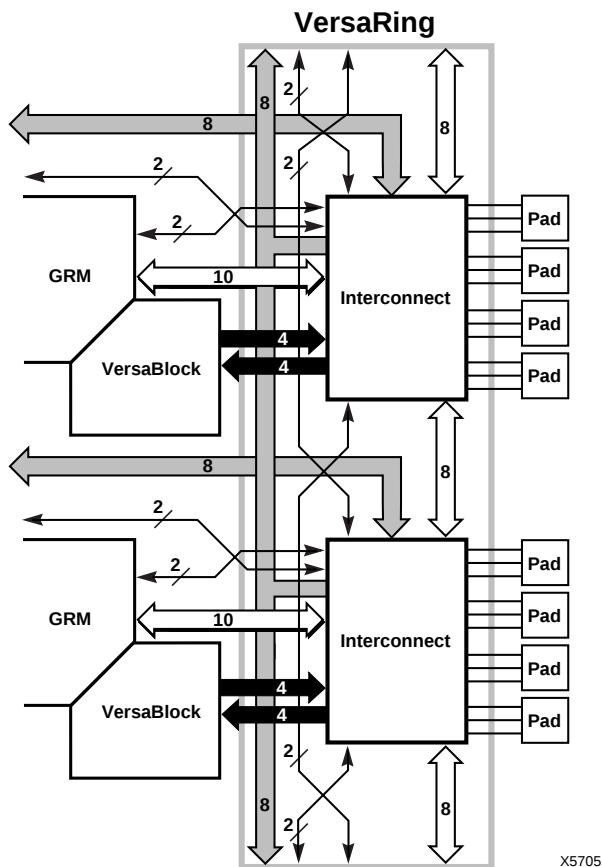


Figure 17: Detail of Programmable Interconnect Associated with XC5200 Series CLB

## VersaRing Input/Output Interface

The VersaRing, shown in [Figure 18](#), is positioned between the core logic and the pad ring; it has all the routing resources of a VersaBlock without the CLB logic. The VersaRing decouples the core logic from the I/O pads. Each VersaRing Cell provides up to four pad-cell connections on one side, and connects directly to the CLB ports on the other side.



**Figure 18: VersaRing I/O Interface**

## Boundary Scan

The “bed of nails” has been the traditional method of testing electronic assemblies. This approach has become less appropriate, due to closer pin spacing and more sophisticated assembly methods like surface-mount technology and multi-layer boards. The IEEE boundary scan standard 1149.1 was developed to facilitate board-level testing of electronic assemblies. Design and test engineers can imbed a standard test logic structure in their device to achieve high fault coverage for I/O and internal logic. This structure is easily implemented with a four-pin interface on any boundary scan-compatible IC. IEEE 1149.1-compatible devices may be serial daisy-chained together, connected in parallel, or a combination of the two.

XC5200 devices support all the mandatory boundary-scan instructions specified in the IEEE standard 1149.1. A Test Access Port (TAP) and registers are provided that implement the EXTEST, SAMPLE/PRELOAD, and BYPASS instructions. The TAP can also support two USERCODE instructions. When the boundary scan configuration option is selected, three normal user I/O pins become dedicated inputs for these functions. Another user output pin becomes the dedicated boundary scan output.

Boundary-scan operation is independent of individual IOB configuration and package type. All IOBs are treated as independently controlled bidirectional pins, including any unbonded IOBs. Retaining the bidirectional test capability after configuration provides flexibility for interconnect testing.

Also, internal signals can be captured during EXTEST by connecting them to unbonded IOBs, or to the unused outputs in IOBs used as unidirectional input pins. This technique partially compensates for the lack of INTEST support.

The user can serially load commands and data into these devices to control the driving of their outputs and to examine their inputs. This method is an improvement over bed-of-nails testing. It avoids the need to over-drive device outputs, and it reduces the user interface to four pins. An optional fifth pin, a reset for the control logic, is described in the standard but is not implemented in Xilinx devices.

The dedicated on-chip logic implementing the IEEE 1149.1 functions includes a 16-state machine, an instruction register and a number of data registers. The functional details can be found in the IEEE 1149.1 specification and are also discussed in the Xilinx application note XAPP 017: *“Boundary Scan in XC4000 and XC5200 Series devices”*

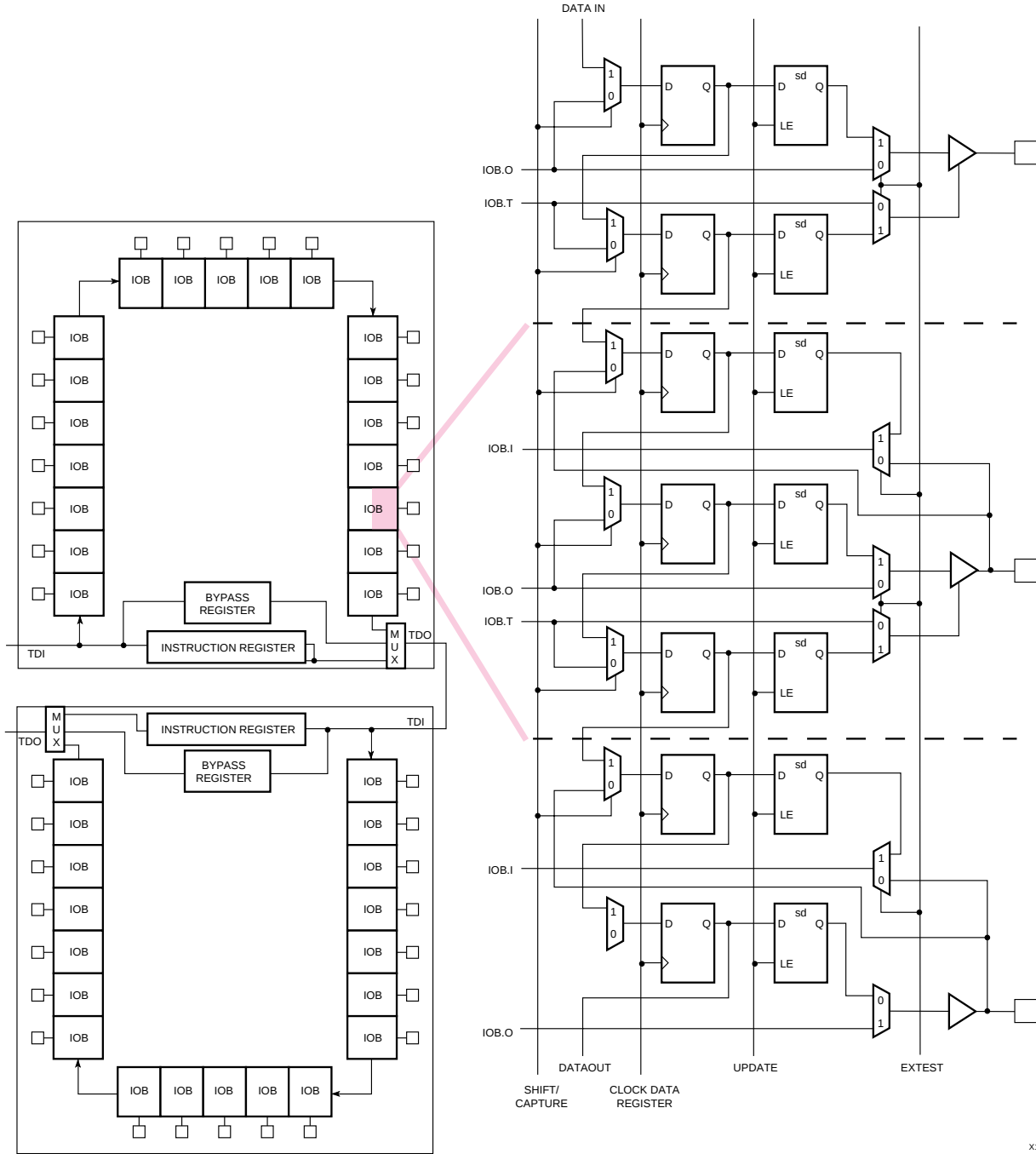
Figure 19 on page 99 is a diagram of the XC5200-Series boundary scan logic. It includes three bits of Data Register per IOB, the IEEE 1149.1 Test Access Port controller, and the Instruction Register with decodes.

The public boundary-scan instructions are always available prior to configuration. After configuration, the public instructions and any USERCODE instructions are only available if specified in the design. While SAMPLE and BYPASS are available during configuration, it is recommended that boundary-scan operations not be performed during this transitory period.

In addition to the test instructions outlined above, the boundary-scan circuitry can be used to configure the FPGA device, and to read back the configuration data.

All of the XC4000 boundary-scan modes are supported in the XC5200 family. Three additional outputs for the User-Register are provided (Reset, Update, and Shift), repre-

sentencing the decoding of the corresponding state of the boundary-scan internal state machine.



**Figure 19: XC5200-Series Boundary Scan Logic**

XC5200-Series devices can also be configured through the boundary scan logic. See XAPP 017 for more information.

### Data Registers

The primary data register is the boundary scan register. For each IOB pin in the FPGA, bonded or not, it includes three bits for In, Out and 3-State Control. Non-IOB pins have appropriate partial bit population for In or Out only. PROGRAM, CCLK and DONE are not included in the boundary scan register. Each EXTEST CAPTURE-DR state captures all In, Out, and 3-State pins.

The data register also includes the following non-pin bits: TDO.T, and TDO.O, which are always bits 0 and 1 of the data register, respectively, and BSCANT.UPD, which is always the last bit of the data register. These three boundary scan bits are special-purpose Xilinx test signals.

The other standard data register is the single flip-flop BYPASS register. It synchronizes data being passed through the FPGA to the next downstream boundary scan device.

The FPGA provides two additional data registers that can be specified using the BSCAN macro. The FPGA provides two user pins (BSCAN.SEL1 and BSCAN.SEL2) which are the decodes of two user instructions, USER1 and USER2. For these instructions, two corresponding pins (BSCAN.TDO1 and BSCAN.TDO2) allow user scan data to be shifted out on TDO. The data register clock (BSCAN.DRCK) is available for control of test logic which the user may wish to implement with CLBs. The NAND of TCK and RUN-TEST-IDLE is also provided (BSCAN.IDLE).

### Instruction Set

The XC5200-Series boundary scan instruction set also includes instructions to configure the device and read back the configuration data. The instruction set is coded as shown in [Table 7](#).

**Table 7: Boundary Scan Instructions**

| Instruction I2<br>I1 I0 |   |   | Test<br>Selected   | TDO Source         | I/O Data<br>Source |
|-------------------------|---|---|--------------------|--------------------|--------------------|
| 0                       | 0 | 0 | EXTEST             | DR                 | DR                 |
| 0                       | 0 | 1 | SAMPLE/PR<br>ELOAD | DR                 | Pin/Logic          |
| 0                       | 1 | 0 | USER 1             | BSCAN.<br>TDO1     | User Logic         |
| 0                       | 1 | 1 | USER 2             | BSCAN.<br>TDO2     | User Logic         |
| 1                       | 0 | 0 | READBACK           | Readback<br>Data   | Pin/Logic          |
| 1                       | 0 | 1 | CONFIGURE          | DOUT               | Disabled           |
| 1                       | 1 | 0 | Reserved           | —                  | —                  |
| 1                       | 1 | 1 | BYPASS             | Bypass<br>Register | —                  |

### Bit Sequence

The bit sequence within each IOB is: 3-State, Out, In. The data-register cells for the TAP pins TMS, TCK, and TDI have an OR-gate that permanently disables the output buffer if boundary-scan operation is selected. Consequently, it is impossible for the outputs in IOBs used by TAP inputs to conflict with TAP operation. TAP data is taken directly from the pin, and cannot be overwritten by injected boundary-scan data.

The primary global clock inputs (PGCK1-PGCK4) are taken directly from the pins, and cannot be overwritten with boundary-scan data. However, if necessary, it is possible to drive the clock input from boundary scan. The external clock source is 3-stated, and the clock net is driven with boundary scan data through the output driver in the clock-pad IOB. If the clock-pad IOBs are used for non-clock signals, the data may be overwritten normally.

Pull-up and pull-down resistors remain active during boundary scan. Before and during configuration, all pins are pulled up. After configuration, the choice of internal pull-up or pull-down resistor must be taken into account when designing test vectors to detect open-circuit PC traces.

From a cavity-up view of the chip (as shown in XDE or Epic), starting in the upper right chip corner, the boundary scan data-register bits are ordered as shown in [Table 8](#). The device-specific pinout tables for the XC5200 Series include the boundary scan locations for each IOB pin.

**Table 8: Boundary Scan Bit Sequence**

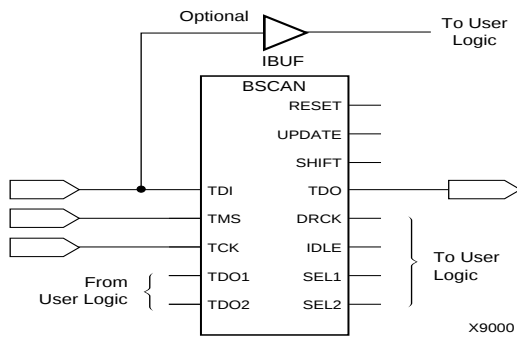
| Bit Position | I/O Pad Location                     |
|--------------|--------------------------------------|
| Bit 0 (TDO)  | Top-edge I/O pads (right to left)    |
| Bit 1        | ...                                  |
| ...          | Left-edge I/O pads (top to bottom)   |
| ...          | Bottom-edge I/O pads (left to right) |
| ...          | Right-edge I/O pads (bottom to top)  |
| Bit N (TDI)  | BSCANT.UPD                           |

BSDL (Boundary Scan Description Language) files for XC5200-Series devices are available on the Xilinx web site in the File Download area.

### Including Boundary Scan

If boundary scan is only to be used during configuration, no special elements need be included in the schematic or HDL code. In this case, the special boundary scan pins TDI, TMS, TCK and TDO can be used for user functions after configuration.

To indicate that boundary scan remain enabled after configuration, include the BSCAN library symbol and connect pad symbols to the TDI, TMS, TCK and TDO pins, as shown in [Figure 20](#).



**Figure 20: Boundary Scan Schematic Example**

Even if the boundary scan symbol is used in a schematic, the input pins TMS, TCK, and TDI can still be used as inputs to be routed to internal logic. Care must be taken not to force the chip into an undesired boundary scan state by inadvertently applying boundary scan input patterns to these pins. The simplest way to prevent this is to keep TMS High, and then apply whatever signal is desired to TDI and TCK.

### Avoiding Inadvertent Boundary Scan

If TMS or TCK is used as user I/O, care must be taken to ensure that at least one of these pins is held constant during configuration. In some applications, a situation may occur where TMS or TCK is driven during configuration. This may cause the device to go into boundary scan mode and disrupt the configuration process.

To prevent activation of boundary scan during configuration, do either of the following:

- TMS: Tie High to put the Test Access Port controller in a benign RESET state
- TCK: Tie High or Low—do not toggle this clock input.

For more information regarding boundary scan, refer to the Xilinx Application Note XAPP 017, "Boundary Scan in XC4000 and XC5200 Devices."

### Power Distribution

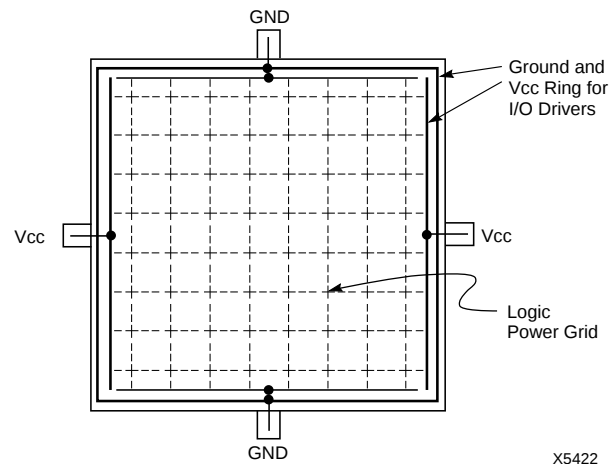
Power for the FPGA is distributed through a grid to achieve high noise immunity and isolation between logic and I/O. Inside the FPGA, a dedicated Vcc and Ground ring surrounding the logic array provides power to the I/O drivers, as shown in Figure 21. An independent matrix of Vcc and Ground lines supplies the interior logic of the device.

This power distribution grid provides a stable supply and ground for all internal logic, providing the external package power pins are all connected and appropriately decoupled.

Typically, a 0.1  $\mu$ F capacitor connected near the Vcc and Ground pins of the package will provide adequate decoupling.

Output buffers capable of driving/sinking the specified 8 mA loads under specified worst-case conditions may be capable of driving/sinking up to 10 times as much current under best case conditions.

Noise can be reduced by minimizing external load capacitance and reducing simultaneous output transitions in the same direction. It may also be beneficial to locate heavily loaded output buffers near the Ground pads. The I/O Block output buffers have a slew-rate limited mode (default) which should be used where output rise and fall times are not speed-critical.



**Figure 21: XC5200-Series Power Distribution**

### Pin Descriptions

There are three types of pins in the XC5200-Series devices:

- Permanently dedicated pins
- User I/O pins that can have special functions
- Unrestricted user-programmable I/O pins.

Before and during configuration, all outputs not used for the configuration process are 3-stated and pulled high with a 20 k $\Omega$  - 100 k $\Omega$  pull-up resistor.

After configuration, if an IOB is unused it is configured as an input with a 20 k $\Omega$  - 100 k $\Omega$  pull-up resistor.

Device pins for XC5200-Series devices are described in Table 9. Pin functions during configuration for each of the seven configuration modes are summarized in "Pin Func-

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



tions During Configuration" on page 124, in the "Configuration Timing" section.

**Table 9: Pin Descriptions**

| Pin Name                                             | I/O During Config. | I/O After Config. | Pin Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|------------------------------------------------------|--------------------|-------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Permanently Dedicated Pins</b>                    |                    |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| VCC                                                  | I                  | I                 | Five or more (depending on package) connections to the nominal +5 V supply voltage. All must be connected, and each must be decoupled with a 0.01 - 0.1 $\mu$ F capacitor to Ground.                                                                                                                                                                                                                                                                                                                                        |
| GND                                                  | I                  | I                 | Four or more (depending on package type) connections to Ground. All must be connected.                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| CCLK                                                 | I or O             | I                 | During configuration, Configuration Clock (CCLK) is an output in Master modes or Asynchronous Peripheral mode, but is an input in Slave mode, Synchronous Peripheral mode, and Express mode. After configuration, CCLK has a weak pull-up resistor and can be selected as the Readback Clock. There is no CCLK High time restriction on XC5200-Series devices, except during Readback. See "Violating the Maximum High and Low Time Specification for the Readback Clock" on page 113 for an explanation of this exception. |
| DONE                                                 | I/O                | O                 | DONE is a bidirectional signal with an optional internal pull-up resistor. As an output, it indicates the completion of the configuration process. As an input, a Low level on DONE can be configured to delay the global logic initialization and the enabling of outputs. The exact timing, the clock source for the Low-to-High transition, and the optional pull-up resistor are selected as options in the program that creates the configuration bit-stream. The resistor is included by default.                     |
| $\overline{\text{PROGRAM}}$                          | I                  | I                 | PROGRAM is an active Low input that forces the FPGA to clear its configuration memory. It is used to initiate a configuration cycle. When PROGRAM goes High, the FPGA executes a complete clear cycle, before it goes into a WAIT state and releases INIT. The PROGRAM pin has an optional weak pull-up after configuration.                                                                                                                                                                                                |
| <b>User I/O Pins That Can Have Special Functions</b> |                    |                   |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| RDY/ $\overline{\text{BUSY}}$                        | O                  | I/O               | During Peripheral mode configuration, this pin indicates when it is appropriate to write another byte of data into the FPGA. The same status is also available on D7 in Asynchronous Peripheral mode, if a read operation is performed when the device is selected. After configuration, RDY/ $\overline{\text{BUSY}}$ is a user-programmable I/O pin. $\overline{\text{RDY/BUSY}}$ is pulled High with a high-impedance pull-up prior to INIT going High.                                                                  |
| $\overline{\text{RCLK}}$                             | O                  | I/O               | During Master Parallel configuration, each change on the A0-A17 outputs is preceded by a rising edge on RCLK, a redundant output signal. RCLK is useful for clocked PROMs. It is rarely used during configuration. After configuration, RCLK is a user-programmable I/O pin.                                                                                                                                                                                                                                                |
| M0, M1, M2                                           | I                  | I/O               | As Mode inputs, these pins are sampled before the start of configuration to determine the configuration mode to be used. After configuration, M0, M1, and M2 become user-programmable I/O. During configuration, these pins have weak pull-up resistors. For the most popular configuration mode, Slave Serial, the mode pins can thus be left unconnected. A pull-down resistor value of 3.3 k $\Omega$ is recommended for other modes.                                                                                    |
| TDO                                                  | O                  | O                 | If boundary scan is used, this pin is the Test Data Output. If boundary scan is not used, this pin is a 3-state output, after configuration is completed. This pin can be user output only when called out by special schematic definitions. To use this pin, place the library component TDO instead of the usual pad symbol. An output buffer must still be used.                                                                                                                                                         |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

Table 9: Pin Descriptions (Continued)

| Pin Name                                                                                   | I/O During Config. | I/O After Config. | Pin Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|--------------------------------------------------------------------------------------------|--------------------|-------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TDI, TCK, TMS                                                                              | I                  | I/O or I (JTAG)   | If boundary scan is used, these pins are Test Data In, Test Clock, and Test Mode Select inputs respectively. They come directly from the pads, bypassing the IOBs. These pins can also be used as inputs to the CLB logic after configuration is completed.<br>If the BSCAN symbol is not placed in the design, all boundary scan functions are inhibited once configuration is completed, and these pins become user-programmable I/O. In this case, they must be called out by special schematic definitions. To use these pins, place the library components TDI, TCK, and TMS instead of the usual pad symbols. Input or output buffers must still be used.                                                                                                         |
| HDC                                                                                        | O                  | I/O               | High During Configuration (HDC) is driven High until the I/O go active. It is available as a control output indicating that configuration is not yet completed. After configuration, HDC is a user-programmable I/O pin.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| $\overline{\text{LDC}}$                                                                    | O                  | I/O               | Low During Configuration (LDC) is driven Low until the I/O go active. It is available as a control output indicating that configuration is not yet completed. After configuration, LDC is a user-programmable I/O pin.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| $\overline{\text{INIT}}$                                                                   | I/O                | I/O               | Before and during configuration, $\overline{\text{INIT}}$ is a bidirectional signal. A 1 k $\Omega$ - 10 k $\Omega$ external pull-up resistor is recommended.<br>As an active-Low open-drain output, $\overline{\text{INIT}}$ is held Low during the power stabilization and internal clearing of the configuration memory. As an active-Low input, it can be used to hold the FPGA in the internal WAIT state before the start of configuration. Master mode devices stay in a WAIT state an additional 50 to 250 $\mu\text{s}$ after $\overline{\text{INIT}}$ has gone High. During configuration, a Low on this output indicates that a configuration data error has occurred. After the I/O go active, $\overline{\text{INIT}}$ is a user-programmable I/O pin.     |
| GCK1 - GCK4                                                                                | Weak Pull-up       | I or I/O          | Four Global inputs each drive a dedicated internal global net with short delay and minimal skew. These internal global nets can also be driven from internal logic. If not used to drive a global net, any of these pins is a user-programmable I/O pin.<br>The GCK1-GCK4 pins provide the shortest path to the four Global Buffers. Any input pad symbol connected directly to the input of a BUFG symbol is automatically placed on one of these pins.                                                                                                                                                                                                                                                                                                                |
| $\overline{\text{CS0}}, \overline{\text{CS1}}, \overline{\text{WS}}, \overline{\text{RS}}$ | I                  | I/O               | These four inputs are used in Asynchronous Peripheral mode. The chip is selected when $\overline{\text{CS0}}$ is Low and $\overline{\text{CS1}}$ is High. While the chip is selected, a Low on Write Strobe ( $\overline{\text{WS}}$ ) loads the data present on the D0 - D7 inputs into the internal data buffer. A Low on Read Strobe ( $\overline{\text{RS}}$ ) changes D7 into a status output — High if Ready, Low if Busy — and drives D0 - D6 High.<br>In Express mode, $\overline{\text{CS1}}$ is used as a serial-enable signal for daisy-chaining. $\overline{\text{WS}}$ and $\overline{\text{RS}}$ should be mutually exclusive, but if both are Low simultaneously, the Write Strobe overrides. After configuration, these are user-programmable I/O pins. |
| A0 - A17                                                                                   | O                  | I/O               | During Master Parallel configuration, these 18 output pins address the configuration EPROM. After configuration, they are user-programmable I/O pins.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| D0 - D7                                                                                    | I                  | I/O               | During Master Parallel, Peripheral, and Express configuration, these eight input pins receive configuration data. After configuration, they are user-programmable I/O pins.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| DIN                                                                                        | I                  | I/O               | During Slave Serial or Master Serial configuration, DIN is the serial configuration data input receiving data on the rising edge of CCLK. During Parallel configuration, DIN is the D0 input. After configuration, DIN is a user-programmable I/O pin.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| DOUT                                                                                       | O                  | I/O               | During configuration in any mode but Express mode, DOUT is the serial configuration data output that can drive the DIN of daisy-chained slave FPGAs. DOUT data changes on the falling edge of CCLK.<br>In Express mode, DOUT is the status output that can drive the $\overline{\text{CS1}}$ of daisy-chained FPGAs, to enable and disable downstream devices.<br>After configuration, DOUT is a user-programmable I/O pin.                                                                                                                                                                                                                                                                                                                                             |

**Table 9: Pin Descriptions (Continued)**

| Pin Name                                       | I/O During Config. | I/O After Config. | Pin Description                                                                                                                                                                                                                                             |
|------------------------------------------------|--------------------|-------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Unrestricted User-Programmable I/O Pins</b> |                    |                   |                                                                                                                                                                                                                                                             |
| I/O                                            | Weak Pull-up       | I/O               | These pins can be configured to be input and/or output after configuration is completed. Before configuration is completed, these pins have an internal high-value pull-up resistor (20 k $\Omega$ - 100 k $\Omega$ ) that defines the logic level as High. |

## Configuration

Configuration is the process of loading design-specific programming data into one or more FPGAs to define the functional operation of the internal blocks and their interconnections. This is somewhat like loading the command registers of a programmable peripheral chip. XC5200-Series devices use several hundred bits of configuration data per CLB and its associated interconnects. Each configuration bit defines the state of a static memory cell that controls either a function look-up table bit, a multiplexer input, or an interconnect pass transistor. The development system translates the design into a netlist file. It automatically partitions, places and routes the logic and generates the configuration data in PROM format.

## Special Purpose Pins

Three configuration mode pins (M2, M1, M0) are sampled prior to configuration to determine the configuration mode. After configuration, these pins can be used as auxiliary I/O connections. The development system does not use these resources unless they are explicitly specified in the design entry. This is done by placing a special pad symbol called MD2, MD1, or MD0 instead of the input or output pad symbol.

In XC5200-Series devices, the mode pins have weak pull-up resistors during configuration. With all three mode pins High, Slave Serial mode is selected, which is the most popular configuration mode. Therefore, for the most common configuration mode, the mode pins can be left unconnected. (Note, however, that the internal pull-up resistor value can be as high as 100 k $\Omega$ .) After configuration, these pins can individually have weak pull-up or pull-down resistors, as specified in the design. A pull-down resistor value of 3.3k $\Omega$  is recommended.

These pins are located in the lower left chip corner and are near the readback nets. This location allows convenient routing if compatibility with the XC2000 and XC3000 family conventions of M0/RT, M1/RD is desired.

## Configuration Modes

XC5200 devices have seven configuration modes. These modes are selected by a 3-bit input code applied to the M2,

M1, and M0 inputs. There are three self-loading Master modes, two Peripheral modes, and a Serial Slave mode,

**Table 10: Configuration Modes**

| Mode                    | M2 | M1 | M0 | CCLK   | Data                            |
|-------------------------|----|----|----|--------|---------------------------------|
| Master Serial           | 0  | 0  | 0  | output | Bit-Serial                      |
| Slave Serial            | 1  | 1  | 1  | input  | Bit-Serial                      |
| Master Parallel Up      | 1  | 0  | 0  | output | Byte-Wide, increment from 00000 |
| Master Parallel Down    | 1  | 1  | 0  | output | Byte-Wide, decrement from 3FFFF |
| Peripheral Synchronous* | 0  | 1  | 1  | input  | Byte-Wide                       |
| Peripheral Asynchronous | 1  | 0  | 1  | output | Byte-Wide                       |
| Express                 | 0  | 1  | 0  | input  | Byte-Wide                       |
| Reserved                | 0  | 0  | 1  | —      | —                               |

Note :\*Peripheral Synchronous can be considered byte-wide Slave Parallel

which is used primarily for daisy-chained devices. The seventh mode, called Express mode, is an additional slave mode that allows high-speed parallel configuration. The coding for mode selection is shown in [Table 10](#).

Note that the smallest package, VQ64, only supports the Master Serial, Slave Serial, and Express modes. A detailed description of each configuration mode, with timing information, is included later in this data sheet. During configuration, some of the I/O pins are used temporarily for the configuration process. All pins used during configuration are shown in [Table 13 on page 124](#).

## Master Modes

The three Master modes use an internal oscillator to generate a Configuration Clock (CCLK) for driving potential slave devices. They also generate address and timing for external PROM(s) containing the configuration data.

Master Parallel (Up or Down) modes generate the CCLK signal and PROM addresses and receive byte parallel data. The data is internally serialized into the FPGA data-frame format. The up and down selection generates starting addresses at either zero or 3FFFF, for compatibility with different microprocessor addressing conventions. The

Master Serial mode generates CCLK and receives the configuration data in serial form from a Xilinx serial-configuration PROM.

CCLK speed is selectable as 1 MHz (default), 6 MHz, or 12 MHz. Configuration always starts at the default slow frequency, then can switch to the higher frequency during the first frame. Frequency tolerance is -50% to +50%.

### Peripheral Modes

The two Peripheral modes accept byte-wide data from a bus. A RDY/BUSY status is available as a handshake signal. In Asynchronous Peripheral mode, the internal oscillator generates a CCLK burst signal that serializes the byte-wide data. CCLK can also drive slave devices. In the synchronous mode, an externally supplied clock input to CCLK serializes the data.

### Slave Serial Mode

In Slave Serial mode, the FPGA receives serial configuration data on the rising edge of CCLK and, after loading its configuration, passes additional data out, resynchronized on the next falling edge of CCLK.

Multiple slave devices with identical configurations can be wired with parallel DIN inputs. In this way, multiple devices can be configured simultaneously.

### Serial Daisy Chain

Multiple devices with different configurations can be connected together in a "daisy chain," and a single combined bitstream used to configure the chain of slave devices.

To configure a daisy chain of devices, wire the CCLK pins of all devices in parallel, as shown in [Figure 28 on page 114](#). Connect the DOUT of each device to the DIN of the next. The lead or master FPGA and following slaves each passes resynchronized configuration data coming from a single source. The header data, including the length count, is passed through and is captured by each FPGA when it recognizes the 0010 preamble. Following the length-count data, each FPGA outputs a High on DOUT until it has received its required number of data frames.

After an FPGA has received its configuration data, it passes on any additional frame start bits and configuration data on DOUT. When the total number of configuration clocks applied after memory initialization equals the value of the 24-bit length count, the FPGAs begin the start-up sequence and become operational together. FPGA I/O are normally released two CCLK cycles after the last configuration bit is received. [Figure 25 on page 109](#) shows the start-up timing for an XC5200-Series device.

The daisy-chained bitstream is not simply a concatenation of the individual bitstreams. The PROM file formatter must be used to combine the bitstreams for a daisy-chained configuration.

### Multi-Family Daisy Chain

All Xilinx FPGAs of the XC2000, XC3000, XC4000, and XC5200 Series use a compatible bitstream format and can, therefore, be connected in a daisy chain in an arbitrary sequence. There is, however, one limitation. If the chain contains XC5200-Series devices, the master normally cannot be an XC2000 or XC3000 device.

The reason for this rule is shown in [Figure 25 on page 109](#). Since all devices in the chain store the same length count value and generate or receive one common sequence of CCLK pulses, they all recognize length-count match on the same CCLK edge, as indicated on the left edge of [Figure 25](#). The master device then generates additional CCLK pulses until it reaches its finish point F. The different families generate or require different numbers of additional CCLK pulses until they reach F. Not reaching F means that the device does not really finish its configuration, although DONE may have gone High, the outputs became active, and the internal reset was released. For the XC5200-Series device, not reaching F means that read-back cannot be initiated and most boundary scan instructions cannot be used.

The user has some control over the relative timing of these events and can, therefore, make sure that they occur at the proper time and the finish point F is reached. Timing is controlled using options in the bitstream generation software.

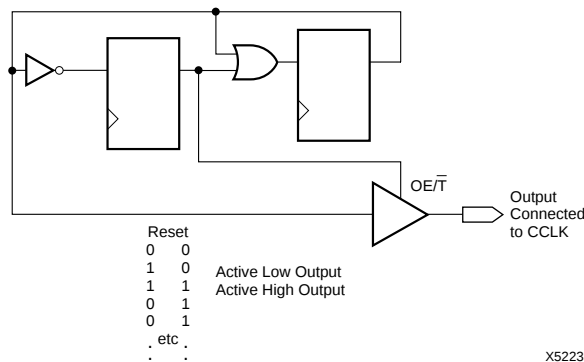
XC5200 devices always have the same number of CCLKs in the power up delay, independent of the configuration mode, unlike the XC3000/XC4000 Series devices. To guarantee all devices in a daisy chain have finished the power-up delay, tie the INIT pins together, as shown in [Figure 27](#).

### XC3000 Master with an XC5200-Series Slave

Some designers want to use an XC3000 lead device in peripheral mode and have the I/O pins of the XC5200-Series devices all available for user I/O. [Figure 22](#) provides a solution for that case.

This solution requires one CLB, one IOB and pin, and an internal oscillator with a frequency of up to 5 MHz as a clock source. The XC3000 master device must be configured with late Internal Reset, which is the default option.

One CLB and one IOB in the lead XC3000-family device are used to generate the additional CCLK pulse required by the XC5200-Series devices. When the lead device removes the internal RESET signal, the 2-bit shift register responds to its clock input and generates an active Low output signal for the duration of the subsequent clock period. An external connection between this output and CCLK thus creates the extra CCLK pulse.



**Figure 22: CCLK Generation for XC3000 Master Driving an XC5200-Series Slave**

### Express Mode

Express mode is similar to Slave Serial mode, except the data is presented in parallel format, and is clocked into the target device a byte at a time rather than a bit at a time. The data is loaded in parallel into eight different columns: it is not internally serialized. Eight bits of configuration data are loaded with every CCLK cycle, therefore this configuration mode runs at eight times the data rate of the other six modes. In this mode the XC5200 family is capable of supporting a CCLK frequency of 10 MHz, which is equivalent to an 80 MHz serial rate, because eight bits of configuration data are being loaded per CCLK cycle. An XC5210 in the Express mode, for instance, can be configured in about 2 ms. The Express mode does not support CRC error checking, but does support constant-field error checking. A length count is not used in Express mode.

In the Express configuration mode, an external signal drives the CCLK input(s). The first byte of parallel configuration data must be available at the D inputs of the FPGA devices a short set-up time before the second rising CCLK edge. Subsequent data bytes are clocked in on each consecutive rising CCLK edge. See [Figure 38 on page 123](#).

Bitstream generation currently generates a bitstream sufficient to program in all configuration modes except Express. Extra CCLK cycles are necessary to complete the configuration, since in this mode data is read at a rate of eight bits per CCLK cycle instead of one bit per cycle. Normally the entire start-up sequence requires a number of bits that is equal to the number of CCLK cycles needed. An additional five CCLKs (equivalent to 40 extra bits) will guarantee completion of configuration, regardless of the start-up options chosen.

Multiple slave devices with identical configurations can be wired with parallel D0-D7 inputs. In this way, multiple devices can be configured simultaneously.

### Pseudo Daisy Chain

Multiple devices with different configurations can be connected together in a pseudo daisy chain, provided that all of the devices are in Express mode. A single combined bitstream is used to configure the chain of Express mode devices, but the input data bus must drive D0-D7 of each device. Tie High the CS1 pin of the first device to be configured, or leave it floating in the XC5200 since it has an internal pull-up. Connect the DOUT pin of each FPGA to the CS1 pin of the next device in the chain. The D0-D7 inputs are wired to each device in parallel. The DONE pins are wired together, with one or more internal DONE pull-ups activated. Alternatively, a 4.7 kΩ external resistor can be used, if desired. (See [Figure 37 on page 122](#).) CCLK pins are tied together.

The requirement that all DONE pins in a daisy chain be wired together applies only to Express mode, and only if all devices in the chain are to become active simultaneously. All devices in Express mode are synchronized to the DONE pin. User I/O for each device become active after the DONE pin for that device goes High. (The exact timing is determined by options to the bitstream generation software.) Since the DONE pin is open-drain and does not drive a High value, tying the DONE pins of all devices together prevents all devices in the chain from going High until the last device in the chain has completed its configuration cycle.

The status pin DOUT is pulled LOW two internal-oscillator cycles (nominally 1 MHz) after INIT is recognized as High, and remains Low until the device's configuration memory is full. Then DOUT is pulled High to signal the next device in the chain to accept the configuration data on the D7-D0 bus. All devices receive and recognize the six bytes of preamble and length count, irrespective of the level on CS1; but subsequent frame data is accepted only when CS1 is High and the device's configuration memory is not already full.

### Setting CCLK Frequency

For Master modes, CCLK can be generated in one of three frequencies. In the default slow mode, the frequency is nominally 1 MHz. In fast CCLK mode, the frequency is nominally 12 MHz. In medium CCLK mode, the frequency is nominally 6 MHz. The frequency range is -50% to +50%. The frequency is selected by an option when running the bitstream generation software. If an XC5200-Series Master is driving an XC3000- or XC2000-family slave, slow CCLK mode must be used. Slow mode is the default.

**Table 11: XC5200 Bitstream Format**

| Data Type      | Value       | Occurrences        |
|----------------|-------------|--------------------|
| Fill Byte      | 11111111    | Once per bitstream |
| Preamble       | 11110010    |                    |
| Length Counter | COUNT(23:0) |                    |
| Fill Byte      | 11111111    |                    |

**Table 11: XC5200 Bitstream Format**

| Data Type                                       | Value            | Occurrences         |
|-------------------------------------------------|------------------|---------------------|
| Start Byte                                      | 11111110         | Once per data frame |
| Data Frame *                                    | DATA(N-1:0)      |                     |
| Cyclic Redundancy Check or Constant Field Check | CRC(3:0) or 0110 |                     |
| Fill Nibble                                     | 1111             |                     |
| Extend Write Cycle                              | FFFFFF           | Once per device     |
| Postamble                                       | 11111110         |                     |
| Fill Bytes (30)                                 | FFFF...FF        |                     |
| Start-Up Byte                                   | FF               | Once per bit-stream |

\*Bits per Frame (N) depends on device size, as described for table 11.

### Data Stream Format

The data stream ("bitstream") format is identical for all configuration modes, with the exception of Express mode. In Express mode, the device becomes active when DONE goes High, therefore no length count is required. Additionally, CRC error checking is not supported in Express mode.

The data stream formats are shown in Table 11. Express mode data is shown with D0 at the left and D7 at the right. For all other modes, bit-serial data is read from left to right, and byte-parallel data is effectively assembled from this serial bitstream, with the first bit in each byte assigned to D0.

The configuration data stream begins with a string of eight ones, a preamble code, followed by a 24-bit length count and a separator field of ones (or 24 fill bits, in Express mode). This header is followed by the actual configuration data in frames. The length and number of frames depends on the device type (see Table 12). Each frame begins with a start field and ends with an error check. In all modes except Express mode, a postamble code is required to signal the end of data for a single device. In all cases, additional start-up bytes of data are required to provide four clocks for the startup sequence at the end of configuration. Long daisy chains require additional startup bytes to shift the last data through the chain. All startup bytes are don't-cares; these bytes are not included in bitstreams created by the Xilinx software.

In Express mode, only non-CRC error checking is supported. In all other modes, a selection of CRC or non-CRC error checking is allowed by the bitstream generation software. The non-CRC error checking tests for a designated end-of-frame field for each frame. For CRC error checking, the software calculates a running CRC and inserts a unique four-bit partial check at the end of each frame. The 11-bit CRC check of the last frame of an FPGA includes the last seven data bits.

Detection of an error results in the suspension of data loading and the pulling down of the INIT pin. In Master modes,

CCLK and address signals continue to operate externally. The user must detect INIT and initialize a new configuration by pulsing the PROGRAM pin Low or cycling Vcc.

**Table 12: Internal Configuration Data Structure**

| Device | VersaBlock Array | PROM Size (bits) | Xilinx Serial PROM Needed |
|--------|------------------|------------------|---------------------------|
| XC5202 | 8 x 8            | 42,416           | XC1765E                   |
| XC5204 | 10 x 12          | 70,704           | XC17128E                  |
| XC5206 | 14 x 14          | 106,288          | XC17128E                  |
| XC5210 | 18 x 18          | 165,488          | XC17256E                  |
| XC5215 | 22 x 22          | 237,744          | XC17256E                  |

Bits per Frame = (34 x number of Rows) + 28 for the top + 28 for the bottom + 4 splitter bits + 8 start bits + 4 error check bits + 4 fill bits \* + 24 extended write bits

= (34 x number of Rows) + 100

\* In the XC5202 (8 x 8), there are 8 fill bits per frame, not 4

Number of Frames = (12 x number of Columns) + 7 for the left edge + 8 for the right edge + 1 splitter bit

= (12 x number of Columns) + 16

Program Data = (Bits per Frame x Number of Frames) + 48

header bits + 8 postamble bits + 240 fill bits + 8 start-up bits

= (Bits per Frame x Number of Frames) + 304

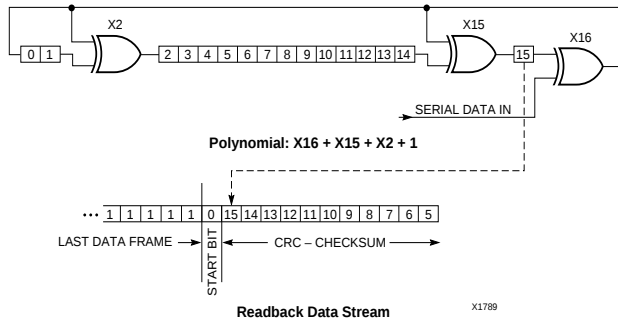
PROM Size = Program Data

### Cyclic Redundancy Check (CRC) for Configuration and Readback

The Cyclic Redundancy Check is a method of error detection in data transmission applications. Generally, the transmitting system performs a calculation on the serial bitstream. The result of this calculation is tagged onto the data stream as additional check bits. The receiving system performs an identical calculation on the bitstream and compares the result with the received checksum.

Each data frame of the configuration bitstream has four error bits at the end, as shown in Table 11. If a frame data error is detected during the loading of the FPGA, the configuration process with a potentially corrupted bitstream is terminated. The FPGA pulls the INIT pin Low and goes into a Wait state.

During Readback, 11 bits of the 16-bit checksum are added to the end of the Readback data stream. The checksum is computed using the CRC-16 CCITT polynomial, as shown in Figure 23. The checksum consists of the 11 most significant bits of the 16-bit code. A change in the checksum indicates a change in the Readback bitstream. A comparison to a previous checksum is meaningful only if the readback data is independent of the current device state. CLB outputs should not be included (Read Capture option not used). Statistically, one error out of 2048 might go undetected.



**Figure 23: Circuit for Generating CRC-16**

### Configuration Sequence

There are four major steps in the XC5200-Series power-up configuration sequence.

- Power-On Time-Out
- Initialization
- Configuration
- Start-Up

The full process is illustrated in [Figure 24](#).

#### Power-On Time-Out

An internal power-on reset circuit is triggered when power is applied. When  $V_{CC}$  reaches the voltage at which portions of the FPGA begin to operate (i.e., performs a write-and-read test of a sample pair of configuration memory bits), the programmable I/O buffers are 3-stated with active high-impedance pull-up resistors. A time-out delay — nominally 4 ms — is initiated to allow the power-supply voltage to stabilize. For correct operation the power supply must reach  $V_{CC}(\text{min})$  by the end of the time-out, and must not dip below it thereafter.

There is no distinction between master and slave modes with regard to the time-out delay. Instead, the INIT line is used to ensure that all daisy-chained devices have completed initialization. Since XC2000 devices do not have this signal, extra care must be taken to guarantee proper operation when daisy-chaining them with XC5200 devices. For proper operation with XC3000 devices, the RESET signal, which is used in XC3000 to delay configuration, should be connected to INIT.

If the time-out delay is insufficient, configuration should be delayed by holding the INIT pin Low until the power supply has reached operating levels.

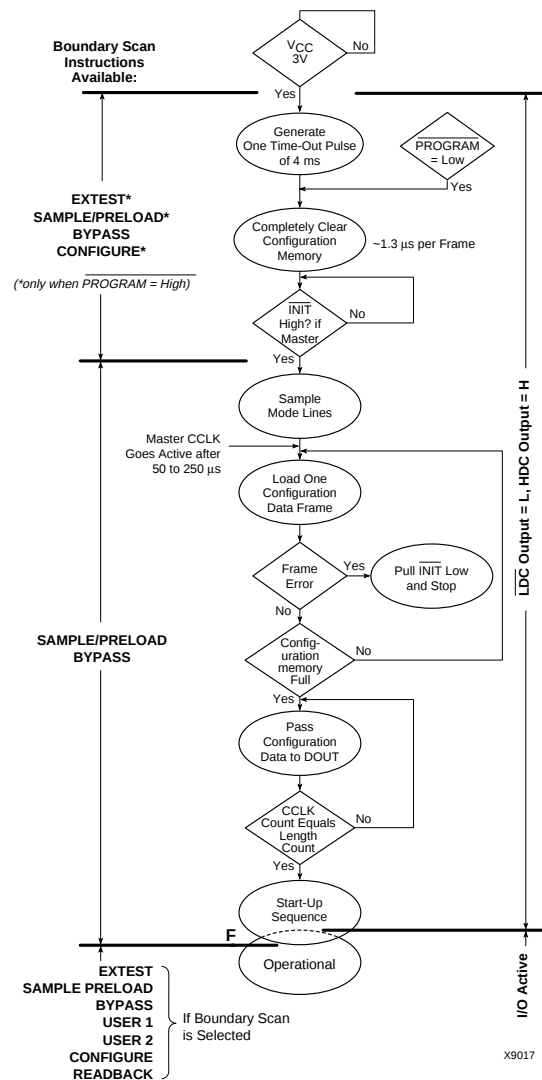
This delay is applied only on power-up. It is not applied when reconfiguring an FPGA by pulsing the PROGRAM pin Low. During all three phases — Power-on, Initialization, and Configuration — DONE is held Low; HDC, LDC, and INIT are active; DOUT is driven; and all I/O buffers are disabled.

### Initialization

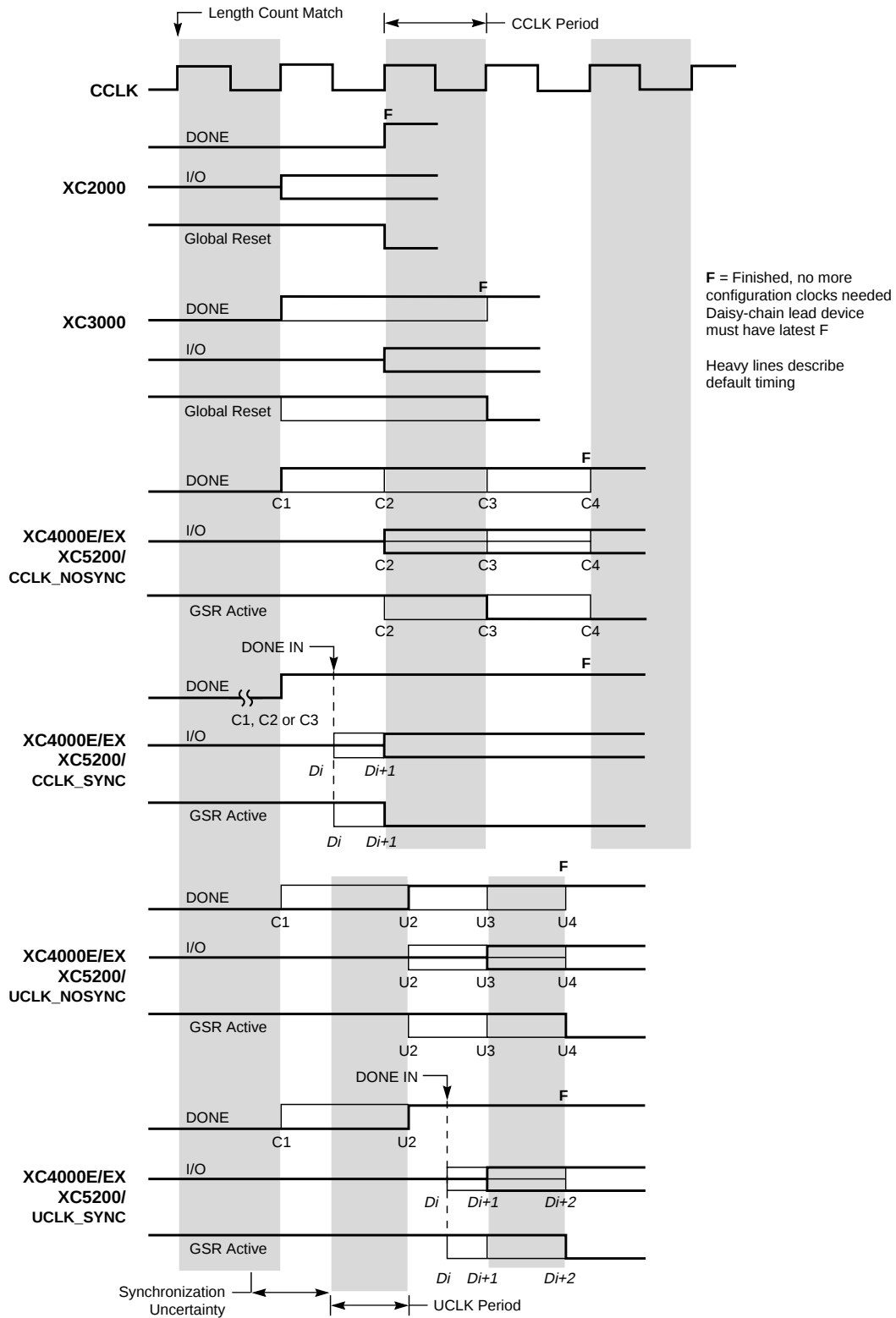
This phase clears the configuration memory and establishes the configuration mode.

The configuration memory is cleared at the rate of one frame per internal clock cycle (nominally 1 MHz). An open-drain bidirectional signal, INIT, is released when the configuration memory is completely cleared. The device then tests for the absence of an external active-low level on INIT. The mode lines are sampled two internal clock cycles later (nominally 2  $\mu\text{s}$ ).

The master device waits an additional 32  $\mu\text{s}$  to 256  $\mu\text{s}$  (nominally 64-128  $\mu\text{s}$ ) to provide adequate time for all of the slave devices to recognize the release of INIT as well. Then the master device enters the Configuration phase.



**Figure 24: Configuration Sequence**



X6700

**Figure 25: Start-up Timing**

## Configuration

The length counter begins counting immediately upon entry into the configuration state. In slave-mode operation it is important to wait at least two cycles of the internal 1-MHz clock oscillator after  $\overline{\text{INIT}}$  is recognized before toggling CCLK and feeding the serial bitstream. Configuration will not begin until the internal configuration logic reset is released, which happens two cycles after  $\overline{\text{INIT}}$  goes High. A master device's configuration is delayed from 32 to 256  $\mu\text{s}$  to ensure proper operation with any slave devices driven by the master device.

The 0010 preamble code, included for all modes except Express mode, indicates that the following 24 bits represent the length count. The length count is the total number of configuration clocks needed to load the complete configuration data. (Four additional configuration clocks are required to complete the configuration process, as discussed below.) After the preamble and the length count have been passed through to all devices in the daisy chain, DOUT is held High to prevent frame start bits from reaching any daisy-chained devices. In Express mode, the length count bits are ignored, and DOUT is held Low, to disable the next device in the pseudo daisy chain.

A specific configuration bit, early in the first frame of a master device, controls the configuration-clock rate and can increase it by a factor of eight. Therefore, if a fast configuration clock is selected by the bitstream, the slower clock rate is used until this configuration bit is detected.

Each frame has a start field followed by the frame-configuration data bits and a frame error field. If a frame data error is detected, the FPGA halts loading, and signals the error by pulling the open-drain  $\overline{\text{INIT}}$  pin Low. After all configuration frames have been loaded into an FPGA, DOUT again follows the input data so that the remaining data is passed on to the next device. In Express mode, when the first device is fully programmed, DOUT goes High to enable the next device in the chain.

### Delaying Configuration After Power-Up

To delay master mode configuration after power-up, pull the bidirectional  $\overline{\text{INIT}}$  pin Low, using an open-collector (open-drain) driver. (See [Figure 12](#).)

Using an open-collector or open-drain driver to hold  $\overline{\text{INIT}}$  Low before the beginning of master mode configuration causes the FPGA to wait after completing the configuration memory clear operation. When  $\overline{\text{INIT}}$  is no longer held Low externally, the device determines its configuration mode by capturing its mode pins, and is ready to start the configuration process. A master device waits up to an additional 250  $\mu\text{s}$  to make sure that any slaves in the optional daisy chain have seen that  $\overline{\text{INIT}}$  is High.

## Start-Up

Start-up is the transition from the configuration process to the intended user operation. This transition involves a change from one clock source to another, and a change from interfacing parallel or serial configuration data where most outputs are 3-stated, to normal operation with I/O pins active in the user-system. Start-up must make sure that the user-logic 'wakes up' gracefully, that the outputs become active without causing contention with the configuration signals, and that the internal flip-flops are released from the global Reset at the right time.

[Figure 25](#) describes start-up timing for the three Xilinx families in detail. Express mode configuration always uses either CCLK\_SYNC or UCLK\_SYNC timing, the other configuration modes can use any of the four timing sequences.

To access the internal start-up signals, place the STARTUP library symbol.

### Start-up Timing

Different FPGA families have different start-up sequences.

The XC2000 family goes through a fixed sequence. DONE goes High and the internal global Reset is de-activated one CCLK period after the I/O become active.

The XC3000A family offers some flexibility. DONE can be programmed to go High one CCLK period before or after the I/O become active. Independent of DONE, the internal global Reset is de-activated one CCLK period before or after the I/O become active.

The XC4000/XC5200 Series offers additional flexibility. The three events — DONE going High, the internal Reset being de-activated, and the user I/O going active — can all occur in any arbitrary sequence. Each of them can occur one CCLK period before or after, or simultaneous with, any of the others. This relative timing is selected by means of software options in the bitstream generation software.

The default option, and the most practical one, is for DONE to go High first, disconnecting the configuration data source and avoiding any contention when the I/Os become active one clock later. Reset is then released another clock period later to make sure that user-operation starts from stable internal conditions. This is the most common sequence, shown with heavy lines in [Figure 25](#), but the designer can modify it to meet particular requirements.

Normally, the start-up sequence is controlled by the internal device oscillator output (CCLK), which is asynchronous to the system clock.

XC4000/XC5200 Series offers another start-up clocking option, UCLK\_NOSYNC. The three events described above need not be triggered by CCLK. They can, as a configuration option, be triggered by a user clock. This means that the device can wake up in synchronism with the user system.

When the UCLK\_SYNC option is enabled, the user can externally hold the open-drain DONE output Low, and thus stall all further progress in the start-up sequence until DONE is released and has gone High. This option can be used to force synchronization of several FPGAs to a common user clock, or to guarantee that all devices are successfully configured before any I/Os go active.

If either of these two options is selected, and no user clock is specified in the design or attached to the device, the chip could reach a point where the configuration of the device is complete and the Done pin is asserted, but the outputs do not become active. The solution is either to recreate the bitstream specifying the start-up clock as CCLK, or to supply the appropriate user clock.

### Start-up Sequence

The Start-up sequence begins when the configuration memory is full, and the total number of configuration clocks received since INIT went High equals the loaded value of the length count.

The next rising clock edge sets a flip-flop Q0, shown in [Figure 26](#). Q0 is the leading bit of a 5-bit shift register. The outputs of this register can be programmed to control three events.

- The release of the open-drain DONE output
- The change of configuration-related pins to the user function, activating all IOBs.
- The termination of the global Set/Reset initialization of all CLB and IOB storage elements.

The DONE pin can also be wire-ANDed with DONE pins of other FPGAs or with other external signals, and can then be used as input to bit Q3 of the start-up register. This is called “Start-up Timing Synchronous to Done In” and is selected by either CCLK\_SYNC or UCLK\_SYNC.

When DONE is not used as an input, the operation is called “Start-up Timing Not Synchronous to DONE In,” and is selected by either CCLK\_NOSYNC or UCLK\_NOSYNC.

As a configuration option, the start-up control register beyond Q0 can be clocked either by subsequent CCLK pulses or from an on-chip user net called STARTUP.CLK. These signals can be accessed by placing the STARTUP library symbol.

### Start-up from CCLK

If CCLK is used to drive the start-up, Q0 through Q3 provide the timing. Heavy lines in [Figure 25](#) show the default timing, which is compatible with XC2000 and XC3000 devices using early DONE and late Reset. The thin lines indicate all other possible timing options.

### Start-up from a User Clock (STARTUP.CLK)

When, instead of CCLK, a user-supplied start-up clock is selected, Q1 is used to bridge the unknown phase relation-

ship between CCLK and the user clock. This arbitration causes an unavoidable one-cycle uncertainty in the timing of the rest of the start-up sequence.

### DONE Goes High to Signal End of Configuration

In all configuration modes except Express mode, XC5200-Series devices read the expected length count from the bitstream and store it in an internal register. The length count varies according to the number of devices and the composition of the daisy chain. Each device also counts the number of CCLKs during configuration.

Two conditions have to be met in order for the DONE pin to go high:

- the chip's internal memory must be full, and
- the configuration length count must be met, *exactly*.

This is important because the counter that determines when the length count is met begins with the very first CCLK, not the first one after the preamble.

Therefore, if a stray bit is inserted before the preamble, or the data source is not ready at the time of the first CCLK, the internal counter that holds the number of CCLKs will be one ahead of the actual number of data bits read. At the end of configuration, the configuration memory will be full, but the number of bits in the internal counter will not match the expected length count.

As a consequence, a Master mode device will continue to send out CCLKs until the internal counter turns over to zero, and then reaches the correct length count a second time. This will take several seconds [ $2^{24} * \text{CCLK period}$ ] — which is sometimes interpreted as the device not configuring at all.

If it is not possible to have the data ready at the time of the first CCLK, the problem can be avoided by increasing the number in the length count by the appropriate value.

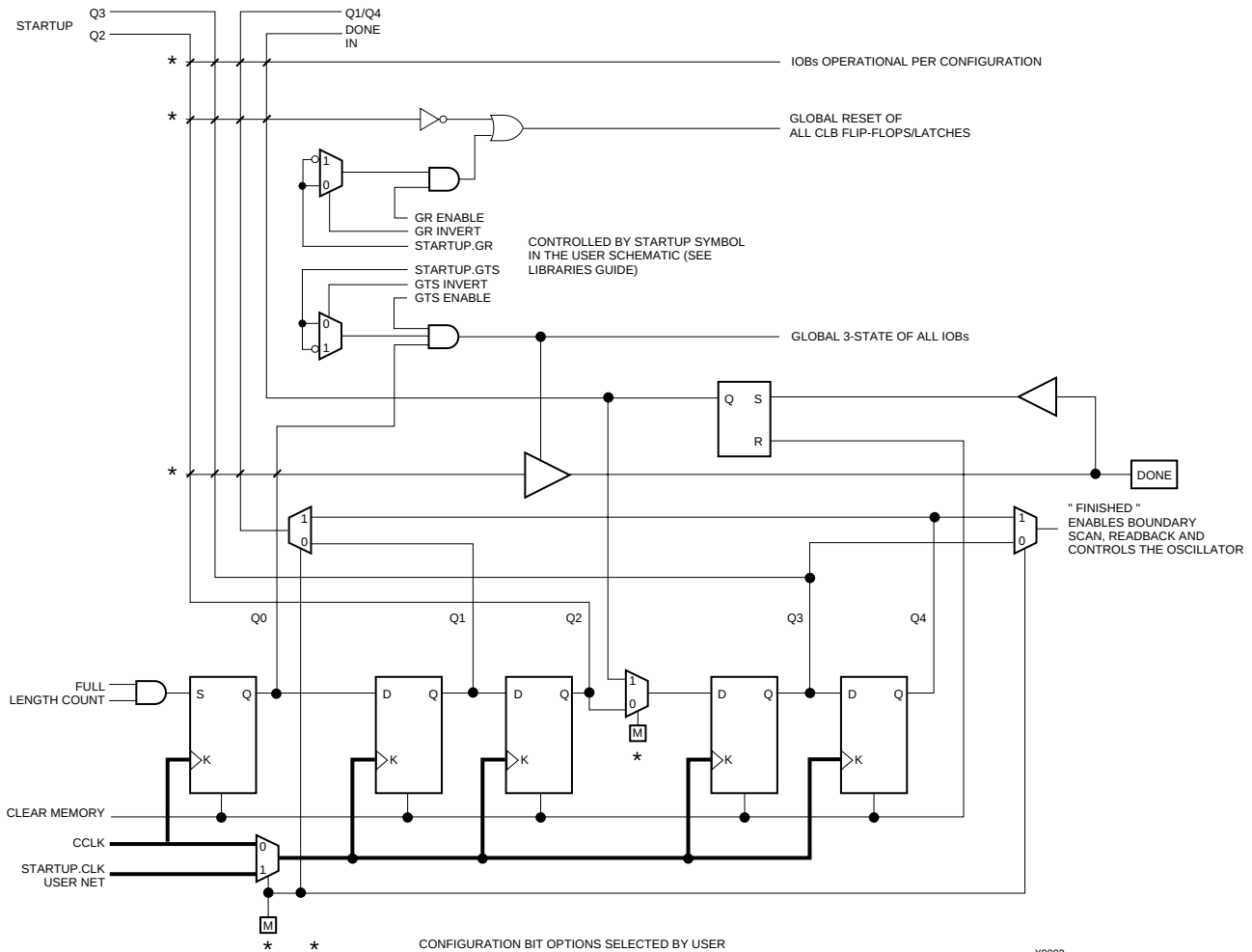
In Express mode, there is no length count. The DONE pin for each device goes High when the device has received its quota of configuration data. Wiring the DONE pins of several devices together delays start-up of all devices until all are fully configured.

Note that DONE is an open-drain output and does not go High unless an internal pull-up is activated or an external pull-up is attached. The internal pull-up is activated as the default by the bitstream generation software.

### Release of User I/O After DONE Goes High

By default, the user I/O are released one CCLK cycle after the DONE pin goes High. If CCLK is not clocked after DONE goes High, the outputs remain in their initial state — 3-stated, with a 20 k $\Omega$  - 100 k $\Omega$  pull-up. The delay from

DONE High to active user I/O is controlled by an option to the bitstream generation software.



**Figure 26: Start-up Logic**

### Release of Global Reset After DONE Goes High

By default, Global Reset (GR) is released two CCLK cycles after the DONE pin goes High. If CCLK is not clocked twice after DONE goes High, all flip-flops are held in their initial reset state. The delay from DONE High to GR inactive is controlled by an option to the bitstream generation software.

### Configuration Complete After DONE Goes High

Three full CCLK cycles are required after the DONE pin goes High, as shown in [Figure 25 on page 109](#). If CCLK is not clocked three times after DONE goes High, readback cannot be initiated and most boundary scan instructions cannot be used.

### Configuration Through the Boundary Scan Pins

XC5200-Series devices can be configured through the boundary scan pins.

For detailed information, refer to the Xilinx application note XAPP017, "Boundary Scan in XC4000 and XC5200 Devices."

### Readback

The user can read back the content of configuration memory and the level of certain internal nodes without interfering with the normal operation of the device.

Readback not only reports the downloaded configuration bits, but can also include the present state of the device, represented by the content of all flip-flops and latches in CLBs.

Note that in XC5200-Series devices, configuration data is *not* inverted with respect to configuration as it is in XC2000 and XC3000 families.

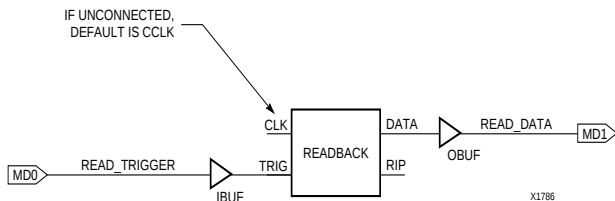
Readback of Express mode bitstreams results in data that does not resemble the original bitstream, because the bitstream format differs from other modes.

XC5200-Series Readback does not use any dedicated pins, but uses four internal nets (RDBK.TRIG, RDBK.DATA, RDBK.RIP and RDBK.CLK) that can be routed to any IOB. To access the internal Readback signals, place the READBACK library symbol and attach the appropriate pad symbols, as shown in [Figure 27](#).

After Readback has been initiated by a Low-to-High transition on RDBK.TRIG, the RDBK.RIP (Read In Progress) output goes High on the next rising edge of RDBK.CLK. Subsequent rising edges of this clock shift out Readback data on the RDBK.DATA net.

Readback data does not include the preamble, but starts with five dummy bits (all High) followed by the Start bit (Low) of the first frame. The first two data bits of the first frame are always High.

Each frame ends with four error check bits. They are read back as High. The last seven bits of the last frame are also read back as High. An additional Start bit (Low) and an 11-bit Cyclic Redundancy Check (CRC) signature follow, before RDBK.RIP returns Low.



**Figure 27: Readback Schematic Example**

### Readback Options

Readback options are: Read Capture, Read Abort, and Clock Select. They are set with the bitstream generation software.

#### Read Capture

When the Read Capture option is selected, the readback data stream includes sampled values of CLB and IOB signals. The rising edge of RDBK.TRIG latches the inverted values of the CLB outputs and the IOB output and input signals. Note that while the bits describing configuration (interconnect and function generators) are *not* inverted, the CLB and IOB output signals *are* inverted.

When the Read Capture option is not selected, the values of the capture bits reflect the configuration data originally written to those memory locations.

The readback signals are located in the lower-left corner of the device.

#### Read Abort

When the Read Abort option is selected, a High-to-Low transition on RDBK.TRIG terminates the readback operation and prepares the logic to accept another trigger.

After an aborted readback, additional clocks (up to one readback clock per configuration frame) may be required to re-initialize the control logic. The status of readback is indicated by the output control net RDBK.RIP. RDBK.RIP is High whenever a readback is in progress.

#### Clock Select

CCLK is the default clock. However, the user can insert another clock on RDBK.CLK. Readback control and data are clocked on rising edges of RDBK.CLK. If readback must be inhibited for security reasons, the readback control nets are simply not connected.

### Violating the Maximum High and Low Time Specification for the Readback Clock

The readback clock has a maximum High and Low time specification. In some cases, this specification cannot be met. For example, if a processor is controlling readback, an interrupt may force it to stop in the middle of a readback. This necessitates stopping the clock, and thus violating the specification.

The specification is mandatory only on clocking data at the end of a frame prior to the next start bit. The transfer mechanism will load the data to a shift register during the last six clock cycles of the frame, prior to the start bit of the following frame. This loading process is dynamic, and is the source of the maximum High and Low time requirements.

Therefore, the specification only applies to the six clock cycles prior to and including any start bit, including the clocks before the first start bit in the readback data stream. At other times, the frame data is already in the register and the register is not dynamic. Thus, it can be shifted out just like a regular shift register.

The user must precisely calculate the location of the readback data relative to the frame. The system must keep track of the position within a data frame, and disable interrupts before frame boundaries. Frame lengths and data formats are listed in [Table 11](#) and [Table 12](#).

### Readback with the XChecker Cable

The XChecker Universal Download/Readback Cable and Logic Probe uses the readback feature for bitstream verification. It can also display selected internal signals on the PC or workstation screen, functioning as a low-cost in-circuit emulator.

## Configuration Timing

The seven configuration modes are discussed in detail in this section. Timing specifications are included.

### Slave Serial Mode

In Slave Serial mode, an external signal drives the CCLK input of the FPGA. The serial configuration bitstream must be available at the DIN input of the lead FPGA a short setup time before each rising CCLK edge.

The lead FPGA then presents the preamble data—and all data that overflows the lead device—on its DOUT pin.

There is an internal delay of 0.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

Figure 28 shows a full master/slave system. An XC5200-Series device in Slave Serial mode should be connected as shown in the third device from the left.

Slave Serial mode is selected by a <111> on the mode pins (M2, M1, M0). Slave Serial is the default mode if the mode pins are left unconnected, as they have weak pull-up resistors during configuration.

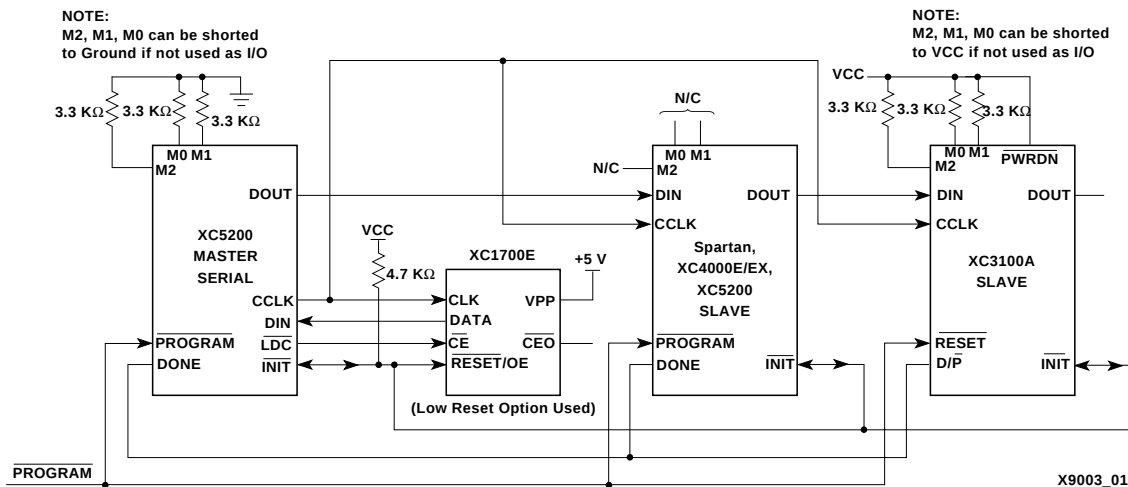
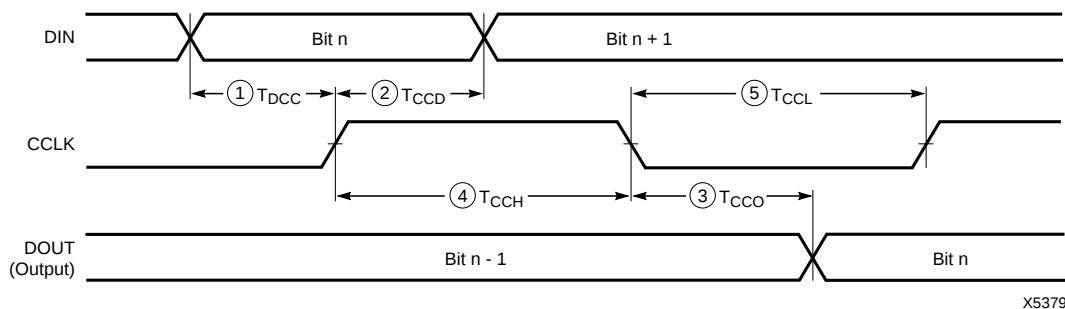


Figure 28: Master/Slave Serial Mode Circuit Diagram



|      | Description | Symbol      | Min | Max | Units |
|------|-------------|-------------|-----|-----|-------|
| CCLK | DIN setup   | 1 $T_{DCC}$ | 20  |     | ns    |
|      | DIN hold    | 2 $T_{CCD}$ | 0   |     | ns    |
|      | DIN to DOUT | 3 $T_{CCO}$ |     | 30  | ns    |
|      | High time   | 4 $T_{CCH}$ | 45  |     | ns    |
|      | Low time    | 5 $T_{CCL}$ | 45  |     | ns    |
|      | Frequency   | $F_{CC}$    |     | 10  | MHz   |

**Note:** Configuration must be delayed until the  $\overline{INIT}$  pins of all daisy-chained FPGAs are High.

Figure 29: Slave Serial Mode Programming Switching Characteristics

### Master Serial Mode

In Master Serial mode, the CCLK output of the lead FPGA drives a Xilinx Serial PROM that feeds the FPGA DIN input. Each rising edge of the CCLK output increments the Serial PROM internal address counter. The next data bit is put on the SPROM data output, connected to the FPGA DIN pin. The lead FPGA accepts this data on the subsequent rising CCLK edge.

The lead FPGA then presents the preamble data—and all data that overflows the lead device—on its DOUT pin. There is an internal pipeline delay of 1.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

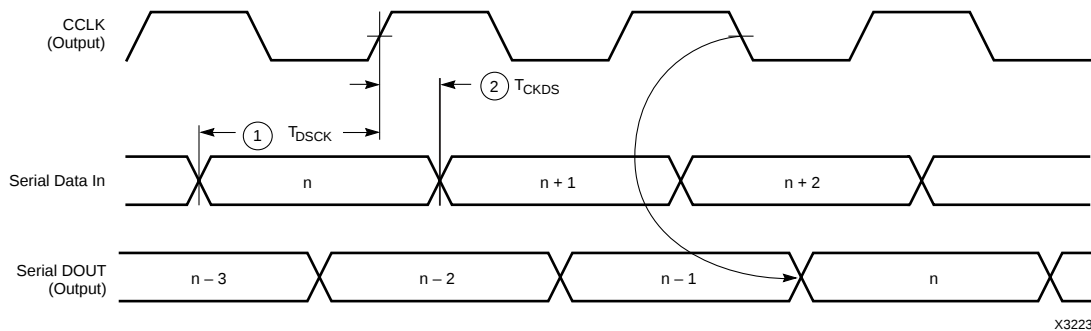
In the bitstream generation software, the user can specify Fast ConfigRate, which, starting several bits into the first frame, increases the CCLK frequency by a factor of twelve.

The value increases from a nominal 1 MHz, to a nominal 12 MHz. Be sure that the serial PROM and slaves are fast enough to support this data rate. The Medium ConfigRate option changes the frequency to a nominal 6 MHz. XC2000, XC3000/A, and XC3100A devices do not support the Fast or Medium ConfigRate options.

The SPROM  $\overline{CE}$  input can be driven from either  $\overline{LDC}$  or  $\overline{DONE}$ . Using  $\overline{LDC}$  avoids potential contention on the DIN pin, if this pin is configured as user-I/O, but  $\overline{LDC}$  is then restricted to be a permanently High user output after configuration. Using  $\overline{DONE}$  can also avoid contention on DIN, provided the  $\overline{DONE}$  before I/O enable option is invoked.

Figure 28 on page 114 shows a full master/slave system. The leftmost device is in Master Serial mode.

Master Serial mode is selected by a <000> on the mode pins (M2, M1, M0).



|      | Description | Symbol       | Min | Max | Units |
|------|-------------|--------------|-----|-----|-------|
| CCLK | DIN setup   | 1 $T_{DSCK}$ | 20  |     | ns    |
|      | DIN hold    | 2 $T_{CKDS}$ | 0   |     | ns    |

Notes: 1. At power-up,  $V_{CC}$  must rise from 2.0 V to  $V_{CC}$  min in less than 25 ms, otherwise delay configuration by pulling  $\overline{PROGRAM}$  Low until  $V_{CC}$  is valid.  
2. Master Serial mode timing is based on testing in slave mode.

**Figure 30: Master Serial Mode Programming Switching Characteristics**

In the two Master Parallel modes, the lead FPGA directly addresses an industry-standard byte-wide EPROM, and accepts eight data bits just before incrementing or decrementing the address outputs.

The eight data bits are serialized in the lead FPGA, which then presents the preamble data—and all data that overflows the lead device—on its DOUT pin. There is an internal delay of 1.5 CCLK periods, after the rising CCLK edge that accepts a byte of data (and also changes the EPROM address) until the falling CCLK edge that makes the LSB (D0) of this byte appear at DOUT. This means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

The PROM address pins can be incremented or decremented, depending on the mode pin settings. This option allows the FPGA to share the PROM with a wide variety of microprocessors and microcontrollers. Some processors must boot from the bottom of memory (all zeros) while others must boot from the top. The FPGA is flexible and can load its configuration bitstream from either end of the memory.

Master Parallel Up mode is selected by a <100> on the mode pins (M2, M1, M0). The EPROM addresses start at 00000 and increment.

Master Parallel Down mode is selected by a <110> on the mode pins. The EPROM addresses start at 3FFFF and decrement.

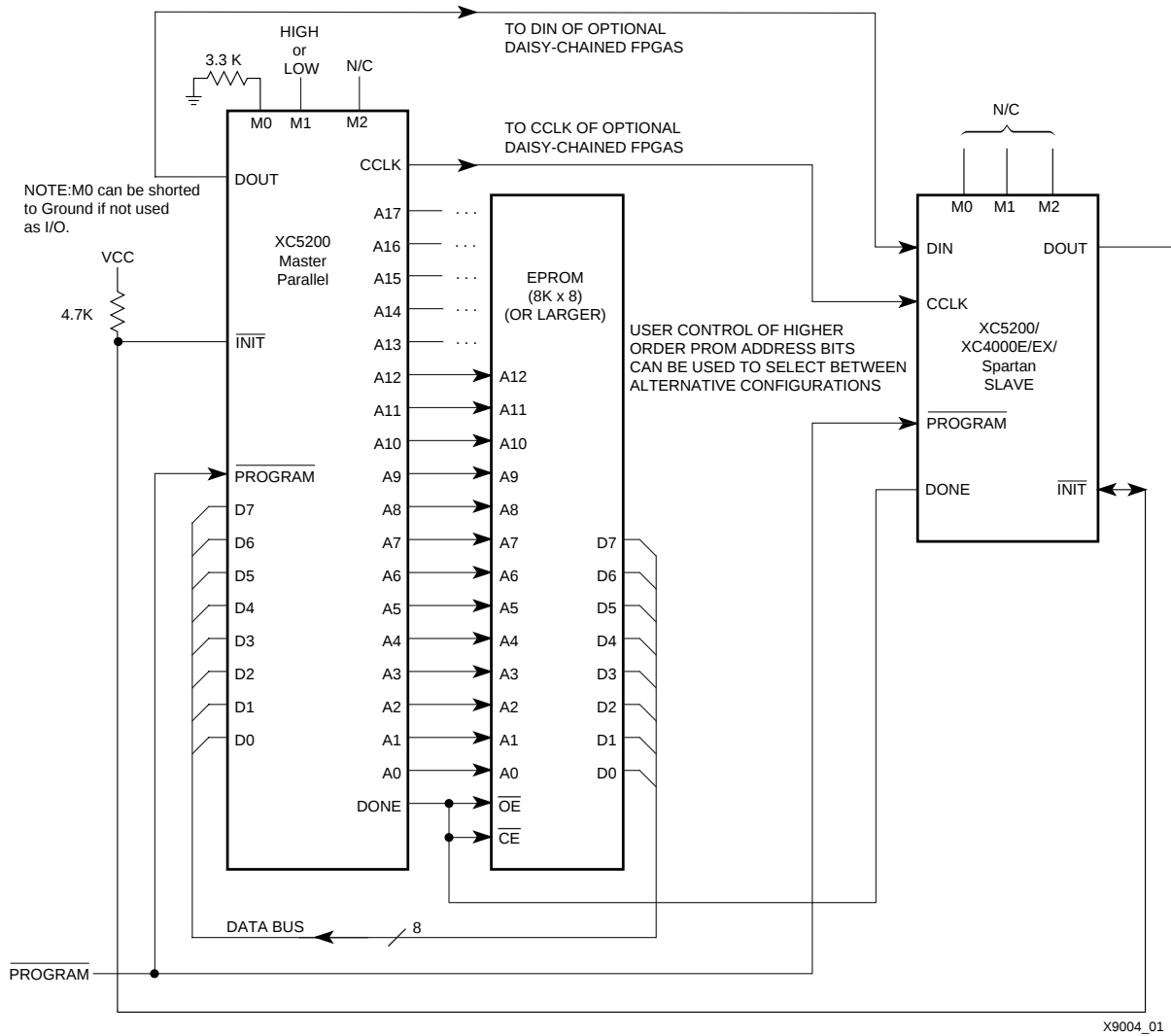
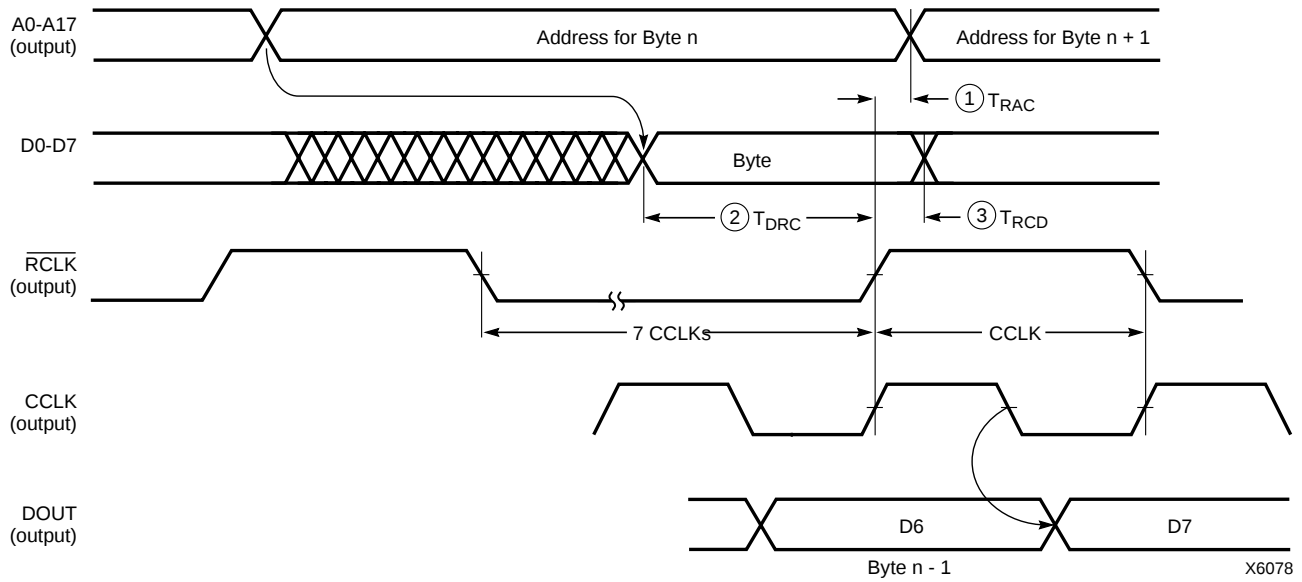


Figure 31: Master Parallel Mode Circuit Diagram



|      | Description            | Symbol      | Min | Max | Units |
|------|------------------------|-------------|-----|-----|-------|
| CCLK | Delay to Address valid | 1 $T_{RAC}$ | 0   | 200 | ns    |
|      | Data setup time        | 2 $T_{DRC}$ | 60  |     | ns    |
|      | Data hold time         | 3 $T_{RCD}$ | 0   |     | ns    |

Note: 1. At power-up,  $V_{CC}$  must rise from 2.0 V to  $V_{CC}$  min in less than 25 ms, otherwise delay configuration by pulling  $\overline{PROGRAM}$  Low until  $V_{CC}$  is Valid.  
2. The first Data byte is loaded and CCLK starts at the end of the first  $\overline{RCLK}$  active cycle (rising edge).

This timing diagram shows that the EPROM requirements are extremely relaxed. EPROM access time can be longer than 500 ns. EPROM data output has no hold-time requirements.

Figure 32: Master Parallel Mode Programming Switching Characteristics

### Synchronous Peripheral Mode

Synchronous Peripheral mode can also be considered Slave Parallel mode. An external signal drives the CCLK input(s) of the FPGA(s). The first byte of parallel configuration data must be available at the Data inputs of the lead FPGA a short setup time before the rising CCLK edge. Subsequent data bytes are clocked in on every eighth consecutive rising CCLK edge.

The same CCLK edge that accepts data, also causes the RDY/BUSY output to go High for one CCLK period. The pin name is a misnomer. In Synchronous Peripheral mode it is really an ACKNOWLEDGE signal. Synchronous operation does not require this response, but it is a meaningful signal

for test purposes. Note that RDY/BUSY is pulled High with a high-impedance pullup prior to INIT going High.

The lead FPGA serializes the data and presents the preamble data (and all data that overflows the lead device) on its DOUT pin. There is an internal delay of 1.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

In order to complete the serial shift operation, 10 additional CCLK rising edges are required after the last data byte has been loaded, plus one more CCLK cycle for each daisy-chained device.

Synchronous Peripheral mode is selected by a <011> on the mode pins (M2, M1, M0).

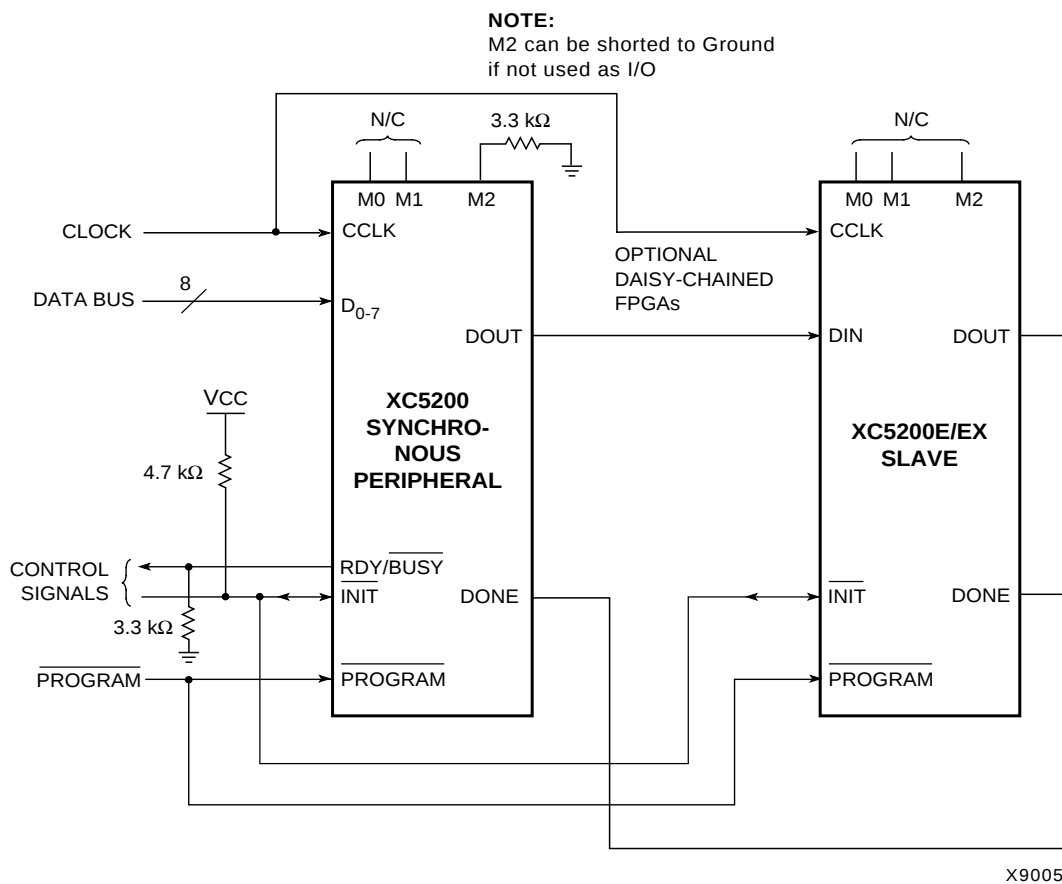
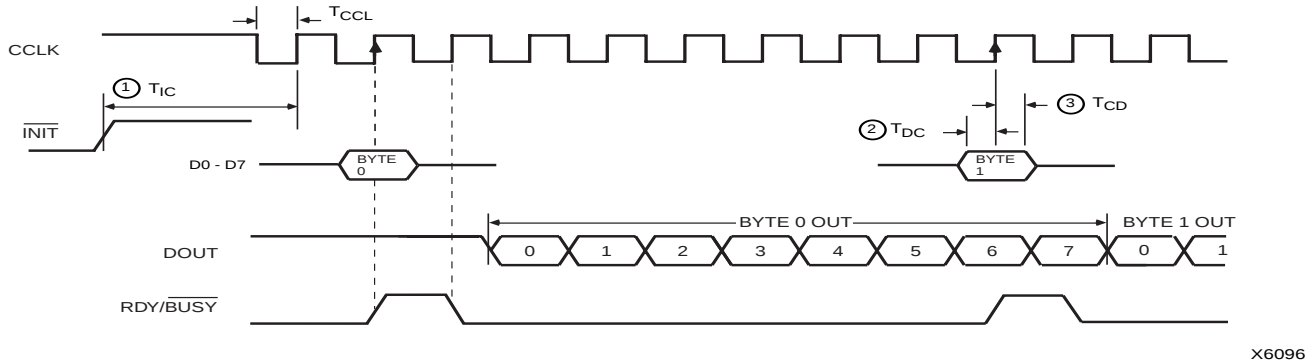


Figure 33: Synchronous Peripheral Mode Circuit Diagram

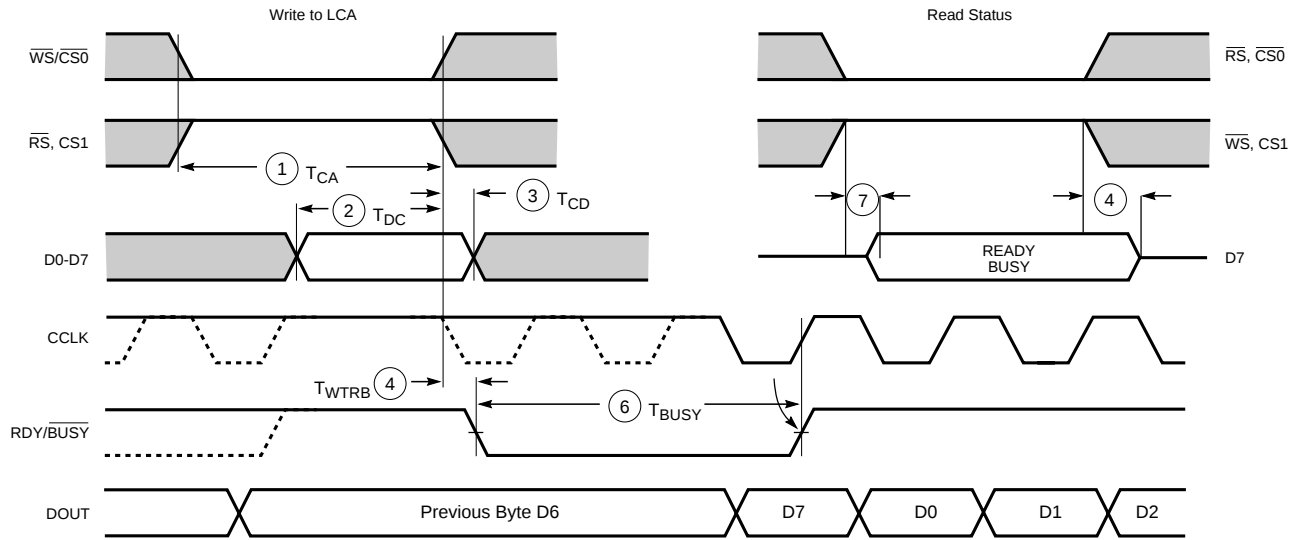


|      | Description            | Symbol     | Min | Max | Units   |
|------|------------------------|------------|-----|-----|---------|
| CCLK | INIT (High) setup time | 1 $T_{IC}$ | 5   |     | $\mu s$ |
|      | D0 - D7 setup time     | 2 $T_{DC}$ | 60  |     | ns      |
|      | D0 - D7 hold time      | 3 $T_{CD}$ | 0   |     | ns      |
|      | CCLK High time         | $T_{CCH}$  | 50  |     | ns      |
|      | CCLK Low time          | $T_{CCL}$  | 60  |     | ns      |
|      | CCLK Frequency         | $F_{CC}$   |     | 8   | MHz     |

- Notes:
1. Peripheral Synchronous mode can be considered Slave Parallel mode. An external CCLK provides timing, clocking in the **first** data byte on the **second** rising edge of CCLK after INIT goes high. Subsequent data bytes are clocked in on every eighth consecutive rising edge of CCLK.
  2. The RDY/BUSY line goes High for one CCLK period after data has been clocked in, although synchronous operation does not require such a response.
  3. The pin name RDY/BUSY is a misnomer. In synchronous peripheral mode this is really an ACKNOWLEDGE signal.
  4. Note that data starts to shift out serially on the DOUT pin 0.5 CCLK periods after it was loaded in parallel. Therefore, additional CCLK pulses are clearly required after the last byte has been loaded.

Figure 34: Synchronous Peripheral Mode Programming Switching Characteristics





X6097

|       | Description                                                                                       | Symbol       | Min | Max | Units           |
|-------|---------------------------------------------------------------------------------------------------|--------------|-----|-----|-----------------|
| Write | Effective Write time<br>( $\overline{CS0}$ , $\overline{WS}$ =Low; $\overline{RS}$ , $CS1$ =High) | 1 $T_{CA}$   | 100 |     | ns              |
|       | DIN setup time                                                                                    | 2 $T_{DC}$   | 60  |     | ns              |
|       | DIN hold time                                                                                     | 3 $T_{CD}$   | 0   |     | ns              |
| RDY   | RDY/BUSY delay after end of<br>Write or Read                                                      | 4 $T_{WTRB}$ |     | 60  | ns              |
|       | RDY/BUSY active after beginning<br>of Read                                                        | 7            |     | 60  | ns              |
|       | RDY/BUSY Low output (Note 4)                                                                      | 6 $T_{BUSY}$ | 2   | 9   | CCLK<br>periods |

- Notes:
1. Configuration must be delayed until  $\overline{INIT}$  pins of all daisy-chained FPGAs are high.
  2. The time from the end of  $\overline{WS}$  to CCLK cycle for the new byte of data depends on the completion of previous byte processing and the phase of internal timing generator for CCLK.
  3. CCLK and DOUT timing is tested in slave mode.
  4.  $T_{BUSY}$  indicates that the double-buffered parallel-to-serial converter is not yet ready to receive new data. The shortest  $T_{BUSY}$  occurs when a byte is loaded into an empty parallel-to-serial converter. The longest  $T_{BUSY}$  occurs when a new word is loaded into the input register before the second-level buffer has started shifting out data.

This timing diagram shows very relaxed requirements. Data need not be held beyond the rising edge of  $\overline{WS}$ . RDY/BUSY will go active within 60 ns after the end of  $\overline{WS}$ . A new write may be asserted immediately after RDY/BUSY goes Low, but write may not be terminated until RDY/BUSY has been High for one CCLK period.

**Figure 36: Asynchronous Peripheral Mode Programming Switching Characteristics**

### Express Mode

Express mode is similar to Slave Serial mode, except that data is processed one byte per CCLK cycle instead of one bit per CCLK cycle. An external source is used to drive CCLK, while byte-wide data is loaded directly into the configuration data shift registers. A CCLK frequency of 10 MHz is equivalent to an 80 MHz serial rate, because eight bits of configuration data are loaded per CCLK cycle. Express mode does not support CRC error checking, but does support constant-field error checking.

In Express mode, an external signal drives the CCLK input of the FPGA device. The first byte of parallel configuration data must be available at the D inputs of the FPGA a short setup time before the second rising CCLK edge. Subsequent data bytes are clocked in on each consecutive rising CCLK edge.

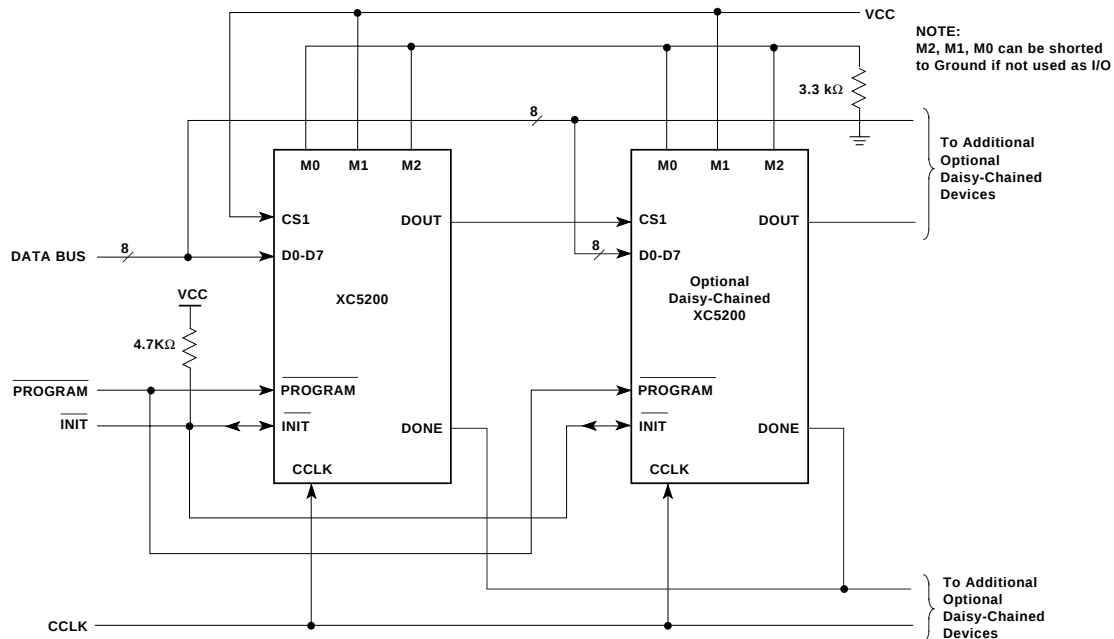
If the first device is configured in Express mode, additional devices may be daisy-chained only if every device in the chain is also configured in Express mode. CCLK pins are tied together and D0-D7 pins are tied together for all devices along the chain. A status signal is passed from DOUT to CS1 of successive devices along the chain. The lead device in the chain has its CS1 input tied High (or floating, since there is an internal pullup). Frame data is accepted only when CS1 is High and the device's configu-

ration memory is not already full. The status pin DOUT is pulled Low two internal-oscillator cycles after INIT is recognized as High, and remains Low until the device's configuration memory is full. DOUT is then pulled High to signal the next device in the chain to accept the configuration data on the D0-D7 bus.

The DONE pins of all devices in the chain should be tied together, with one or more active internal pull-ups. If a large number of devices are included in the chain, deactivate some of the internal pull-ups, since the Low-driving DONE pin of the last device in the chain must sink the current from all pull-ups in the chain. The DONE pull-up is activated by default. It can be deactivated using an option in the bitstream generation software.

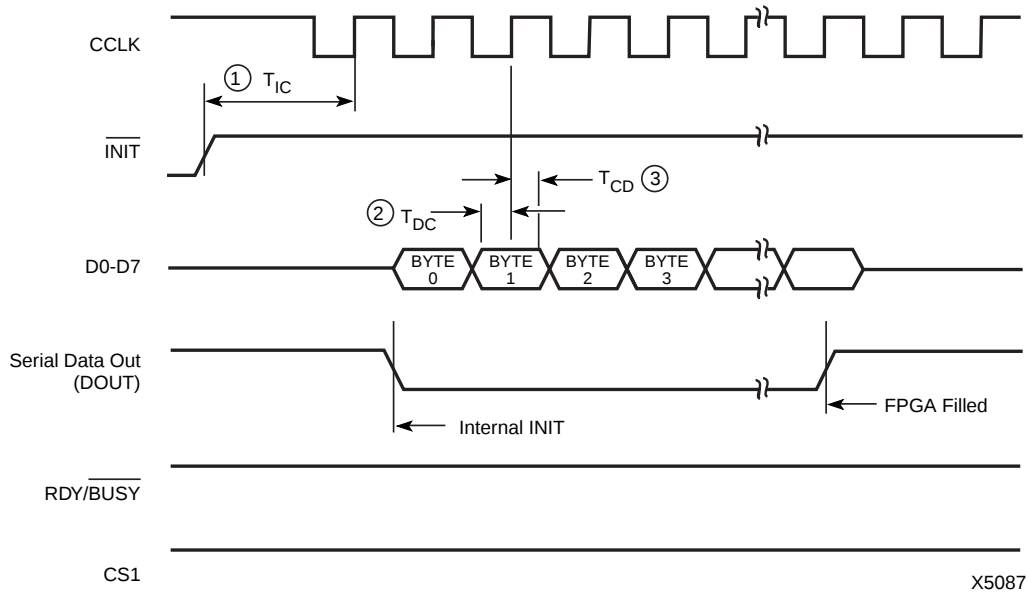
XC5200 devices in Express mode are always synchronized to DONE. The device becomes active after DONE goes High. DONE is an open-drain output. With the DONE pins tied together, therefore, the external DONE signal stays low until all devices are configured, then all devices in the daisy chain become active simultaneously. If the DONE pin of a device is left unconnected, the device becomes active as soon as that device has been configured.

Express mode is selected by a <010> on the mode pins (M2, M1, M0).



X6611\_01

Figure 37: Express Mode Circuit Diagram



|      | Description                     | Symbol |           | Min | Max | Units   |
|------|---------------------------------|--------|-----------|-----|-----|---------|
| CCLK | INIT (High) Setup time required | 1      | $T_{IC}$  | 5   |     | $\mu s$ |
|      | DIN Setup time required         | 2      | $T_{DC}$  | 30  |     | ns      |
|      | DIN hold time required          | 3      | $T_{CD}$  | 0   |     | ns      |
|      | CCLK High time                  |        | $T_{CCH}$ | 30  |     | ns      |
|      | CCLK Low time                   |        | $T_{CCL}$ | 30  |     | ns      |
|      | CCLK frequency                  |        | $F_{CC}$  |     | 10  | MHz     |

Note: If not driven by the preceding DOUT, CS1 must remain high until the device is fully configured.

Figure 38: Express Mode Programming Switching Characteristics

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays

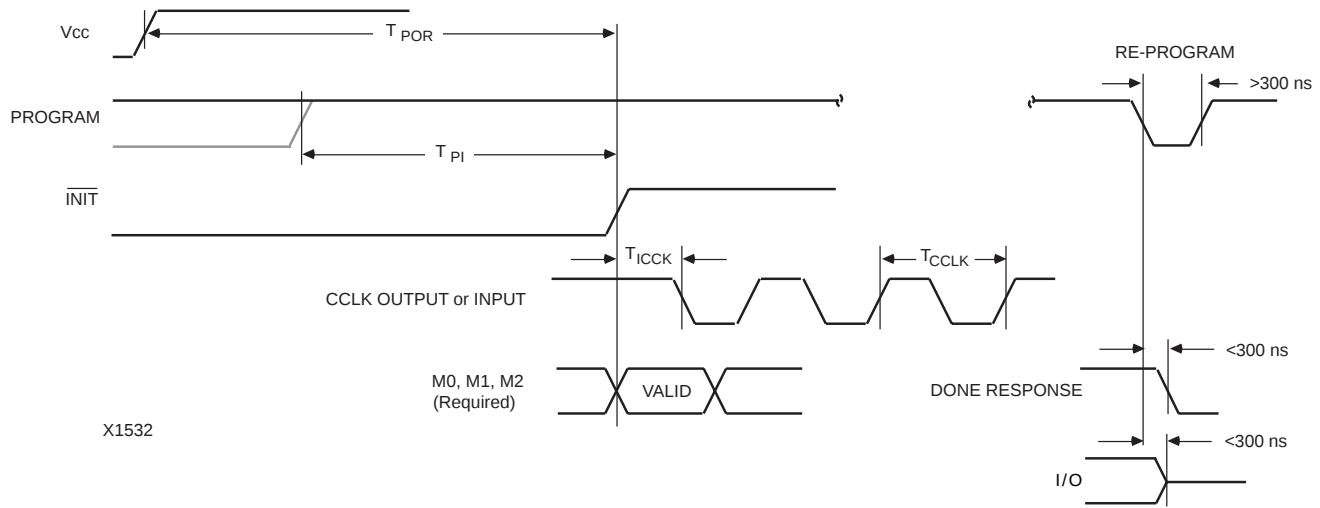


**Table 13. Pin Functions During Configuration**

| CONFIGURATION MODE: <M2:M1:M0> |                       |                       |                        |                        |                       |                    | USER OPERATION |
|--------------------------------|-----------------------|-----------------------|------------------------|------------------------|-----------------------|--------------------|----------------|
| SLAVE<br><1:1:1>               | MASTER-SER<br><0:0:0> | SYN.PERIPH<br><0:1:1> | ASYN.PERIPH<br><1:0:1> | MASTER-HIGH<br><1:1:0> | MASTER-LOW<br><1:0:0> | EXPRESS<br><0:1:0> |                |
|                                |                       |                       |                        | A16                    | A16                   |                    | GCK1-I/O       |
|                                |                       |                       |                        | A17                    | A17                   |                    | I/O            |
| TDI                            | TDI                   | TDI                   | TDI                    | TDI                    | TDI                   | TDI                | TDI-I/O        |
| TCK                            | TCK                   | TCK                   | TCK                    | TCK                    | TCK                   | TCK                | TCK-I/O        |
| TMS                            | TMS                   | TMS                   | TMS                    | TMS                    | TMS                   | TMS                | TMS-I/O        |
|                                |                       |                       |                        |                        |                       |                    | I/O            |
| M1 (HIGH) (I)                  | M1 (LOW) (I)          | M1 (HIGH) (I)         | M1 (LOW) (I)           | M1 (HIGH) (I)          | M1 (LOW) (I)          | M1 (HIGH) (I)      | I/O            |
| M0 (HIGH) (I)                  | M0 (LOW) (I)          | M0 (HIGH) (I)         | M0 (HIGH) (I)          | M0 (LOW) (I)           | M0 (LOW) (I)          | M0 (LOW) (I)       | I/O            |
| M2 (HIGH) (I)                  | M2 (LOW) (I)          | M2 (LOW) (I)          | M2 (HIGH) (I)          | M2 (HIGH) (I)          | M2 (HIGH) (I)         | M2 (LOW) (I)       | I/O            |
|                                |                       |                       |                        |                        |                       |                    | GCK2-I/O       |
| HDC (HIGH)                     | HDC (HIGH)            | HDC (HIGH)            | HDC (HIGH)             | HDC (HIGH)             | HDC (HIGH)            | HDC (HIGH)         | I/O            |
| LDC (LOW)                      | LDC (LOW)             | LDC (LOW)             | LDC (LOW)              | LDC (LOW)              | LDC (LOW)             | LDC (LOW)          | I/O            |
| INIT-ERROR                     | INIT-ERROR            | INIT-ERROR            | INIT-ERROR             | INIT-ERROR             | INIT-ERROR            | INIT-ERROR         | I/O            |
|                                |                       |                       |                        |                        |                       |                    | I/O            |
| DONE                           | DONE                  | DONE                  | DONE                   | DONE                   | DONE                  | DONE               | DONE           |
| PROGRAM (I)                    | PROGRAM (I)           | PROGRAM (I)           | PROGRAM (I)            | PROGRAM (I)            | PROGRAM (I)           | PROGRAM (I)        | PROGRAM        |
|                                |                       | DATA 7 (I)            | DATA 7 (I)             | DATA 7 (I)             | DATA 7 (I)            | DATA 7 (I)         | I/O            |
|                                |                       |                       |                        |                        |                       |                    | GCK3-I/O       |
|                                |                       | DATA 6 (I)            | DATA 6 (I)             | DATA 6 (I)             | DATA 6 (I)            | DATA 6 (I)         | I/O            |
|                                |                       | DATA 5 (I)            | DATA 5 (I)             | DATA 5 (I)             | DATA 5 (I)            | DATA 5 (I)         | I/O            |
|                                |                       |                       | CS0 (I)                |                        |                       |                    | I/O            |
|                                |                       | DATA 4 (I)            | DATA 4 (I)             | DATA 4 (I)             | DATA 4 (I)            | DATA 4 (I)         | I/O            |
|                                |                       | DATA 3 (I)            | DATA 3 (I)             | DATA 3 (I)             | DATA 3 (I)            | DATA 3 (I)         | I/O            |
|                                |                       |                       | RS (I)                 |                        |                       |                    | I/O            |
|                                |                       | DATA 2 (I)            | DATA 2 (I)             | DATA 2 (I)             | DATA 2 (I)            | DATA 2 (I)         | I/O            |
|                                |                       | DATA 1 (I)            | DATA 1 (I)             | DATA 1 (I)             | DATA 1 (I)            | DATA 1 (I)         | I/O            |
|                                |                       | RDY/BUSY              | RDY/BUSY               | RCLK                   | RCLK                  |                    | I/O            |
| DIN (I)                        | DIN (I)               | DATA 0 (I)            | DATA 0 (I)             | DATA 0 (I)             | DATA 0 (I)            | DATA 0 (I)         | I/O            |
| DOUT                           | DOUT                  | DOUT                  | DOUT                   | DOUT                   | DOUT                  | DOUT               | I/O            |
| CCLK (I)                       | CCLK (O)              | CCLK (I)              | CCLK (O)               | CCLK (O)               | CCLK (O)              | CCLK (I)           | CCLK (I)       |
| TDO                            | TDO                   | TDO                   | TDO                    | TDO                    | TDO                   | TDO                | TDO-I/O        |
|                                |                       |                       | WS (I)                 | A0                     | A0                    |                    | I/O            |
|                                |                       |                       |                        | A1                     | A1                    |                    | GCK4-I/O       |
|                                |                       |                       | CS1 (I)                | A2                     | A2                    | CS1 (I)            | I/O            |
|                                |                       |                       |                        | A3                     | A3                    |                    | I/O            |
|                                |                       |                       |                        | A4                     | A4                    |                    | I/O            |
|                                |                       |                       |                        | A5                     | A5                    |                    | I/O            |
|                                |                       |                       |                        | A6                     | A6                    |                    | I/O            |
|                                |                       |                       |                        | A7                     | A7                    |                    | I/O            |
|                                |                       |                       |                        | A8                     | A8                    |                    | I/O            |
|                                |                       |                       |                        | A9                     | A9                    |                    | I/O            |
|                                |                       |                       |                        | A10                    | A10                   |                    | I/O            |
|                                |                       |                       |                        | A11                    | A11                   |                    | I/O            |
|                                |                       |                       |                        | A12                    | A12                   |                    | I/O            |
|                                |                       |                       |                        | A13                    | A13                   |                    | I/O            |
|                                |                       |                       |                        | A14                    | A14                   |                    | I/O            |
|                                |                       |                       |                        | A15                    | A15                   |                    | I/O            |
|                                |                       |                       |                        |                        |                       |                    | ALL OTHERS     |

- Notes:**
1. A shaded table cell represents a 20-kΩ to 100-kΩ pull-up resistor before and during configuration.
  2. (I) represents an input (O) represents an output.
  3. INIT is an open-drain output during configuration.

## Configuration Switching Characteristics



## Master Modes

| Description         | Symbol     | Min | Max  | Units                  |
|---------------------|------------|-----|------|------------------------|
| Power-On-Reset      | $T_{POR}$  | 2   | 15   | ms                     |
| Program Latency     | $T_{PI}$   | 6   | 70   | $\mu$ s per CLB column |
| CCLK (output) Delay | $T_{ICCK}$ | 40  | 375  | $\mu$ s                |
| period (slow)       | $T_{CCLK}$ | 640 | 3000 | ns                     |
| period (fast)       | $T_{CCLK}$ | 100 | 375  | ns                     |

7

## Slave and Peripheral Modes

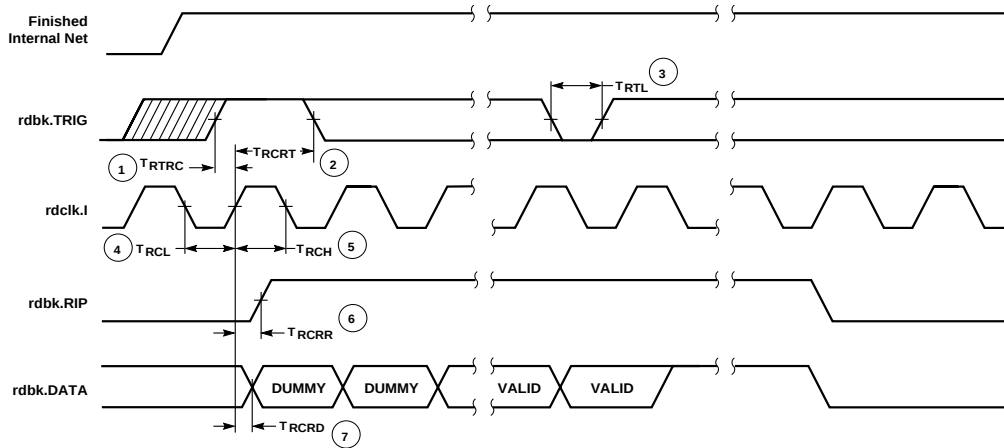
| Description                   | Symbol     | Min | Max | Units                  |
|-------------------------------|------------|-----|-----|------------------------|
| Power-On-Reset                | $T_{POR}$  | 2   | 15  | ms                     |
| Program Latency               | $T_{PI}$   | 6   | 70  | $\mu$ s per CLB column |
| CCLK (input) Delay (required) | $T_{ICCK}$ | 5   |     | $\mu$ s                |
| period (required)             | $T_{CCLK}$ | 100 |     | ns                     |

**Note:** At power-up,  $V_{CC}$  must rise from 2.0 to  $V_{CC}$  min in less than 15 ms, otherwise delay configuration using PROGRAM until  $V_{CC}$  is valid.

### XC5200 Program Readback Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Internal timing parameters are not measured directly. They are derived from benchmark timing patterns that are taken at device introduction, prior to any process improvements.

The following guidelines reflect worst-case values over the recommended operating conditions.



X1790

|           | Description                                    | Symbol       | Min | Max | Units |
|-----------|------------------------------------------------|--------------|-----|-----|-------|
| rdbk.TRIG | rdbk.TRIG setup to initiate and abort Readback | 1 $T_{RTRC}$ | 200 | -   | ns    |
|           | rdbk.TRIG hold to initiate and abort Readback  | 2 $T_{RCRT}$ | 50  | -   | ns    |
| rdclk.1   | rdbk.DATA delay                                | 7 $T_{RCRD}$ | -   | 250 | ns    |
|           | rdbk.RIP delay                                 | 6 $T_{RCRR}$ | -   | 250 | ns    |
|           | High time                                      | 5 $T_{RCH}$  | 250 | 500 | ns    |
|           | Low time                                       | 4 $T_{RCL}$  | 250 | 500 | ns    |

Note 1: Timing parameters apply to all speed grades.

Note 2: rdbk.TRIG is High prior to Finished, Finished will trigger the first Readback

### XC5200 Switching Characteristics

#### Definition of Terms

In the following tables, some specifications may be designated as Advance or Preliminary. These terms are defined as follows:

**Advance:** Initial estimates based on simulation and/or extrapolation from other speed grades, devices, or device families. Use as estimates, not for production.

**Preliminary:** Based on preliminary characterization. Further changes are not expected.

**Unmarked:** Specifications not identified as either Advance or Preliminary are to be considered Final.<sup>1</sup>

#### XC5200 Operating Conditions

| Symbol    | Description                                                        | Min  | Max      | Units    |
|-----------|--------------------------------------------------------------------|------|----------|----------|
| $V_{CC}$  | Supply voltage relative to GND Commercial: 0°C to 85°C junction    | 4.75 | 5.25     | V        |
|           | Supply voltage relative to GND Industrial: -40°C to 100°C junction | 4.5  | 5.5      | V        |
| $V_{IHT}$ | High-level input voltage — TTL configuration                       | 2.0  | $V_{CC}$ | V        |
| $V_{ILT}$ | Low-level input voltage — TTL configuration                        | 0    | 0.8      | V        |
| $V_{IHC}$ | High-level input voltage — CMOS configuration                      | 70%  | 100%     | $V_{CC}$ |
| $V_{ILC}$ | Low-level input voltage — CMOS configuration                       | 0    | 20%      | $V_{CC}$ |
| $T_{IN}$  | Input signal transition time                                       |      | 250      | ns       |

#### XC5200 DC Characteristics Over Operating Conditions

| Symbol    | Description                                                  | Min  | Max  | Units   |
|-----------|--------------------------------------------------------------|------|------|---------|
| $V_{OH}$  | High-level output voltage @ $I_{OH} = -8.0$ mA, $V_{CC}$ min | 3.86 |      | V       |
| $V_{OL}$  | Low-level output voltage @ $I_{OL} = 8.0$ mA, $V_{CC}$ max   |      | 0.4  | V       |
| $I_{CCO}$ | Quiescent FPGA supply current (Note 1)                       |      | 15   | mA      |
| $I_{IL}$  | Leakage current                                              | -10  | +10  | $\mu$ A |
| $C_{IN}$  | Input capacitance (sample tested)                            |      | 15   | pF      |
| $I_{RIN}$ | Pad pull-up (when selected) @ $V_{IN} = 0$ V (sample tested) | 0.02 | 0.30 | mA      |

Note: 1. With no output current loads, all package pins at  $V_{CC}$  or GND, either TTL or CMOS inputs, and the FPGA configured with a tie option.

#### XC5200 Absolute Maximum Ratings

| Symbol    | Description                                              |                        | Units |
|-----------|----------------------------------------------------------|------------------------|-------|
| $V_{CC}$  | Supply voltage relative to GND                           | -0.5 to +7.0           | V     |
| $V_{IN}$  | Input voltage with respect to GND                        | -0.5 to $V_{CC} + 0.5$ | V     |
| $V_{TS}$  | Voltage applied to 3-state output                        | -0.5 to $V_{CC} + 0.5$ | V     |
| $T_{STG}$ | Storage temperature (ambient)                            | -65 to +150            | °C    |
| $T_{SOL}$ | Maximum soldering temperature (10 s @ 1/16 in. = 1.5 mm) | +260                   | °C    |
| $T_J$     | Junction temperature in plastic packages                 | +125                   | °C    |
|           | Junction temperature in ceramic packages                 | +150                   | °C    |

**Note:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect device reliability.

1. Notwithstanding the definition of the above terms, all specifications are subject to change without notice.

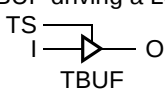
### XC5200 Global Buffer Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Since many internal timing parameters cannot be measured directly, they are derived from benchmark timing patterns. The following guidelines reflect worst-case values over the recommended operating conditions. For more detailed, more precise, and more up-to-date timing information, use the values provided by the timing calculator and used in the simulator.

| Speed Grade                                                                            |                   |        | -6       | -5       | -4       | -3       |
|----------------------------------------------------------------------------------------|-------------------|--------|----------|----------|----------|----------|
| Description                                                                            | Symbol            | Device | Max (ns) | Max (ns) | Max (ns) | Max (ns) |
| <b>Global Signal Distribution</b><br>From pad through global buffer, to any clock (CK) | $T_{\text{BUFG}}$ | XC5202 | 9.1      | 8.5      | 8.0      | 6.9      |
|                                                                                        |                   | XC5204 | 9.3      | 8.7      | 8.2      | 7.6      |
|                                                                                        |                   | XC5206 | 9.4      | 8.8      | 8.3      | 7.7      |
|                                                                                        |                   | XC5210 | 9.4      | 8.8      | 8.5      | 7.7      |
|                                                                                        |                   | XC5215 | 10.5     | 9.9      | 9.8      | 9.6      |

### XC5200 Longline Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Since many internal timing parameters cannot be measured directly, they are derived from benchmark timing patterns. The following guidelines reflect worst-case values over the recommended operating conditions. For more detailed, more precise, and more up-to-date timing information, use the values provided by the timing calculator and used in the simulator.

| Speed Grade                                                                                                                                                                                |                  |        | -6       | -5       | -4       | -3       |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|--------|----------|----------|----------|----------|
| Description                                                                                                                                                                                | Symbol           | Device | Max (ns) | Max (ns) | Max (ns) | Max (ns) |
| <b>TBUF driving a Longline</b><br><br>I to Longline, while TS is Low; i.e., buffer is constantly active | $T_{\text{IO}}$  | XC5202 | 6.0      | 3.8      | 3.0      | 2.0      |
|                                                                                                                                                                                            |                  | XC5204 | 6.4      | 4.1      | 3.2      | 2.3      |
|                                                                                                                                                                                            |                  | XC5206 | 6.6      | 4.2      | 3.3      | 2.7      |
|                                                                                                                                                                                            |                  | XC5210 | 6.6      | 4.2      | 3.3      | 2.9      |
|                                                                                                                                                                                            |                  | XC5215 | 7.3      | 4.6      | 3.8      | 3.2      |
| TS going Low to Longline going from floating High or Low to active Low or High                                                                                                             | $T_{\text{ON}}$  | XC5202 | 7.8      | 5.6      | 4.7      | 4.0      |
|                                                                                                                                                                                            |                  | XC5204 | 8.3      | 5.9      | 4.9      | 4.3      |
|                                                                                                                                                                                            |                  | XC5206 | 8.4      | 6.0      | 5.0      | 4.4      |
|                                                                                                                                                                                            |                  | XC5210 | 8.4      | 6.0      | 5.0      | 4.4      |
|                                                                                                                                                                                            |                  | XC5215 | 8.9      | 6.3      | 5.3      | 4.5      |
| TS going High to TBUF going inactive, not driving Longline                                                                                                                                 | $T_{\text{OFF}}$ | XC52xx | 3.0      | 2.8      | 2.6      | 2.4      |

**Note:** 1. Die-size-dependent parameters are based upon XC5215 characterization. Production specifications will vary with array size.

### XC5200 CLB Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Since many internal timing parameters cannot be measured directly, they are derived from benchmark timing patterns. The following guidelines reflect worst-case values over the recommended operating conditions. For more detailed, more precise, and more up-to-date timing information, use the values provided by the timing calculator and used in the simulator.

| Speed Grade                                     |                        | -6       |          | -5       |          | -4       |          | -3       |          |
|-------------------------------------------------|------------------------|----------|----------|----------|----------|----------|----------|----------|----------|
| Description                                     | Symbol                 | Min (ns) | Max (ns) | Min (ns) | Max (ns) | Min (ns) | Max (ns) | Min (ns) | Max (ns) |
| <b>Combinatorial Delays</b>                     |                        |          |          |          |          |          |          |          |          |
| F inputs to X output                            | $T_{ILO}$              |          | 5.6      |          | 4.6      |          | 3.8      |          | 3.0      |
| F inputs via transparent latch to Q             | $T_{ITO}$              |          | 8.0      |          | 6.6      |          | 5.4      |          | 4.3      |
| DI inputs to DO output (Logic-Cell Feedthrough) | $T_{IDO}$              |          | 4.3      |          | 3.5      |          | 2.8      |          | 2.4      |
| F inputs via F5_MUX to DO output                | $T_{IMO}$              |          | 7.2      |          | 5.8      |          | 5.0      |          | 4.3      |
| <b>Carry Delays</b>                             |                        |          |          |          |          |          |          |          |          |
| Incremental delay per bit                       | $T_{CY}$               |          | 0.7      |          | 0.6      |          | 0.5      |          | 0.5      |
| Carry-in overhead from DI                       | $T_{CYDI}$             |          | 1.8      |          | 1.6      |          | 1.5      |          | 1.4      |
| Carry-in overhead from F                        | $T_{CYL}$              |          | 3.7      |          | 3.2      |          | 2.9      |          | 2.4      |
| Carry-out overhead to DO                        | $T_{CYO}$              |          | 4.0      |          | 3.2      |          | 2.5      |          | 2.1      |
| <b>Sequential Delays</b>                        |                        |          |          |          |          |          |          |          |          |
| Clock (CK) to out (Q) (Flip-Flop)               | $T_{CKO}$              |          | 5.8      |          | 4.9      |          | 4.0      |          | 4.0      |
| Gate (Latch enable) going active to out (Q)     | $T_{GO}$               |          | 9.2      |          | 7.4      |          | 5.9      |          | 5.5      |
| <b>Set-up Time Before Clock (CK)</b>            |                        |          |          |          |          |          |          |          |          |
| F inputs                                        | $T_{ICK}$              | 2.3      |          | 1.8      |          | 1.4      |          | 1.3      |          |
| F inputs via F5_MUX                             | $T_{MICK}$             | 3.8      |          | 3.0      |          | 2.5      |          | 2.4      |          |
| DI input                                        | $T_{DICK}$             | 0.8      |          | 0.5      |          | 0.4      |          | 0.4      |          |
| CE input                                        | $T_{EICK}$             | 1.6      |          | 1.2      |          | 0.9      |          | 0.9      |          |
| <b>Hold Times After Clock (CK)</b>              |                        |          |          |          |          |          |          |          |          |
| F inputs                                        | $T_{CKI}$              | 0        |          | 0        |          | 0        |          | 0        |          |
| F inputs via F5_MUX                             | $T_{CKMI}$             | 0        |          | 0        |          | 0        |          | 0        |          |
| DI input                                        | $T_{CKDI}$             | 0        |          | 0        |          | 0        |          | 0        |          |
| CE input                                        | $T_{CKEI}$             | 0        |          | 0        |          | 0        |          | 0        |          |
| <b>Clock Widths</b>                             |                        |          |          |          |          |          |          |          |          |
| Clock High Time                                 | $T_{CH}$               | 6.0      |          | 6.0      |          | 6.0      |          | 6.0      |          |
| Clock Low Time                                  | $T_{CL}$               | 6.0      |          | 6.0      |          | 6.0      |          | 6.0      |          |
| Toggle Frequency (MHz) (Note 3)                 | $F_{TOG}$              |          | 83       |          | 83       |          | 83       |          | 83       |
| <b>Reset Delays</b>                             |                        |          |          |          |          |          |          |          |          |
| Width (High)                                    | $T_{CLR\overline{W}}$  | 6.0      |          | 6.0      |          | 6.0      |          | 6.0      |          |
| Delay from CLR to Q (Flip-Flop)                 | $T_{CLR}$              |          | 7.7      |          | 6.3      |          | 5.1      |          | 4.0      |
| Delay from CLR to Q (Latch)                     | $T_{CLR\overline{L}}$  |          | 6.5      |          | 5.2      |          | 4.2      |          | 3.0      |
| <b>Global Reset Delays</b>                      |                        |          |          |          |          |          |          |          |          |
| Width (High)                                    | $T_{GCLR\overline{W}}$ | 6.0      |          | 6.0      |          | 6.0      |          | 6.0      |          |
| Delay from internal GR to Q                     | $T_{GCLR}$             |          | 14.7     |          | 12.1     |          | 9.1      |          | 8.0      |

- Note:**
1. The CLB K to Q output delay ( $T_{CKO}$ ) of any CLB, plus the shortest possible interconnect delay, is always longer than the Data In hold-time requirement ( $T_{CKDI}$ ) of any CLB on the same die.
  2. Timing is based upon the XC5215 device. For other devices, see Timing Calculator.
  3. Maximum flip-flop toggle rate for export control purposes.

### XC5200 Guaranteed Input and Output Parameters (Pin-to-Pin)

All values listed below are tested directly, and guaranteed over the operating conditions. The same parameters can also be derived indirectly from the Global Buffer specifications. The delay calculator uses this indirect method, and may overestimate because of worst-case assumptions. When there is a discrepancy between these two methods, the values listed below should be used, and the derived values should be considered conservative overestimates.

|                                                              |                          | Speed Grade | -6       | -5       | -4       | -3       |
|--------------------------------------------------------------|--------------------------|-------------|----------|----------|----------|----------|
| Description                                                  | Symbol                   | Device      | Max (ns) | Max (ns) | Max (ns) | Max (ns) |
| Global Clock to Output Pad (fast)<br>                        | $T_{ICKOF}$<br><br>(Max) | XC5202      | 16.9     | 15.1     | 10.9     | 9.8      |
|                                                              |                          | XC5204      | 17.1     | 15.3     | 11.3     | 9.9      |
|                                                              |                          | XC5206      | 17.2     | 15.4     | 11.9     | 10.8     |
|                                                              |                          | XC5210      | 17.2     | 15.4     | 12.8     | 11.2     |
|                                                              |                          | XC5215      | 19.0     | 17.0     | 12.8     | 11.7     |
| Global Clock to Output Pad (slew-limited)<br>                | $T_{ICKO}$<br><br>(Max)  | XC5202      | 21.4     | 18.7     | 12.6     | 11.5     |
|                                                              |                          | XC5204      | 21.6     | 18.9     | 13.3     | 11.9     |
|                                                              |                          | XC5206      | 21.7     | 19.0     | 13.6     | 12.5     |
|                                                              |                          | XC5210      | 21.7     | 19.0     | 15.0     | 12.9     |
|                                                              |                          | XC5215      | 24.3     | 21.2     | 15.0     | 13.1     |
| Input Set-up Time (no delay) to CLB Flip-Flop<br>            | $T_{PSUF}$<br><br>(Min)  | XC5202      | 2.5      | 2.0      | 1.9      | 1.9      |
|                                                              |                          | XC5204      | 2.3      | 1.9      | 1.9      | 1.9      |
|                                                              |                          | XC5206      | 2.2      | 1.9      | 1.9      | 1.9      |
|                                                              |                          | XC5210      | 2.2      | 1.9      | 1.9      | 1.8      |
|                                                              |                          | XC5215      | 2.0      | 1.8      | 1.7      | 1.7      |
| Input Hold Time (no delay) to CLB Flip-Flop<br>              | $T_{PHF}$<br><br>(Min)   | XC5202      | 3.8      | 3.8      | 3.5      | 3.5      |
|                                                              |                          | XC5204      | 3.9      | 3.9      | 3.8      | 3.6      |
|                                                              |                          | XC5206      | 4.4      | 4.4      | 4.4      | 4.3      |
|                                                              |                          | XC5210      | 5.1      | 5.1      | 4.9      | 4.8      |
|                                                              |                          | XC5215      | 5.8      | 5.8      | 5.7      | 5.6      |
| Input Set-up Time (with delay) to CLB Flip-Flop DI Input<br> | $T_{PSU}$                | XC5202      | 7.3      | 6.6      | 6.6      | 6.6      |
|                                                              |                          | XC5204      | 7.3      | 6.6      | 6.6      | 6.6      |
|                                                              |                          | XC5206      | 7.2      | 6.5      | 6.4      | 6.3      |
|                                                              |                          | XC5210      | 7.2      | 6.5      | 6.0      | 6.0      |
|                                                              |                          | XC5215      | 6.8      | 5.7      | 5.7      | 5.7      |
| Input Set-up Time (with delay) to CLB Flip-Flop F Input<br>  | $T_{PSUL}$<br><br>(Min)  | XC5202      | 8.8      | 7.7      | 7.5      | 7.5      |
|                                                              |                          | XC5204      | 8.6      | 7.5      | 7.5      | 7.5      |
|                                                              |                          | XC5206      | 8.5      | 7.4      | 7.4      | 7.4      |
|                                                              |                          | XC5210      | 8.5      | 7.4      | 7.4      | 7.3      |
|                                                              |                          | XC5215      | 8.5      | 7.4      | 7.4      | 7.2      |
| Input Hold Time (with delay) to CLB Flip-Flop<br>            | $T_{PH}$<br><br>(Min)    | XC52xx      | 0        | 0        | 0        | 0        |

- Note:**
- These measurements assume that the CLB flip-flop uses a direct interconnect to or from the IOB. The INREG/ OUTREG properties, or XACT-Performance, can be used to assure that direct connects are used.  $t_{PSU}$  applies only to the CLB input DI that bypasses the look-up table, which only offers direct connects to IOBs on the left and right edges of the die.  $t_{PSUL}$  applies to the CLB inputs F that feed the look-up table, which offers direct connect to IOBs on all four edges, as do the CLB Q outputs.
  - When testing outputs (fast or slew-limited), half of the outputs on one side of the device are switching.

### XC5200 IOB Switching Characteristic Guidelines

Testing of the switching parameters is modeled after testing methods specified by MIL-M-38510/605. All devices are 100% functionally tested. Since many internal timing parameters cannot be measured directly, they are derived from benchmark timing patterns. The following guidelines reflect worst-case values over the recommended operating conditions. For more detailed, more precise, and more up-to-date timing information, use the values provided by the timing calculator and used in the simulator.

| Speed Grade                                                                                 |              | -6       | -5       | -4       | -3       |
|---------------------------------------------------------------------------------------------|--------------|----------|----------|----------|----------|
| Description                                                                                 | Symbol       | Max (ns) | Max (ns) | Max (ns) | Max (ns) |
| <b>Input</b>                                                                                |              |          |          |          |          |
| Propagation Delays from CMOS or TTL Levels                                                  |              |          |          |          |          |
| Pad to I (no delay)                                                                         | $T_{PI}$     | 5.7      | 5.0      | 4.8      | 3.3      |
| Pad to I (with delay)                                                                       | $T_{PID}$    | 11.4     | 10.2     | 10.2     | 9.5      |
| <b>Output</b>                                                                               |              |          |          |          |          |
| Propagation Delays to CMOS or TTL Levels                                                    |              |          |          |          |          |
| Output (O) to Pad (fast)                                                                    | $T_{OPF}$    | 4.6      | 4.5      | 4.5      | 3.5      |
| Output (O) to Pad (slew-limited)                                                            | $T_{OPS}$    | 9.5      | 8.4      | 8.0      | 5.0      |
| From clock (CK) to output pad (fast), using direct connect between Q and output (O)         | $T_{OKPOF}$  | 10.1     | 9.3      | 8.3      | 7.5      |
| From clock (CK) to output pad (slew-limited), using direct connect between Q and output (O) | $T_{OKPOS}$  | 14.9     | 13.1     | 11.8     | 10.0     |
| 3-state to Pad active (fast)                                                                | $T_{TSO NF}$ | 5.6      | 5.2      | 4.9      | 4.6      |
| 3-state to Pad active (slew-limited)                                                        | $T_{TSO NS}$ | 10.4     | 9.0      | 8.3      | 6.0      |
| Internal GTS to Pad active                                                                  | $T_{GTS}$    | 17.7     | 15.9     | 14.7     | 13.5     |

- Note:**
1. Timing is measured at pin threshold, with 50-pF external capacitance loads. **Slew-limited** output rise/fall times are approximately two times longer than **fast** output rise/fall times.
  2. Unused and unbonded IOBs are configured by default as inputs with internal pull-up resistors.
  3. Timing is based upon the XC5215 device. For other devices, see Timing Calculator.

### XC5200 Boundary Scan (JTAG) Switching Characteristic Guidelines

The following guidelines reflect worst-case values over the recommended operating conditions. They are expressed in units of nanoseconds and apply to all XC5200 devices unless otherwise noted.

| Speed Grade                              |              | -6   |      | -5   |      | -4   |      | -3   |      |
|------------------------------------------|--------------|------|------|------|------|------|------|------|------|
| Description                              | Symbol       | Min  | Max  | Min  | Max  | Min  | Max  | Min  | Max  |
| <b>Setup and Hold</b>                    |              |      |      |      |      |      |      |      |      |
| Input (TDI) to clock (TCK)<br>setup time | $T_{TDITCK}$ | 30.0 |      | 30.0 |      | 30.0 |      | 30.0 |      |
| Input (TDI) to clock (TCK)<br>hold time  | $T_{TCKTDI}$ | 0    |      | 0    |      | 0    |      | 0    |      |
| Input (TMS) to clock (TCK)<br>setup time | $T_{TMSTCK}$ | 15.0 |      | 15.0 |      | 15.0 |      | 15.0 |      |
| Input (TMS) to clock (TCK)<br>hold time  | $T_{TCKTMS}$ | 0    |      | 0    |      | 0    |      | 0    |      |
| <b>Propagation Delay</b>                 |              |      |      |      |      |      |      |      |      |
| Clock (TCK) to Pad (TDO)                 | $T_{TCKPO}$  |      | 30.0 |      | 30.0 |      | 30.0 |      | 30.0 |
| <b>Clock</b>                             |              |      |      |      |      |      |      |      |      |
| Clock (TCK) High                         | $T_{TCKH}$   | 30.0 |      | 30.0 |      | 30.0 |      | 30.0 |      |
| Clock (TCK) Low                          | $T_{TCKL}$   | 30.0 |      | 30.0 |      | 30.0 |      | 30.0 |      |
| $F_{MAX}$ (MHz)                          | $F_{MAX}$    |      | 10.0 |      | 10.0 |      | 10.0 |      | 10.0 |

Note 1: Input pad setup and hold times are specified with respect to the internal clock.

### Device-Specific Pinout Tables

Device-specific tables include all packages for each XC5200-Series device. They follow the pad locations around the die, and include boundary scan register locations.

#### Pin Locations for XC5202 Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC5200 Series data sheet for availability information.

| Pin | Description     | VQ64* | PC84 | PQ100 | VQ100 | TQ144 | PG156 | Boundary Scan Order |
|-----|-----------------|-------|------|-------|-------|-------|-------|---------------------|
|     | VCC             | -     | 2    | 92    | 89    | 128   | H3    | -                   |
| 1.  | I/O (A8)        | 57    | 3    | 93    | 90    | 129   | H1    | 51                  |
| 2.  | I/O (A9)        | 58    | 4    | 94    | 91    | 130   | G1    | 54                  |
| 3.  | I/O             | -     | -    | 95    | 92    | 131   | G2    | 57                  |
| 4.  | I/O             | -     | -    | 96    | 93    | 132   | G3    | 63                  |
| 5.  | I/O (A10)       | -     | 5    | 97    | 94    | 133   | F1    | 66                  |
| 6.  | I/O (A11)       | 59    | 6    | 98    | 95    | 134   | F2    | 69                  |
|     | GND             | -     | -    | -     | -     | 137   | F3    | -                   |
| 7.  | I/O (A12)       | 60    | 7    | 99    | 96    | 138   | E3    | 78                  |
| 8.  | I/O (A13)       | 61    | 8    | 100   | 97    | 139   | C1    | 81                  |
| 9.  | I/O (A14)       | 62    | 9    | 1     | 98    | 142   | B1    | 90                  |
| 10. | I/O (A15)       | 63    | 10   | 2     | 99    | 143   | B2    | 93                  |
|     | VCC             | 64    | 11   | 3     | 100   | 144   | C3    | -                   |
|     | GND             | -     | 12   | 4     | 1     | 1     | C4    | -                   |
| 11. | GCK1 (A16, I/O) | 1     | 13   | 5     | 2     | 2     | B3    | 102                 |
| 12. | I/O (A17)       | 2     | 14   | 6     | 3     | 3     | A1    | 105                 |
| 13. | I/O (TDI)       | 3     | 15   | 7     | 4     | 6     | B4    | 111                 |
| 14. | I/O (TCK)       | 4     | 16   | 8     | 5     | 7     | A3    | 114                 |
|     | GND             | -     | -    | -     | -     | 8     | C6    | -                   |
| 15. | I/O (TMS)       | 5     | 17   | 9     | 6     | 11    | A5    | 117                 |
| 16. | I/O             | 6     | 18   | 10    | 7     | 12    | C7    | 123                 |
| 17. | I/O             | -     | -    | -     | -     | 13    | B7    | 126                 |
| 18. | I/O             | -     | -    | 11    | 8     | 14    | A6    | 129                 |
| 19. | I/O             | -     | 19   | 12    | 9     | 15    | A7    | 135                 |
| 20. | I/O             | 7     | 20   | 13    | 10    | 16    | A8    | 138                 |
|     | GND             | 8     | 21   | 14    | 11    | 17    | C8    | -                   |
|     | VCC             | 9     | 22   | 15    | 12    | 18    | B8    | -                   |
| 21. | I/O             | -     | 23   | 16    | 13    | 19    | C9    | 141                 |
| 22. | I/O             | 10    | 24   | 17    | 14    | 20    | B9    | 147                 |
| 23. | I/O             |       | -    | 18    | 15    | 21    | A9    | 150                 |
| 24. | I/O             |       | -    | -     | -     | 22    | B10   | 153                 |
| 25. | I/O             | -     | 25   | 19    | 16    | 23    | C10   | 159                 |
| 26. | I/O             | 11    | 26   | 20    | 17    | 24    | A10   | 162                 |
|     | GND             |       | -    | -     | -     | 27    | C11   | -                   |
| 27. | I/O             | 12    | 27   | 21    | 18    | 28    | B12   | 165                 |
| 28. | I/O             |       | -    | 22    | 19    | 29    | A13   | 171                 |
| 29. | I/O             | 13    | 28   | 23    | 20    | 32    | B13   | 174                 |
| 30. | I/O             | 14    | 29   | 24    | 21    | 33    | B14   | 177                 |
| 31. | M1 (I/O)        | 15    | 30   | 25    | 22    | 34    | A15   | 186                 |
|     | GND             | -     | 31   | 26    | 23    | 35    | C13   | -                   |
| 32. | M0 (I/O)        | 16    | 32   | 27    | 24    | 36    | A16   | 189                 |
|     | VCC             | -     | 33   | 28    | 25    | 37    | C14   | -                   |
| 33. | M2 (I/O)        | 17    | 34   | 29    | 26    | 38    | B15   | 192                 |
| 34. | GCK2 (I/O)      | 18    | 35   | 30    | 27    | 39    | B16   | 195                 |

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



| Pin | Description            | VQ64* | PC84 | PQ100 | VQ100 | TQ144 | PG156 | Boundary Scan Order |
|-----|------------------------|-------|------|-------|-------|-------|-------|---------------------|
| 35. | I/O (HDC)              | 19    | 36   | 31    | 28    | 40    | D14   | 204                 |
| 36. | I/O                    | -     | -    | 32    | 29    | 43    | E14   | 207                 |
| 37. | I/O (LDC)              | 20    | 37   | 33    | 30    | 44    | C16   | 210                 |
|     | GND                    | -     | -    | -     | -     | 45    | F14   | -                   |
| 38. | I/O                    | -     | 38   | 34    | 31    | 48    | F16   | 216                 |
| 39. | I/O                    | 21    | 39   | 35    | 32    | 49    | G14   | 219                 |
| 40. | I/O                    | -     | -    | 36    | 33    | 50    | G15   | 222                 |
| 41. | I/O                    | -     | -    | 37    | 34    | 51    | G16   | 228                 |
| 42. | I/O                    | 22    | 40   | 38    | 35    | 52    | H16   | 231                 |
| 43. | I/O (ERR, INIT)        | 23    | 41   | 39    | 36    | 53    | H15   | 234                 |
|     | VCC                    | 24    | 42   | 40    | 37    | 54    | H14   | -                   |
|     | GND                    | 25    | 43   | 41    | 38    | 55    | J14   | -                   |
| 44. | I/O                    | 26    | 44   | 42    | 39    | 56    | J15   | 240                 |
| 45. | I/O                    | 27    | 45   | 43    | 40    | 57    | J16   | 243                 |
| 46. | I/O                    | -     | -    | 44    | 41    | 58    | K16   | 246                 |
| 47. | I/O                    | -     | -    | 45    | 42    | 59    | K15   | 252                 |
| 48. | I/O                    | 28    | 46   | 46    | 43    | 60    | K14   | 255                 |
| 49. | I/O                    | 29    | 47   | 47    | 44    | 61    | L16   | 258                 |
|     | GND                    | -     | -    | -     | -     | 64    | L14   | -                   |
| 50. | I/O                    | -     | 48   | 48    | 45    | 65    | P16   | 264                 |
| 51. | I/O                    | 30    | 49   | 49    | 46    | 66    | M14   | 267                 |
| 52. | I/O                    | -     | 50   | 50    | 47    | 69    | N14   | 276                 |
| 53. | I/O                    | 31    | 51   | 51    | 48    | 70    | R16   | 279                 |
|     | GND                    | -     | 52   | 52    | 49    | 71    | P14   | -                   |
|     | DONE                   | 32    | 53   | 53    | 50    | 72    | R15   | -                   |
|     | VCC                    | 33    | 54   | 54    | 51    | 73    | P13   | -                   |
|     | PROG                   | 34    | 55   | 55    | 52    | 74    | R14   | -                   |
| 54. | I/O (D7)               | 35    | 56   | 56    | 53    | 75    | T16   | 288                 |
| 55. | GCK3 (I/O)             | 36    | 57   | 57    | 54    | 76    | T15   | 291                 |
| 56. | I/O (D6)               | 37    | 58   | 58    | 55    | 79    | T14   | 300                 |
| 57. | I/O                    | -     | -    | 59    | 56    | 80    | T13   | 303                 |
|     | GND                    | -     | -    | -     | -     | 81    | P11   | -                   |
| 58. | I/O (D5)               | 38    | 59   | 60    | 57    | 84    | T10   | 306                 |
| 59. | I/O (CS0)              | -     | 60   | 61    | 58    | 85    | P10   | 312                 |
| 60. | I/O                    | -     | -    | 62    | 59    | 86    | R10   | 315                 |
| 61. | I/O                    | -     | -    | 63    | 60    | 87    | T9    | 318                 |
| 62. | I/O (D4)               | 39    | 61   | 64    | 61    | 88    | R9    | 324                 |
| 63. | I/O                    | -     | 62   | 65    | 62    | 89    | P9    | 327                 |
|     | VCC                    | 40    | 63   | 66    | 63    | 90    | R8    | -                   |
|     | GND                    | 41    | 64   | 67    | 64    | 91    | P8    | -                   |
| 64. | I/O (D3)               | 42    | 65   | 68    | 65    | 92    | T8    | 336                 |
| 65. | I/O (RS)               | 43    | 66   | 69    | 66    | 93    | T7    | 339                 |
| 66. | I/O                    | -     | -    | 70    | 67    | 94    | T6    | 342                 |
| 67. | I/O                    | -     | -    | -     | -     | 95    | R7    | 348                 |
| 68. | I/O (D2)               | 44    | 67   | 71    | 68    | 96    | P7    | 351                 |
| 69. | I/O                    | -     | 68   | 72    | 69    | 97    | T5    | 360                 |
|     | GND                    | -     | -    | -     | -     | 100   | P6    | -                   |
| 70. | I/O (D1)               | 45    | 69   | 73    | 70    | 101   | T3    | 363                 |
| 71. | I/O<br>(RCLK-BUSY/RDY) | -     | 70   | 74    | 71    | 102   | P5    | 366                 |
| 72. | I/O (D0, DIN)          | 46    | 71   | 75    | 72    | 105   | P4    | 372                 |
| 73. | I/O (DOUT)             | 47    | 72   | 76    | 73    | 106   | T2    | 375                 |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

| Pin | Description                | VQ64* | PC84 | PQ100 | VQ100 | TQ144 | PG156 | Boundary Scan Order |
|-----|----------------------------|-------|------|-------|-------|-------|-------|---------------------|
|     | CCLK                       | 48    | 73   | 77    | 74    | 107   | R2    | -                   |
|     | VCC                        | -     | 74   | 78    | 75    | 108   | P3    | -                   |
| 74. | I/O (TDO)                  | 49    | 75   | 79    | 76    | 109   | T1    | 0                   |
|     | GND                        | -     | 76   | 80    | 77    | 110   | N3    | -                   |
| 75. | I/O (A0, $\overline{WS}$ ) | 50    | 77   | 81    | 78    | 111   | R1    | 9                   |
| 76. | GCK4 (A1, I/O)             | 51    | 78   | 82    | 79    | 112   | P2    | 15                  |
| 77. | I/O (A2, CS1)              | 52    | 79   | 83    | 80    | 115   | P1    | 18                  |
| 78. | I/O (A3)                   | -     | 80   | 84    | 81    | 116   | N1    | 21                  |
|     | GND                        | -     | -    | -     | -     | 118   | L3    | -                   |
| 79. | I/O (A4)                   | -     | 81   | 85    | 82    | 121   | K3    | 27                  |
| 80. | I/O (A5)                   | 53    | 82   | 86    | 83    | 122   | K2    | 30                  |
| 81. | I/O                        | -     | -    | 87    | 84    | 123   | K1    | 33                  |
| 82. | I/O                        | -     | -    | 88    | 85    | 124   | J1    | 39                  |
| 83. | I/O (A6)                   | 54    | 83   | 89    | 86    | 125   | J2    | 42                  |
| 84. | I/O (A7)                   | 55    | 84   | 90    | 87    | 126   | J3    | 45                  |
|     | GND                        | 56    | 1    | 91    | 88    | 127   | H2    | -                   |

\* VQ64 package supports Master Serial, Slave Serial, and Express configuration modes only.

### Additional No Connect (N.C.) Connections on TQ144 Package

| TQ144 |    |    |    |     |     |
|-------|----|----|----|-----|-----|
| 135   | 9  | 41 | 67 | 98  | 117 |
| 136   | 10 | 42 | 68 | 99  | 119 |
| 140   | 25 | 46 | 77 | 103 | 120 |
| 141   | 26 | 47 | 78 | 104 |     |
| 4     | 30 | 62 | 82 | 113 |     |
| 5     | 31 | 63 | 83 | 114 |     |

**Notes:** Boundary Scan Bit 0 = TDO.T  
Boundary Scan Bit 1 = TDO.O  
Boundary Scan Bit 1056 = BSCAN.UPD

### Pin Locations for XC5204 Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC5200 Series data sheet for availability information.

| Pin | Description |  | PC84 | PQ100 | VQ100 | TQ144 | PG156 | PQ160 | Boundary Scan Order |
|-----|-------------|--|------|-------|-------|-------|-------|-------|---------------------|
|     | VCC         |  | 2    | 92    | 89    | 128   | H3    | 142   | -                   |
| 1.  | I/O (A8)    |  | 3    | 93    | 90    | 129   | H1    | 143   | 78                  |
| 2.  | I/O (A9)    |  | 4    | 94    | 91    | 130   | G1    | 144   | 81                  |
| 3.  | I/O         |  | -    | 95    | 92    | 131   | G2    | 145   | 87                  |
| 4.  | I/O         |  | -    | 96    | 93    | 132   | G3    | 146   | 90                  |
| 5.  | I/O (A10)   |  | 5    | 97    | 94    | 133   | F1    | 147   | 93                  |
| 6.  | I/O (A11)   |  | 6    | 98    | 95    | 134   | F2    | 148   | 99                  |
| 7.  | I/O         |  | -    | -     | -     | 135   | E1    | 149   | 102                 |
| 8.  | I/O         |  | -    | -     | -     | 136   | E2    | 150   | 105                 |
|     | GND         |  | -    | -     | -     | 137   | F3    | 151   | -                   |
| 9.  | I/O         |  | -    | -     | -     | -     | D1    | 152   | 111                 |
| 10. | I/O         |  | -    | -     | -     | -     | D2    | 153   | 114                 |
| 11. | I/O (A12)   |  | 7    | 99    | 96    | 138   | E3    | 154   | 117                 |
| 12. | I/O (A13)   |  | 8    | 100   | 97    | 139   | C1    | 155   | 123                 |
| 13. | I/O         |  | -    | -     | -     | 140   | C2    | 156   | 126                 |

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



| Pin | Description     |  | PC84 | PQ100 | VQ100 | TQ144 | PG156 | PQ160 | Boundary Scan Order |
|-----|-----------------|--|------|-------|-------|-------|-------|-------|---------------------|
| 14. | I/O             |  | -    | -     | -     | 141   | D3    | 157   | 129                 |
| 15. | I/O (A14)       |  | 9    | 1     | 98    | 142   | B1    | 158   | 138                 |
| 16. | I/O (A15)       |  | 10   | 2     | 99    | 143   | B2    | 159   | 141                 |
|     | VCC             |  | 11   | 3     | 100   | 144   | C3    | 160   | -                   |
|     | GND             |  | 12   | 4     | 1     | 1     | C4    | 1     | -                   |
| 17. | GCK1 (A16, I/O) |  | 13   | 5     | 2     | 2     | B3    | 2     | 150                 |
| 18. | I/O (A17)       |  | 14   | 6     | 3     | 3     | A1    | 3     | 153                 |
| 19. | I/O             |  | -    | -     | -     | 4     | A2    | 4     | 159                 |
| 20. | I/O             |  | -    | -     | -     | 5     | C5    | 5     | 162                 |
| 21. | I/O (TDI)       |  | 15   | 7     | 4     | 6     | B4    | 6     | 165                 |
| 22. | I/O (TCK)       |  | 16   | 8     | 5     | 7     | A3    | 7     | 171                 |
|     | GND             |  | -    | -     | -     | 8     | C6    | 10    | -                   |
| 23. | I/O             |  | -    | -     | -     | 9     | B5    | 11    | 174                 |
| 24. | I/O             |  | -    | -     | -     | 10    | B6    | 12    | 177                 |
| 25. | I/O (TMS)       |  | 17   | 9     | 6     | 11    | A5    | 13    | 180                 |
| 26. | I/O             |  | 18   | 10    | 7     | 12    | C7    | 14    | 183                 |
| 27. | I/O             |  | -    | -     | -     | 13    | B7    | 15    | 186                 |
| 28. | I/O             |  | -    | 11    | 8     | 14    | A6    | 16    | 189                 |
| 29. | I/O             |  | 19   | 12    | 9     | 15    | A7    | 17    | 195                 |
| 30. | I/O             |  | 20   | 13    | 10    | 16    | A8    | 18    | 198                 |
|     | GND             |  | 21   | 14    | 11    | 17    | C8    | 19    | -                   |
|     | VCC             |  | 22   | 15    | 12    | 18    | B8    | 20    | -                   |
| 31. | I/O             |  | 23   | 16    | 13    | 19    | C9    | 21    | 201                 |
| 32. | I/O             |  | 24   | 17    | 14    | 20    | B9    | 22    | 207                 |
| 33. | I/O             |  | -    | 18    | 15    | 21    | A9    | 23    | 210                 |
| 34. | I/O             |  | -    | -     | -     | 22    | B10   | 24    | 213                 |
| 35. | I/O             |  | 25   | 19    | 16    | 23    | C10   | 25    | 219                 |
| 36. | I/O             |  | 26   | 20    | 17    | 24    | A10   | 26    | 222                 |
| 37. | I/O             |  | -    | -     | -     | 25    | A11   | 27    | 225                 |
| 38. | I/O             |  | -    | -     | -     | 26    | B11   | 28    | 231                 |
|     | GND             |  | -    | -     | -     | 27    | C11   | 29    | -                   |
| 39. | I/O             |  | 27   | 21    | 18    | 28    | B12   | 32    | 234                 |
| 40. | I/O             |  | -    | 22    | 19    | 29    | A13   | 33    | 237                 |
| 41. | I/O             |  | -    | -     | -     | 30    | A14   | 34    | 240                 |
| 42. | I/O             |  | -    | -     | -     | 31    | C12   | 35    | 243                 |
| 43. | I/O             |  | 28   | 23    | 20    | 32    | B13   | 36    | 246                 |
| 44. | I/O             |  | 29   | 24    | 21    | 33    | B14   | 37    | 249                 |
| 45. | M1 (I/O)        |  | 30   | 25    | 22    | 34    | A15   | 38    | 258                 |
|     | GND             |  | 31   | 26    | 23    | 35    | C13   | 39    | -                   |
| 46. | M0 (I/O)        |  | 32   | 27    | 24    | 36    | A16   | 40    | 261                 |
|     | VCC             |  | 33   | 28    | 25    | 37    | C14   | 41    | -                   |
| 47. | M2 (I/O)        |  | 34   | 29    | 26    | 38    | B15   | 42    | 264                 |
| 48. | GCK2 (I/O)      |  | 35   | 30    | 27    | 39    | B16   | 43    | 267                 |
| 49. | I/O (HDC)       |  | 36   | 31    | 28    | 40    | D14   | 44    | 276                 |
| 50. | I/O             |  | -    | -     | -     | 41    | C15   | 45    | 279                 |
| 51. | I/O             |  | -    | -     | -     | 42    | D15   | 46    | 282                 |
| 52. | I/O             |  | -    | 32    | 29    | 43    | E14   | 47    | 288                 |
| 53. | I/O (LDC)       |  | 37   | 33    | 30    | 44    | C16   | 48    | 291                 |
| 54. | I/O             |  | -    | -     | -     | -     | E15   | 49    | 294                 |
| 55. | I/O             |  | -    | -     | -     | -     | D16   | 50    | 300                 |
|     | GND             |  | -    | -     | -     | 45    | F14   | 51    | -                   |
| 56. | I/O             |  | -    | -     | -     | 46    | F15   | 52    | 303                 |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

| Pin | Description     |  | PC84 | PQ100 | VQ100 | TQ144 | PG156 | PQ160 | Boundary Scan Order |
|-----|-----------------|--|------|-------|-------|-------|-------|-------|---------------------|
| 57. | I/O             |  | -    | -     | -     | 47    | E16   | 53    | 306                 |
| 58. | I/O             |  | 38   | 34    | 31    | 48    | F16   | 54    | 312                 |
| 59. | I/O             |  | 39   | 35    | 32    | 49    | G14   | 55    | 315                 |
| 60. | I/O             |  | -    | 36    | 33    | 50    | G15   | 56    | 318                 |
| 61. | I/O             |  | -    | 37    | 34    | 51    | G16   | 57    | 324                 |
| 62. | I/O             |  | 40   | 38    | 35    | 52    | H16   | 58    | 327                 |
| 63. | I/O (ERR, INIT) |  | 41   | 39    | 36    | 53    | H15   | 59    | 330                 |
|     | VCC             |  | 42   | 40    | 37    | 54    | H14   | 60    | -                   |
|     | GND             |  | 43   | 41    | 38    | 55    | J14   | 61    | -                   |
| 64. | I/O             |  | 44   | 42    | 39    | 56    | J15   | 62    | 336                 |
| 65. | I/O             |  | 45   | 43    | 40    | 57    | J16   | 63    | 339                 |
| 66. | I/O             |  | -    | 44    | 41    | 58    | K16   | 64    | 348                 |
| 67. | I/O             |  | -    | 45    | 42    | 59    | K15   | 65    | 351                 |
| 68. | I/O             |  | 46   | 46    | 43    | 60    | K14   | 66    | 354                 |
| 69. | I/O             |  | 47   | 47    | 44    | 61    | L16   | 67    | 360                 |
| 70. | I/O             |  | -    | -     | -     | 62    | M16   | 68    | 363                 |
| 71. | I/O             |  | -    | -     | -     | 63    | L15   | 69    | 366                 |
|     | GND             |  | -    | -     | -     | 64    | L14   | 70    | -                   |
| 72. | I/O             |  | -    | -     | -     | -     | N16   | 71    | 372                 |
| 73. | I/O             |  | -    | -     | -     | -     | M15   | 72    | 375                 |
| 74. | I/O             |  | 48   | 48    | 45    | 65    | P16   | 73    | 378                 |
| 75. | I/O             |  | 49   | 49    | 46    | 66    | M14   | 74    | 384                 |
| 76. | I/O             |  | -    | -     | -     | 67    | N15   | 75    | 387                 |
| 77. | I/O             |  | -    | -     | -     | 68    | P15   | 76    | 390                 |
| 78. | I/O             |  | 50   | 50    | 47    | 69    | N14   | 77    | 396                 |
| 79. | I/O             |  | 51   | 51    | 48    | 70    | R16   | 78    | 399                 |
|     | GND             |  | 52   | 52    | 49    | 71    | P14   | 79    | -                   |
|     | DONE            |  | 53   | 53    | 50    | 72    | R15   | 80    | -                   |
|     | VCC             |  | 54   | 54    | 51    | 73    | P13   | 81    | -                   |
|     | PROG            |  | 55   | 55    | 52    | 74    | R14   | 82    | -                   |
| 80. | I/O (D7)        |  | 56   | 56    | 53    | 75    | T16   | 83    | 408                 |
| 81. | GCK3 (I/O)      |  | 57   | 57    | 54    | 76    | T15   | 84    | 411                 |
| 82. | I/O             |  | -    | -     | -     | 77    | R13   | 85    | 420                 |
| 83. | I/O             |  | -    | -     | -     | 78    | P12   | 86    | 423                 |
| 84. | I/O (D6)        |  | 58   | 58    | 55    | 79    | T14   | 87    | 426                 |
| 85. | I/O             |  | -    | 59    | 56    | 80    | T13   | 88    | 432                 |
|     | GND             |  | -    | -     | -     | 81    | P11   | 91    | -                   |
| 86. | I/O             |  | -    | -     | -     | 82    | R11   | 92    | 435                 |
| 87. | I/O             |  | -    | -     | -     | 83    | T11   | 93    | 438                 |
| 88. | I/O (D5)        |  | 59   | 60    | 57    | 84    | T10   | 94    | 444                 |
| 89. | I/O (CS0)       |  | 60   | 61    | 58    | 85    | P10   | 95    | 447                 |
| 90. | I/O             |  | -    | 62    | 59    | 86    | R10   | 96    | 450                 |
| 91. | I/O             |  | -    | 63    | 60    | 87    | T9    | 97    | 456                 |
| 92. | I/O (D4)        |  | 61   | 64    | 61    | 88    | R9    | 98    | 459                 |
| 93. | I/O             |  | 62   | 65    | 62    | 89    | P9    | 99    | 462                 |
|     | VCC             |  | 63   | 66    | 63    | 90    | R8    | 100   | -                   |
|     | GND             |  | 64   | 67    | 64    | 91    | P8    | 101   | -                   |
| 94. | I/O (D3)        |  | 65   | 68    | 65    | 92    | T8    | 102   | 468                 |
| 95. | I/O (RS)        |  | 66   | 69    | 66    | 93    | T7    | 103   | 471                 |
| 96. | I/O             |  | -    | 70    | 67    | 94    | T6    | 104   | 474                 |
| 97. | I/O             |  | -    | -     | -     | 95    | R7    | 105   | 480                 |
| 98. | I/O (D2)        |  | 67   | 71    | 68    | 96    | P7    | 106   | 483                 |

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



| Pin  | Description            |  | PC84 | PQ100 | VQ100 | TQ144 | PG156 | PQ160 | Boundary Scan Order |
|------|------------------------|--|------|-------|-------|-------|-------|-------|---------------------|
| 99.  | I/O                    |  | 68   | 72    | 69    | 97    | T5    | 107   | 486                 |
| 100. | I/O                    |  | -    | -     | -     | 98    | R6    | 108   | 492                 |
| 101. | I/O                    |  | -    | -     | -     | 99    | T4    | 109   | 495                 |
|      | GND                    |  | -    | -     | -     | 100   | P6    | 110   | -                   |
| 102. | I/O (D1)               |  | 69   | 73    | 70    | 101   | T3    | 113   | 498                 |
| 103. | I/O<br>(RCLK-BUSY/RDY) |  | 70   | 74    | 71    | 102   | P5    | 114   | 504                 |
| 104. | I/O                    |  | -    | -     | -     | 103   | R4    | 115   | 507                 |
| 105. | I/O                    |  | -    | -     | -     | 104   | R3    | 116   | 510                 |
| 106. | I/O (D0, DIN)          |  | 71   | 75    | 72    | 105   | P4    | 117   | 516                 |
| 107. | I/O (DOU)              |  | 72   | 76    | 73    | 106   | T2    | 118   | 519                 |
|      | CCLK                   |  | 73   | 77    | 74    | 107   | R2    | 119   | -                   |
|      | VCC                    |  | 74   | 78    | 75    | 108   | P3    | 120   | -                   |
| 108. | I/O (TDO)              |  | 75   | 79    | 76    | 109   | T1    | 121   | 0                   |
|      | GND                    |  | 76   | 80    | 77    | 110   | N3    | 122   | -                   |
| 109. | I/O (A0, WS)           |  | 77   | 81    | 78    | 111   | R1    | 123   | 9                   |
| 110. | GCK4 (A1, I/O)         |  | 78   | 82    | 79    | 112   | P2    | 124   | 15                  |
| 111. | I/O                    |  | -    | -     | -     | 113   | N2    | 125   | 18                  |
| 112. | I/O                    |  | -    | -     | -     | 114   | M3    | 126   | 21                  |
| 113. | I/O (A2, CS1)          |  | 79   | 83    | 80    | 115   | P1    | 127   | 27                  |
| 114. | I/O (A3)               |  | 80   | 84    | 81    | 116   | N1    | 128   | 30                  |
| 115. | I/O                    |  | -    | -     | -     | 117   | M2    | 129   | 33                  |
| 116. | I/O                    |  | -    | -     | -     | -     | M1    | 130   | 39                  |
|      | GND                    |  | -    | -     | -     | 118   | L3    | 131   | -                   |
| 117. | I/O                    |  | -    | -     | -     | 119   | L2    | 132   | 42                  |
| 118. | I/O                    |  | -    | -     | -     | 120   | L1    | 133   | 45                  |
| 119. | I/O (A4)               |  | 81   | 85    | 82    | 121   | K3    | 134   | 51                  |
| 120. | I/O (A5)               |  | 82   | 86    | 83    | 122   | K2    | 135   | 54                  |
| 121. | I/O                    |  | -    | 87    | 84    | 123   | K1    | 137   | 57                  |
| 122. | I/O                    |  | -    | 88    | 85    | 124   | J1    | 138   | 63                  |
| 123. | I/O (A6)               |  | 83   | 89    | 86    | 125   | J2    | 139   | 66                  |
| 124. | I/O (A7)               |  | 84   | 90    | 87    | 126   | J3    | 140   | 69                  |
|      | GND                    |  | 1    | 91    | 88    | 127   | H2    | 141   | -                   |

### Additional No Connect (N.C.) Connections for PQ160 Package

| PQ160 |    |    |     |     |
|-------|----|----|-----|-----|
| 8     | 30 | 89 | 111 | 136 |
| 9     | 31 | 90 | 112 |     |

**Notes:** Boundary Scan Bit 0 = TDO.T  
Boundary Scan Bit 1 = TDO.O  
Boundary Scan Bit 1056 = BSCAN.UPD

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

### Pin Locations for XC5206 Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC5200 Series data sheet for availability information.

| Pin | Description     | PC84 | PQ100 | VQ100 | TQ144 | PQ160 | TQ176 | PG191 | PQ208 | Boundary Scan Order |
|-----|-----------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
|     | VCC             | 2    | 92    | 89    | 128   | 142   | 155   | J4    | 183   | -                   |
| 1.  | I/O (A8)        | 3    | 93    | 90    | 129   | 143   | 156   | J3    | 184   | 87                  |
| 2.  | I/O (A9)        | 4    | 94    | 91    | 130   | 144   | 157   | J2    | 185   | 90                  |
| 3.  | I/O             | -    | 95    | 92    | 131   | 145   | 158   | J1    | 186   | 93                  |
| 4.  | I/O             | -    | 96    | 93    | 132   | 146   | 159   | H1    | 187   | 99                  |
| 5.  | I/O             | -    | -     | -     | -     | -     | 160   | H2    | 188   | 102                 |
| 6.  | I/O             | -    | -     | -     | -     | -     | 161   | H3    | 189   | 105                 |
| 7.  | I/O (A10)       | 5    | 97    | 94    | 133   | 147   | 162   | G1    | 190   | 111                 |
| 8.  | I/O (A11)       | 6    | 98    | 95    | 134   | 148   | 163   | G2    | 191   | 114                 |
| 9.  | I/O             | -    | -     | -     | 135   | 149   | 164   | F1    | 192   | 117                 |
| 10. | I/O             | -    | -     | -     | 136   | 150   | 165   | E1    | 193   | 123                 |
|     | GND             | -    | -     | -     | 137   | 151   | 166   | G3    | 194   | -                   |
| 11. | I/O             | -    | -     | -     | -     | 152   | 168   | C1    | 197   | 126                 |
| 12. | I/O             | -    | -     | -     | -     | 153   | 169   | E2    | 198   | 129                 |
| 13. | I/O (A12)       | 7    | 99    | 96    | 138   | 154   | 170   | F3    | 199   | 138                 |
| 14. | I/O (A13)       | 8    | 100   | 97    | 139   | 155   | 171   | D2    | 200   | 141                 |
| 15. | I/O             | -    | -     | -     | 140   | 156   | 172   | B1    | 201   | 150                 |
| 16. | I/O             | -    | -     | -     | 141   | 157   | 173   | E3    | 202   | 153                 |
| 17. | I/O (A14)       | 9    | 1     | 98    | 142   | 158   | 174   | C2    | 203   | 162                 |
| 18. | I/O (A15)       | 10   | 2     | 99    | 143   | 159   | 175   | B2    | 204   | 165                 |
|     | VCC             | 11   | 3     | 100   | 144   | 160   | 176   | D3    | 205   | -                   |
|     | GND             | 12   | 4     | 1     | 1     | 1     | 1     | D4    | 2     | -                   |
| 19. | GCK1 (A16, I/O) | 13   | 5     | 2     | 2     | 2     | 2     | C3    | 4     | 174                 |
| 20. | I/O (A17)       | 14   | 6     | 3     | 3     | 3     | 3     | C4    | 5     | 177                 |
| 21. | I/O             | -    | -     | -     | 4     | 4     | 4     | B3    | 6     | 183                 |
| 22. | I/O             | -    | -     | -     | 5     | 5     | 5     | C5    | 7     | 186                 |
| 23. | I/O (TDI)       | 15   | 7     | 4     | 6     | 6     | 6     | A2    | 8     | 189                 |
| 24. | I/O (TCK)       | 16   | 8     | 5     | 7     | 7     | 7     | B4    | 9     | 195                 |
| 25. | I/O             | -    | -     | -     | -     | 8     | 8     | C6    | 10    | 198                 |
| 26. | I/O             | -    | -     | -     | -     | 9     | 9     | A3    | 11    | 201                 |
|     | GND             | -    | -     | -     | 8     | 10    | 10    | C7    | 14    | -                   |
| 27. | I/O             | -    | -     | -     | 9     | 11    | 11    | A4    | 15    | 207                 |
| 28. | I/O             | -    | -     | -     | 10    | 12    | 12    | A5    | 16    | 210                 |
| 29. | I/O (TMS)       | 17   | 9     | 6     | 11    | 13    | 13    | B7    | 17    | 213                 |
| 30. | I/O             | 18   | 10    | 7     | 12    | 14    | 14    | A6    | 18    | 219                 |
| 31. | I/O             | -    | -     | -     | -     | -     | 15    | C8    | 19    | 222                 |
| 32. | I/O             | -    | -     | -     | -     | -     | 16    | A7    | 20    | 225                 |
| 33. | I/O             | -    | -     | -     | 13    | 15    | 17    | B8    | 21    | 234                 |
| 34. | I/O             | -    | 11    | 8     | 14    | 16    | 18    | A8    | 22    | 237                 |
| 35. | I/O             | 19   | 12    | 9     | 15    | 17    | 19    | B9    | 23    | 246                 |
| 36. | I/O             | 20   | 13    | 10    | 16    | 18    | 20    | C9    | 24    | 249                 |
|     | GND             | 21   | 14    | 11    | 17    | 19    | 21    | D9    | 25    | -                   |
|     | VCC             | 22   | 15    | 12    | 18    | 20    | 22    | D10   | 26    | -                   |
| 37. | I/O             | 23   | 16    | 13    | 19    | 21    | 23    | C10   | 27    | 255                 |
| 38. | I/O             | 24   | 17    | 14    | 20    | 22    | 24    | B10   | 28    | 258                 |
| 39. | I/O             | -    | 18    | 15    | 21    | 23    | 25    | A9    | 29    | 261                 |
| 40. | I/O             | -    | -     | -     | 22    | 24    | 26    | A10   | 30    | 267                 |
| 41. | I/O             | -    | -     | -     | -     | -     | 27    | A11   | 31    | 270                 |

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



| Pin | Description     | PC84 | PQ100 | VQ100 | TQ144 | PQ160 | TQ176 | PG191 | PQ208 | Boundary Scan Order |
|-----|-----------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
| 42. | I/O             | -    | -     | -     | -     | -     | 28    | C11   | 32    | 273                 |
| 43. | I/O             | 25   | 19    | 16    | 23    | 25    | 29    | B11   | 33    | 279                 |
| 44. | I/O             | 26   | 20    | 17    | 24    | 26    | 30    | A12   | 34    | 282                 |
| 45. | I/O             | -    | -     | -     | 25    | 27    | 31    | B12   | 35    | 285                 |
| 46. | I/O             | -    | -     | -     | 26    | 28    | 32    | A13   | 36    | 291                 |
|     | GND             | -    | -     | -     | 27    | 29    | 33    | C12   | 37    | -                   |
| 47. | I/O             | -    | -     | -     | -     | 30    | 34    | A15   | 40    | 294                 |
| 48. | I/O             | -    | -     | -     | -     | 31    | 35    | C13   | 41    | 297                 |
| 49. | I/O             | 27   | 21    | 18    | 28    | 32    | 36    | B14   | 42    | 303                 |
| 50. | I/O             | -    | 22    | 19    | 29    | 33    | 37    | A16   | 43    | 306                 |
| 51. | I/O             | -    | -     | -     | 30    | 34    | 38    | B15   | 44    | 309                 |
| 52. | I/O             | -    | -     | -     | 31    | 35    | 39    | C14   | 45    | 315                 |
| 53. | I/O             | 28   | 23    | 20    | 32    | 36    | 40    | A17   | 46    | 318                 |
| 54. | I/O             | 29   | 24    | 21    | 33    | 37    | 41    | B16   | 47    | 321                 |
| 55. | M1 (I/O)        | 30   | 25    | 22    | 34    | 38    | 42    | C15   | 48    | 330                 |
|     | GND             | 31   | 26    | 23    | 35    | 39    | 43    | D15   | 49    | -                   |
| 56. | M0 (I/O)        | 32   | 27    | 24    | 36    | 40    | 44    | A18   | 50    | 333                 |
|     | VCC             | 33   | 28    | 25    | 37    | 41    | 45    | D16   | 55    | -                   |
| 57. | M2 (I/O)        | 34   | 29    | 26    | 38    | 42    | 46    | C16   | 56    | 336                 |
| 58. | GCK2 (I/O)      | 35   | 30    | 27    | 39    | 43    | 47    | B17   | 57    | 339                 |
| 59. | I/O (HDC)       | 36   | 31    | 28    | 40    | 44    | 48    | E16   | 58    | 348                 |
| 60. | I/O             | -    | -     | -     | 41    | 45    | 49    | C17   | 59    | 351                 |
| 61. | I/O             | -    | -     | -     | 42    | 46    | 50    | D17   | 60    | 354                 |
| 62. | I/O             | -    | 32    | 29    | 43    | 47    | 51    | B18   | 61    | 360                 |
| 63. | I/O (LDC)       | 37   | 33    | 30    | 44    | 48    | 52    | E17   | 62    | 363                 |
| 64. | I/O             | -    | -     | -     | -     | 49    | 53    | F16   | 63    | 372                 |
| 65. | I/O             | -    | -     | -     | -     | 50    | 54    | C18   | 64    | 375                 |
|     | GND             | -    | -     | -     | 45    | 51    | 55    | G16   | 67    | -                   |
| 66. | I/O             | -    | -     | -     | 46    | 52    | 56    | E18   | 68    | 378                 |
| 67. | I/O             | -    | -     | -     | 47    | 53    | 57    | F18   | 69    | 384                 |
| 68. | I/O             | 38   | 34    | 31    | 48    | 54    | 58    | G17   | 70    | 387                 |
| 69. | I/O             | 39   | 35    | 32    | 49    | 55    | 59    | G18   | 71    | 390                 |
| 70. | I/O             | -    | -     | -     | -     | -     | 60    | H16   | 72    | 396                 |
| 71. | I/O             | -    | -     | -     | -     | -     | 61    | H17   | 73    | 399                 |
| 72. | I/O             | -    | 36    | 33    | 50    | 56    | 62    | H18   | 74    | 402                 |
| 73. | I/O             | -    | 37    | 34    | 51    | 57    | 63    | J18   | 75    | 408                 |
| 74. | I/O             | 40   | 38    | 35    | 52    | 58    | 64    | J17   | 76    | 411                 |
| 75. | I/O (ERR, INIT) | 41   | 39    | 36    | 53    | 59    | 65    | J16   | 77    | 414                 |
|     | VCC             | 42   | 40    | 37    | 54    | 60    | 66    | J15   | 78    | -                   |
|     | GND             | 43   | 41    | 38    | 55    | 61    | 67    | K15   | 79    | -                   |
| 76. | I/O             | 44   | 42    | 39    | 56    | 62    | 68    | K16   | 80    | 420                 |
| 77. | I/O             | 45   | 43    | 40    | 57    | 63    | 69    | K17   | 81    | 423                 |
| 78. | I/O             | -    | 44    | 41    | 58    | 64    | 70    | K18   | 82    | 426                 |
| 79. | I/O             | -    | 45    | 42    | 59    | 65    | 71    | L18   | 83    | 432                 |
| 80. | I/O             | -    | -     | -     | -     | -     | 72    | L17   | 84    | 435                 |
| 81. | I/O             | -    | -     | -     | -     | -     | 73    | L16   | 85    | 438                 |
| 82. | I/O             | 46   | 46    | 43    | 60    | 66    | 74    | M18   | 86    | 444                 |
| 83. | I/O             | 47   | 47    | 44    | 61    | 67    | 75    | M17   | 87    | 447                 |
| 84. | I/O             | -    | -     | -     | 62    | 68    | 76    | N18   | 88    | 450                 |
| 85. | I/O             | -    | -     | -     | 63    | 69    | 77    | P18   | 89    | 456                 |
|     | GND             | -    | -     | -     | 64    | 70    | 78    | M16   | 90    | -                   |
| 86. | I/O             | -    | -     | -     | -     | 71    | 79    | T18   | 93    | 459                 |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

| Pin  | Description            | PC84 | PQ100 | VQ100 | TQ144 | PQ160 | TQ176 | PG191 | PQ208 | Boundary Scan Order |
|------|------------------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
| 87.  | I/O                    | -    | -     | -     | -     | 72    | 80    | P17   | 94    | 468                 |
| 88.  | I/O                    | 48   | 48    | 45    | 65    | 73    | 81    | N16   | 95    | 471                 |
| 89.  | I/O                    | 49   | 49    | 46    | 66    | 74    | 82    | T17   | 96    | 480                 |
| 90.  | I/O                    | -    | -     | -     | 67    | 75    | 83    | R17   | 97    | 483                 |
| 91.  | I/O                    | -    | -     | -     | 68    | 76    | 84    | P16   | 98    | 486                 |
| 92.  | I/O                    | 50   | 50    | 47    | 69    | 77    | 85    | U18   | 99    | 492                 |
| 93.  | I/O                    | 51   | 51    | 48    | 70    | 78    | 86    | T16   | 100   | 495                 |
|      | GND                    | 52   | 52    | 49    | 71    | 79    | 87    | R16   | 101   | -                   |
|      | DONE                   | 53   | 53    | 50    | 72    | 80    | 88    | U17   | 103   | -                   |
|      | VCC                    | 54   | 54    | 51    | 73    | 81    | 89    | R15   | 106   | -                   |
|      | PROG                   | 55   | 55    | 52    | 74    | 82    | 90    | V18   | 108   | -                   |
| 94.  | I/O (D7)               | 56   | 56    | 53    | 75    | 83    | 91    | T15   | 109   | 504                 |
| 95.  | GCK3 (I/O)             | 57   | 57    | 54    | 76    | 84    | 92    | U16   | 110   | 507                 |
| 96.  | I/O                    | -    | -     | -     | 77    | 85    | 93    | T14   | 111   | 516                 |
| 97.  | I/O                    | -    | -     | -     | 78    | 86    | 94    | U15   | 112   | 519                 |
| 98.  | I/O (D6)               | 58   | 58    | 55    | 79    | 87    | 95    | V17   | 113   | 522                 |
| 99.  | I/O                    | -    | 59    | 56    | 80    | 88    | 96    | V16   | 114   | 528                 |
| 100. | I/O                    | -    | -     | -     | -     | 89    | 97    | T13   | 115   | 531                 |
| 101. | I/O                    | -    | -     | -     | -     | 90    | 98    | U14   | 116   | 534                 |
|      | GND                    | -    | -     | -     | 81    | 91    | 99    | T12   | 119   | -                   |
| 102. | I/O                    | -    | -     | -     | 82    | 92    | 100   | U13   | 120   | 540                 |
| 103. | I/O                    | -    | -     | -     | 83    | 93    | 101   | V13   | 121   | 543                 |
| 104. | I/O (D5)               | 59   | 60    | 57    | 84    | 94    | 102   | U12   | 122   | 552                 |
| 105. | I/O (CS0)              | 60   | 61    | 58    | 85    | 95    | 103   | V12   | 123   | 555                 |
| 106. | I/O                    | -    | -     | -     | -     | -     | 104   | T11   | 124   | 558                 |
| 107. | I/O                    | -    | -     | -     | -     | -     | 105   | U11   | 125   | 564                 |
| 108. | I/O                    | -    | 62    | 59    | 86    | 96    | 106   | V11   | 126   | 567                 |
| 109. | I/O                    | -    | 63    | 60    | 87    | 97    | 107   | V10   | 127   | 570                 |
| 110. | I/O (D4)               | 61   | 64    | 61    | 88    | 98    | 108   | U10   | 128   | 576                 |
| 111. | I/O                    | 62   | 65    | 62    | 89    | 99    | 109   | T10   | 129   | 579                 |
|      | VCC                    | 63   | 66    | 63    | 90    | 100   | 110   | R10   | 130   | -                   |
|      | GND                    | 64   | 67    | 64    | 91    | 101   | 111   | R9    | 131   | -                   |
| 112. | I/O (D3)               | 65   | 68    | 65    | 92    | 102   | 112   | T9    | 132   | 588                 |
| 113. | I/O (RS)               | 66   | 69    | 66    | 93    | 103   | 113   | U9    | 133   | 591                 |
| 114. | I/O                    | -    | 70    | 67    | 94    | 104   | 114   | V9    | 134   | 600                 |
| 115. | I/O                    | -    | -     | -     | 95    | 105   | 115   | V8    | 135   | 603                 |
| 116. | I/O                    | -    | -     | -     | -     | -     | 116   | U8    | 136   | 612                 |
| 117. | I/O                    | -    | -     | -     | -     | -     | 117   | T8    | 137   | 615                 |
| 118. | I/O (D2)               | 67   | 71    | 68    | 96    | 106   | 118   | V7    | 138   | 618                 |
| 119. | I/O                    | 68   | 72    | 69    | 97    | 107   | 119   | U7    | 139   | 624                 |
| 120. | I/O                    | -    | -     | -     | 98    | 108   | 120   | V6    | 140   | 627                 |
| 121. | I/O                    | -    | -     | -     | 99    | 109   | 121   | U6    | 141   | 630                 |
|      | GND                    | -    | -     | -     | 100   | 110   | 122   | T7    | 142   | -                   |
| 122. | I/O                    | -    | -     | -     | -     | 111   | 123   | U5    | 145   | 636                 |
| 123. | I/O                    | -    | -     | -     | -     | 112   | 124   | T6    | 146   | 639                 |
| 124. | I/O (D1)               | 69   | 73    | 70    | 101   | 113   | 125   | V3    | 147   | 642                 |
| 125. | I/O<br>(RCLK-BUSY/RDY) | 70   | 74    | 71    | 102   | 114   | 126   | V2    | 148   | 648                 |
| 126. | I/O                    | -    | -     | -     | 103   | 115   | 127   | U4    | 149   | 651                 |
| 127. | I/O                    | -    | -     | -     | 104   | 116   | 128   | T5    | 150   | 654                 |
| 128. | I/O (D0, DIN)          | 71   | 75    | 72    | 105   | 117   | 129   | U3    | 151   | 660                 |
| 129. | I/O (DOUT)             | 72   | 76    | 73    | 106   | 118   | 130   | T4    | 152   | 663                 |

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



| Pin  | Description                | PC84 | PQ100 | VQ100 | TQ144 | PQ160 | TQ176 | PG191 | PQ208 | Boundary Scan Order |
|------|----------------------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
|      | CCLK                       | 73   | 77    | 74    | 107   | 119   | 131   | V1    | 153   | -                   |
|      | VCC                        | 74   | 78    | 75    | 108   | 120   | 132   | R4    | 154   | -                   |
| 130. | I/O (TDO)                  | 75   | 79    | 76    | 109   | 121   | 133   | U2    | 159   | -                   |
|      | GND                        | 76   | 80    | 77    | 110   | 122   | 134   | R3    | 160   | -                   |
| 131. | I/O (A0, $\overline{WS}$ ) | 77   | 81    | 78    | 111   | 123   | 135   | T3    | 161   | 9                   |
| 132. | GCK4 (A1, I/O)             | 78   | 82    | 79    | 112   | 124   | 136   | U1    | 162   | 15                  |
| 133. | I/O                        | -    | -     | -     | 113   | 125   | 137   | P3    | 163   | 18                  |
| 134. | I/O                        | -    | -     | -     | 114   | 126   | 138   | R2    | 164   | 21                  |
| 135. | I/O (A2, CS1)              | 79   | 83    | 80    | 115   | 127   | 139   | T2    | 165   | 27                  |
| 136. | I/O (A3)                   | 80   | 84    | 81    | 116   | 128   | 140   | N3    | 166   | 30                  |
| 137. | I/O                        | -    | -     | -     | 117   | 129   | 141   | P2    | 167   | 33                  |
| 138. | I/O                        | -    | -     | -     | -     | 130   | 142   | T1    | 168   | 42                  |
|      | GND                        | -    | -     | -     | 118   | 131   | 143   | M3    | 171   | -                   |
| 139. | I/O                        | -    | -     | -     | 119   | 132   | 144   | P1    | 172   | 45                  |
| 140. | I/O                        | -    | -     | -     | 120   | 133   | 145   | N1    | 173   | 51                  |
| 141. | I/O (A4)                   | 81   | 85    | 82    | 121   | 134   | 146   | M2    | 174   | 54                  |
| 142. | I/O (A5)                   | 82   | 86    | 83    | 122   | 135   | 147   | M1    | 175   | 57                  |
| 143. | I/O                        | -    | -     | -     | -     | -     | 148   | L3    | 176   | 63                  |
| 144. | I/O                        | -    | -     | -     | -     | 136   | 149   | L2    | 177   | 66                  |
| 145. | I/O                        | -    | 87    | 84    | 123   | 137   | 150   | L1    | 178   | 69                  |
| 146. | I/O                        | -    | 88    | 85    | 124   | 138   | 151   | K1    | 179   | 75                  |
| 147. | I/O (A6)                   | 83   | 89    | 86    | 125   | 139   | 152   | K2    | 180   | 78                  |
| 148. | I/O (A7)                   | 84   | 90    | 87    | 126   | 140   | 153   | K3    | 181   | 81                  |
|      | GND                        | 1    | 91    | 88    | 127   | 141   | 154   | K4    | 182   | -                   |

### Additional No Connect (N.C.) Connections for PQ208 and TQ176 Packages

| PQ208 |    |    |     |     |     |     | TQ176 |
|-------|----|----|-----|-----|-----|-----|-------|
| 195   | 1  | 39 | 65  | 104 | 143 | 158 | 167   |
| 196   | 3  | 51 | 66  | 105 | 144 | 169 |       |
| 206   | 12 | 52 | 91  | 107 | 155 | 170 |       |
| 207   | 13 | 53 | 92  | 117 | 156 |     |       |
| 208   | 38 | 54 | 102 | 118 | 157 |     |       |

**Notes:** Boundary Scan Bit 0 = TDO.T  
 Boundary Scan Bit 1 = TDO.O  
 Boundary Scan Bit 1056 = BSCAN.UPD

### Pin Locations for XC5210 Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC5200 Series data sheet for availability information.

| Pin | Description | PC84 | TQ144 | PQ160 | TQ176 | PQ208 | PG223 | BG225 | PQ240 | Boundary Scan Order |
|-----|-------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
|     | VCC         | 2    | 128   | 142   | 155   | 183   | J4    | VCC*  | 212   | -                   |
| 1.  | I/O (A8)    | 3    | 129   | 143   | 156   | 184   | J3    | E8    | 213   | 111                 |
| 2.  | I/O (A9)    | 4    | 130   | 144   | 157   | 185   | J2    | B7    | 214   | 114                 |
| 3.  | I/O         | -    | 131   | 145   | 158   | 186   | J1    | A7    | 215   | 117                 |
| 4.  | I/O         | -    | 132   | 146   | 159   | 187   | H1    | C7    | 216   | 123                 |
| 5.  | I/O         | -    | -     | -     | 160   | 188   | H2    | D7    | 217   | 126                 |
| 6.  | I/O         | -    | -     | -     | 161   | 189   | H3    | E7    | 218   | 129                 |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

| Pin | Description     | PC84 | TQ144 | PQ160 | TQ176 | PQ208 | PG223 | BG225 | PQ240 | Boundary Scan Order |
|-----|-----------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
| 7.  | I/O (A10)       | 5    | 133   | 147   | 162   | 190   | G1    | A6    | 220   | 135                 |
| 8.  | I/O (A11)       | 6    | 134   | 148   | 163   | 191   | G2    | B6    | 221   | 138                 |
|     | VCC             | -    | -     | -     | -     | -     | -     | VCC*  | 222   | -                   |
| 9.  | I/O             | -    | -     | -     | -     | -     | H4    | C6    | 223   | 141                 |
| 10. | I/O             | -    | -     | -     | -     | -     | G4    | F7    | 224   | 150                 |
| 11. | I/O             | -    | 135   | 149   | 164   | 192   | F1    | A5    | 225   | 153                 |
| 12. | I/O             | -    | 136   | 150   | 165   | 193   | E1    | B5    | 226   | 162                 |
|     | GND             | -    | 137   | 151   | 166   | 194   | G3    | GND*  | 227   | -                   |
| 13. | I/O             | -    | -     | -     | -     | 195   | F2    | D6    | 228   | 165                 |
| 14. | I/O             | -    | -     | -     | 167   | 196   | D1    | C5    | 229   | 171                 |
| 15. | I/O             | -    | -     | 152   | 168   | 197   | C1    | A4    | 230   | 174                 |
| 16. | I/O             | -    | -     | 153   | 169   | 198   | E2    | E6    | 231   | 177                 |
| 17. | I/O (A12)       | 7    | 138   | 154   | 170   | 199   | F3    | B4    | 232   | 183                 |
| 18. | I/O (A13)       | 8    | 139   | 155   | 171   | 200   | D2    | D5    | 233   | 186                 |
| 19. | I/O             | -    | -     | -     | -     | -     | F4    | A3    | 234   | 189                 |
| 20. | I/O             | -    | -     | -     | -     | -     | E4    | C4    | 235   | 195                 |
| 21. | I/O             | -    | 140   | 156   | 172   | 201   | B1    | B3    | 236   | 198                 |
| 22. | I/O             | -    | 141   | 157   | 173   | 202   | E3    | F6    | 237   | 201                 |
| 23. | I/O (A14)       | 9    | 142   | 158   | 174   | 203   | C2    | A2    | 238   | 210                 |
| 24. | I/O (A15)       | 10   | 143   | 159   | 175   | 204   | B2    | C3    | 239   | 213                 |
|     | VCC             | 11   | 144   | 160   | 176   | 205   | D3    | VCC*  | 240   | -                   |
|     | GND             | 12   | 1     | 1     | 1     | 2     | D4    | GND*  | 1     | -                   |
| 25. | GCK1 (A16, I/O) | 13   | 2     | 2     | 2     | 4     | C3    | D4    | 2     | 222                 |
| 26. | I/O (A17)       | 14   | 3     | 3     | 3     | 5     | C4    | B1    | 3     | 225                 |
| 27. | I/O             | -    | 4     | 4     | 4     | 6     | B3    | C2    | 4     | 231                 |
| 28. | I/O             | -    | 5     | 5     | 5     | 7     | C5    | E5    | 5     | 234                 |
| 29. | I/O (TDI)       | 15   | 6     | 6     | 6     | 8     | A2    | D3    | 6     | 237                 |
| 30. | I/O (TCK)       | 16   | 7     | 7     | 7     | 9     | B4    | C1    | 7     | 243                 |
| 31. | I/O             | -    | -     | 8     | 8     | 10    | C6    | D2    | 8     | 246                 |
| 32. | I/O             | -    | -     | 9     | 9     | 11    | A3    | G6    | 9     | 249                 |
| 33. | I/O             | -    | -     | -     | -     | 12    | B5    | E4    | 10    | 255                 |
| 34. | I/O             | -    | -     | -     | -     | 13    | B6    | D1    | 11    | 258                 |
| 35. | I/O             | -    | -     | -     | -     | -     | D5    | E3    | 12    | 261                 |
| 36. | I/O             | -    | -     | -     | -     | -     | D6    | E2    | 13    | 267                 |
|     | GND             | -    | 8     | 10    | 10    | 14    | C7    | GND*  | 14    | -                   |
| 37. | I/O             | -    | 9     | 11    | 11    | 15    | A4    | F5    | 15    | 270                 |
| 38. | I/O             | -    | 10    | 12    | 12    | 16    | A5    | E1    | 16    | 273                 |
| 39. | I/O (TMS)       | 17   | 11    | 13    | 13    | 17    | B7    | F4    | 17    | 279                 |
| 40. | I/O             | 18   | 12    | 14    | 14    | 18    | A6    | F3    | 18    | 282                 |
|     | VCC             | -    | -     | -     | -     | -     | -     | VCC*  | 19    | -                   |
| 41. | I/O             | -    | -     | -     | -     | -     | D7    | F2    | 20    | 285                 |
| 42. | I/O             | -    | -     | -     | -     | -     | D8    | F1    | 21    | 291                 |
| 43. | I/O             | -    | -     | -     | 15    | 19    | C8    | G4    | 23    | 294                 |
| 44. | I/O             | -    | -     | -     | 16    | 20    | A7    | G3    | 24    | 297                 |
| 45. | I/O             | -    | 13    | 15    | 17    | 21    | B8    | G2    | 25    | 306                 |
| 46. | I/O             | -    | 14    | 16    | 18    | 22    | A8    | G1    | 26    | 309                 |
| 47. | I/O             | 19   | 15    | 17    | 19    | 23    | B9    | G5    | 27    | 318                 |
| 48. | I/O             | 20   | 16    | 18    | 20    | 24    | C9    | H3    | 28    | 321                 |
|     | GND             | 21   | 17    | 19    | 21    | 25    | D9    | GND*  | 29    | -                   |
|     | VCC             | 22   | 18    | 20    | 22    | 26    | D10   | VCC*  | 30    | -                   |
| 49. | I/O             | 23   | 19    | 21    | 23    | 27    | C10   | H4    | 31    | 327                 |

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



| Pin | Description | PC84 | TQ144 | PQ160 | TQ176 | PQ208 | PG223 | BG225 | PQ240 | Boundary Scan Order |
|-----|-------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
| 50. | I/O         | 24   | 20    | 22    | 24    | 28    | B10   | H5    | 32    | 330                 |
| 51. | I/O         | -    | 21    | 23    | 25    | 29    | A9    | J2    | 33    | 333                 |
| 52. | I/O         | -    | 22    | 24    | 26    | 30    | A10   | J1    | 34    | 339                 |
| 53. | I/O         | -    | -     | -     | 27    | 31    | A11   | J3    | 35    | 342                 |
| 54. | I/O         | -    | -     | -     | 28    | 32    | C11   | J4    | 36    | 345                 |
| 55. | I/O         | -    | -     | -     | -     | -     | D11   | J5    | 38    | 351                 |
| 56. | I/O         | -    | -     | -     | -     | -     | D12   | K1    | 39    | 354                 |
|     | VCC         | -    | -     | -     | -     | -     | -     | VCC*  | 40    | -                   |
| 57. | I/O         | 25   | 23    | 25    | 29    | 33    | B11   | K2    | 41    | 357                 |
| 58. | I/O         | 26   | 24    | 26    | 30    | 34    | A12   | K3    | 42    | 363                 |
| 59. | I/O         | -    | 25    | 27    | 31    | 35    | B12   | J6    | 43    | 366                 |
| 60. | I/O         | -    | 26    | 28    | 32    | 36    | A13   | L1    | 44    | 369                 |
|     | GND         | -    | 27    | 29    | 33    | 37    | C12   | GND*  | 45    | -                   |
| 61. | I/O         | -    | -     | -     | -     | -     | D13   | L2    | 46    | 375                 |
| 62. | I/O         | -    | -     | -     | -     | -     | D14   | K4    | 47    | 378                 |
| 63. | I/O         | -    | -     | -     | -     | 38    | B13   | L3    | 48    | 381                 |
| 64. | I/O         | -    | -     | -     | -     | 39    | A14   | M1    | 49    | 387                 |
| 65. | I/O         | -    | -     | 30    | 34    | 40    | A15   | K5    | 50    | 390                 |
| 66. | I/O         | -    | -     | 31    | 35    | 41    | C13   | M2    | 51    | 393                 |
| 67. | I/O         | 27   | 28    | 32    | 36    | 42    | B14   | L4    | 52    | 399                 |
| 68. | I/O         | -    | 29    | 33    | 37    | 43    | A16   | N1    | 53    | 402                 |
| 69. | I/O         | -    | 30    | 34    | 38    | 44    | B15   | M3    | 54    | 405                 |
| 70. | I/O         | -    | 31    | 35    | 39    | 45    | C14   | N2    | 55    | 411                 |
| 71. | I/O         | 28   | 32    | 36    | 40    | 46    | A17   | K6    | 56    | 414                 |
| 72. | I/O         | 29   | 33    | 37    | 41    | 47    | B16   | P1    | 57    | 417                 |
| 73. | M1 (I/O)    | 30   | 34    | 38    | 42    | 48    | C15   | N3    | 58    | 426                 |
|     | GND         | 31   | 35    | 39    | 43    | 49    | D15   | GND*  | 59    | -                   |
| 74. | M0 (I/O)    | 32   | 36    | 40    | 44    | 50    | A18   | P2    | 60    | 429                 |
|     | VCC         | 33   | 37    | 41    | 45    | 55    | D16   | VCC*  | 61    | -                   |
| 75. | M2 (I/O)    | 34   | 38    | 42    | 46    | 56    | C16   | M4    | 62    | 432                 |
| 76. | GCK2 (I/O)  | 35   | 39    | 43    | 47    | 57    | B17   | R2    | 63    | 435                 |
| 77. | I/O (HDC)   | 36   | 40    | 44    | 48    | 58    | E16   | P3    | 64    | 444                 |
| 78. | I/O         | -    | 41    | 45    | 49    | 59    | C17   | L5    | 65    | 447                 |
| 79. | I/O         | -    | 42    | 46    | 50    | 60    | D17   | N4    | 66    | 450                 |
| 80. | I/O         | -    | 43    | 47    | 51    | 61    | B18   | R3    | 67    | 456                 |
| 81. | I/O (LDC)   | 37   | 44    | 48    | 52    | 62    | E17   | P4    | 68    | 459                 |
| 82. | I/O         | -    | -     | 49    | 53    | 63    | F16   | K7    | 69    | 462                 |
| 83. | I/O         | -    | -     | 50    | 54    | 64    | C18   | M5    | 70    | 468                 |
| 84. | I/O         | -    | -     | -     | -     | 65    | D18   | R4    | 71    | 471                 |
| 85. | I/O         | -    | -     | -     | -     | 66    | F17   | N5    | 72    | 474                 |
| 86. | I/O         | -    | -     | -     | -     | -     | E15   | P5    | 73    | 480                 |
| 87. | I/O         | -    | -     | -     | -     | -     | F15   | L6    | 74    | 483                 |
|     | GND         | -    | 45    | 51    | 55    | 67    | G16   | GND*  | 75    | -                   |
| 88. | I/O         | -    | 46    | 52    | 56    | 68    | E18   | R5    | 76    | 486                 |
| 89. | I/O         | -    | 47    | 53    | 57    | 69    | F18   | M6    | 77    | 492                 |
| 90. | I/O         | 38   | 48    | 54    | 58    | 70    | G17   | N6    | 78    | 495                 |
| 91. | I/O         | 39   | 49    | 55    | 59    | 71    | G18   | P6    | 79    | 504                 |
|     | VCC         | -    | -     | -     | -     | -     | -     | VCC*  | 80    | -                   |
| 92. | I/O         | -    | -     | -     | 60    | 72    | H16   | R6    | 81    | 507                 |
| 93. | I/O         | -    | -     | -     | 61    | 73    | H17   | M7    | 82    | 510                 |
| 94. | I/O         | -    | -     | -     | -     | -     | G15   | N7    | 84    | 516                 |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

| Pin  | Description     | PC84 | TQ144 | PQ160 | TQ176 | PQ208 | PG223 | BG225 | PQ240 | Boundary Scan Order |
|------|-----------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
| 95.  | I/O             | -    | -     | -     | -     | -     | H15   | P7    | 85    | 519                 |
| 96.  | I/O             | -    | 50    | 56    | 62    | 74    | H18   | R7    | 86    | 522                 |
| 97.  | I/O             | -    | 51    | 57    | 63    | 75    | J18   | L7    | 87    | 528                 |
| 98.  | I/O             | 40   | 52    | 58    | 64    | 76    | J17   | N8    | 88    | 531                 |
| 99.  | I/O (ERR, INIT) | 41   | 53    | 59    | 65    | 77    | J16   | P8    | 89    | 534                 |
|      | VCC             | 42   | 54    | 60    | 66    | 78    | J15   | VCC*  | 90    | -                   |
|      | GND             | 43   | 55    | 61    | 67    | 79    | K15   | GND*  | 91    | -                   |
| 100. | I/O             | 44   | 56    | 62    | 68    | 80    | K16   | L8    | 92    | 540                 |
| 101. | I/O             | 45   | 57    | 63    | 69    | 81    | K17   | P9    | 93    | 543                 |
| 102. | I/O             | -    | 58    | 64    | 70    | 82    | K18   | R9    | 94    | 546                 |
| 103. | I/O             | -    | 59    | 65    | 71    | 83    | L18   | N9    | 95    | 552                 |
| 104. | I/O             | -    | -     | -     | 72    | 84    | L17   | M9    | 96    | 555                 |
| 105. | I/O             | -    | -     | -     | 73    | 85    | L16   | L9    | 97    | 558                 |
| 106. | I/O             | -    | -     | -     | -     | -     | L15   | R10   | 99    | 564                 |
| 107. | I/O             | -    | -     | -     | -     | -     | M15   | P10   | 100   | 567                 |
|      | VCC             | -    | -     | -     | -     | -     | -     | VCC*  | 101   | -                   |
| 108. | I/O             | 46   | 60    | 66    | 74    | 86    | M18   | N10   | 102   | 570                 |
| 109. | I/O             | 47   | 61    | 67    | 75    | 87    | M17   | K9    | 103   | 576                 |
| 110. | I/O             | -    | 62    | 68    | 76    | 88    | N18   | R11   | 104   | 579                 |
| 111. | I/O             | -    | 63    | 69    | 77    | 89    | P18   | P11   | 105   | 588                 |
|      | GND             | -    | 64    | 70    | 78    | 90    | M16   | GND*  | 106   | -                   |
| 112. | I/O             | -    | -     | -     | -     | -     | N15   | M10   | 107   | 591                 |
| 113. | I/O             | -    | -     | -     | -     | -     | P15   | N11   | 108   | 600                 |
| 114. | I/O             | -    | -     | -     | -     | 91    | N17   | R12   | 109   | 603                 |
| 115. | I/O             | -    | -     | -     | -     | 92    | R18   | L10   | 110   | 606                 |
| 116. | I/O             | -    | -     | 71    | 79    | 93    | T18   | P12   | 111   | 612                 |
| 117. | I/O             | -    | -     | 72    | 80    | 94    | P17   | M11   | 112   | 615                 |
| 118. | I/O             | 48   | 65    | 73    | 81    | 95    | N16   | R13   | 113   | 618                 |
| 119. | I/O             | 49   | 66    | 74    | 82    | 96    | T17   | N12   | 114   | 624                 |
| 120. | I/O             | -    | 67    | 75    | 83    | 97    | R17   | P13   | 115   | 627                 |
| 121. | I/O             | -    | 68    | 76    | 84    | 98    | P16   | K10   | 116   | 630                 |
| 122. | I/O             | 50   | 69    | 77    | 85    | 99    | U18   | R14   | 117   | 636                 |
| 123. | I/O             | 51   | 70    | 78    | 86    | 100   | T16   | N13   | 118   | 639                 |
|      | GND             | 52   | 71    | 79    | 87    | 101   | R16   | GND*  | 119   | -                   |
|      | DONE            | 53   | 72    | 80    | 88    | 103   | U17   | P14   | 120   | -                   |
|      | VCC             | 54   | 73    | 81    | 89    | 106   | R15   | VCC*  | 121   | -                   |
|      | PROG            | 55   | 74    | 82    | 90    | 108   | V18   | M12   | 122   | -                   |
| 124. | I/O (D7)        | 56   | 75    | 83    | 91    | 109   | T15   | P15   | 123   | 648                 |
| 125. | GCK3 (I/O)      | 57   | 76    | 84    | 92    | 110   | U16   | N14   | 124   | 651                 |
| 126. | I/O             | -    | 77    | 85    | 93    | 111   | T14   | L11   | 125   | 660                 |
| 127. | I/O             | -    | 78    | 86    | 94    | 112   | U15   | M13   | 126   | 663                 |
| 128. | I/O             | -    | -     | -     | -     | -     | R14   | N15   | 127   | 666                 |
| 129. | I/O             | -    | -     | -     | -     | -     | R13   | M14   | 128   | 672                 |
| 130. | I/O (D6)        | 58   | 79    | 87    | 95    | 113   | V17   | J10   | 129   | 675                 |
| 131. | I/O             | -    | 80    | 88    | 96    | 114   | V16   | L12   | 130   | 678                 |
| 132. | I/O             | -    | -     | 89    | 97    | 115   | T13   | M15   | 131   | 684                 |
| 133. | I/O             | -    | -     | 90    | 98    | 116   | U14   | L13   | 132   | 687                 |
| 134. | I/O             | -    | -     | -     | -     | 117   | V15   | L14   | 133   | 690                 |
| 135. | I/O             | -    | -     | -     | -     | 118   | V14   | K11   | 134   | 696                 |
|      | GND             | -    | 81    | 91    | 99    | 119   | T12   | GND*  | 135   | -                   |
| 136. | I/O             | -    | -     | -     | -     | -     | R12   | L15   | 136   | 699                 |

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



| Pin  | Description                | PC84 | TQ144 | PQ160 | TQ176 | PQ208 | PG223 | BG225 | PQ240 | Boundary Scan Order |
|------|----------------------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
| 137. | I/O                        | -    | -     | -     | -     | -     | R11   | K12   | 137   | 708                 |
| 138. | I/O                        | -    | 82    | 92    | 100   | 120   | U13   | K13   | 138   | 711                 |
| 139. | I/O                        | -    | 83    | 93    | 101   | 121   | V13   | K14   | 139   | 714                 |
|      | VCC                        | -    | -     | -     | -     | -     | -     | VCC*  | 140   | -                   |
| 140. | I/O (D5)                   | 59   | 84    | 94    | 102   | 122   | U12   | K15   | 141   | 720                 |
| 141. | I/O (CS0)                  | 60   | 85    | 95    | 103   | 123   | V12   | J12   | 142   | 723                 |
| 142. | I/O                        | -    | -     | -     | 104   | 124   | T11   | J13   | 144   | 726                 |
| 143. | I/O                        | -    | -     | -     | 105   | 125   | U11   | J14   | 145   | 732                 |
| 144. | I/O                        | -    | 86    | 96    | 106   | 126   | V11   | J15   | 146   | 735                 |
| 145. | I/O                        | -    | 87    | 97    | 107   | 127   | V10   | J11   | 147   | 738                 |
| 146. | I/O (D4)                   | 61   | 88    | 98    | 108   | 128   | U10   | H13   | 148   | 744                 |
| 147. | I/O                        | 62   | 89    | 99    | 109   | 129   | T10   | H14   | 149   | 747                 |
|      | VCC                        | 63   | 90    | 100   | 110   | 130   | R10   | VCC*  | 150   | -                   |
|      | GND                        | 64   | 91    | 101   | 111   | 131   | R9    | GND*  | 151   | -                   |
| 148. | I/O (D3)                   | 65   | 92    | 102   | 112   | 132   | T9    | H12   | 152   | 756                 |
| 149. | I/O (RS)                   | 66   | 93    | 103   | 113   | 133   | U9    | H11   | 153   | 759                 |
| 150. | I/O                        | -    | 94    | 104   | 114   | 134   | V9    | G14   | 154   | 768                 |
| 151. | I/O                        | -    | 95    | 105   | 115   | 135   | V8    | G15   | 155   | 771                 |
| 152. | I/O                        | -    | -     | -     | 116   | 136   | U8    | G13   | 156   | 780                 |
| 153. | I/O                        | -    | -     | -     | 117   | 137   | T8    | G12   | 157   | 783                 |
| 154. | I/O (D2)                   | 67   | 96    | 106   | 118   | 138   | V7    | G11   | 159   | 786                 |
| 155. | I/O                        | 68   | 97    | 107   | 119   | 139   | U7    | F15   | 160   | 792                 |
|      | VCC                        | -    | -     | -     | -     | -     | -     | VCC*  | 161   | -                   |
| 156. | I/O                        | -    | 98    | 108   | 120   | 140   | V6    | F14   | 162   | 795                 |
| 157. | I/O                        | -    | 99    | 109   | 121   | 141   | U6    | F13   | 163   | 798                 |
| 158. | I/O                        | -    | -     | -     | -     | -     | R8    | G10   | 164   | 804                 |
| 159. | I/O                        | -    | -     | -     | -     | -     | R7    | E15   | 165   | 807                 |
|      | GND                        | -    | 100   | 110   | 122   | 142   | T7    | GND*  | 166   | -                   |
| 160. | I/O                        | -    | -     | -     | -     | -     | R6    | E14   | 167   | 810                 |
| 161. | I/O                        | -    | -     | -     | -     | -     | R5    | F12   | 168   | 816                 |
| 162. | I/O                        | -    | -     | -     | -     | 143   | V5    | E13   | 169   | 819                 |
| 163. | I/O                        | -    | -     | -     | -     | 144   | V4    | D15   | 170   | 822                 |
| 164. | I/O                        | -    | -     | 111   | 123   | 145   | U5    | F11   | 171   | 828                 |
| 165. | I/O                        | -    | -     | 112   | 124   | 146   | T6    | D14   | 172   | 831                 |
| 166. | I/O (D1)                   | 69   | 101   | 113   | 125   | 147   | V3    | E12   | 173   | 834                 |
| 167. | I/O (RCLK-BUSY/RDY)        | 70   | 102   | 114   | 126   | 148   | V2    | C15   | 174   | 840                 |
| 168. | I/O                        | -    | 103   | 115   | 127   | 149   | U4    | D13   | 175   | 843                 |
| 169. | I/O                        | -    | 104   | 116   | 128   | 150   | T5    | C14   | 176   | 846                 |
| 170. | I/O (D0, DIN)              | 71   | 105   | 117   | 129   | 151   | U3    | F10   | 177   | 855                 |
| 171. | I/O (DOUT)                 | 72   | 106   | 118   | 130   | 152   | T4    | B15   | 178   | 858                 |
|      | CCLK                       | 73   | 107   | 119   | 131   | 153   | V1    | C13   | 179   | -                   |
|      | VCC                        | 74   | 108   | 120   | 132   | 154   | R4    | VCC*  | 180   | -                   |
| 172. | I/O (TDO)                  | 75   | 109   | 121   | 133   | 159   | U2    | A15   | 181   | -                   |
|      | GND                        | 76   | 110   | 122   | 134   | 160   | R3    | GND*  | 182   | -                   |
| 173. | I/O (A0, $\overline{WS}$ ) | 77   | 111   | 123   | 135   | 161   | T3    | A14   | 183   | 9                   |
| 174. | GCK4 (A1, I/O)             | 78   | 112   | 124   | 136   | 162   | U1    | B13   | 184   | 15                  |
| 175. | I/O                        | -    | 113   | 125   | 137   | 163   | P3    | E11   | 185   | 18                  |
| 176. | I/O                        | -    | 114   | 126   | 138   | 164   | R2    | C12   | 186   | 21                  |
| 177. | I/O (CS1, A2)              | 79   | 115   | 127   | 139   | 165   | T2    | A13   | 187   | 27                  |
| 178. | I/O (A3)                   | 80   | 116   | 128   | 140   | 166   | N3    | B12   | 188   | 30                  |
| 179. | I/O                        | -    | -     | -     | -     | -     | P4    | F9    | 189   | 33                  |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

| Pin  | Description | PC84 | TQ144 | PQ160 | TQ176 | PQ208 | PG223 | BG225 | PQ240 | Boundary Scan Order |
|------|-------------|------|-------|-------|-------|-------|-------|-------|-------|---------------------|
| 180. | I/O         | -    | -     | -     | -     | -     | N4    | D11   | 190   | 39                  |
| 181. | I/O         | -    | 117   | 129   | 141   | 167   | P2    | A12   | 191   | 42                  |
| 182. | I/O         | -    | -     | 130   | 142   | 168   | T1    | C11   | 192   | 45                  |
| 183. | I/O         | -    | -     | -     | -     | 169   | R1    | B11   | 193   | 51                  |
| 184. | I/O         | -    | -     | -     | -     | 170   | N2    | E10   | 194   | 54                  |
|      | -           | -    | -     | -     | -     | -     | -     | GND*  |       | -                   |
|      | GND         | -    | 118   | 131   | 143   | 171   | M3    | -     | 196   | -                   |
| 185. | I/O         | -    | 119   | 132   | 144   | 172   | P1    | A11   | 197   | 57                  |
| 186. | I/O         | -    | 120   | 133   | 145   | 173   | N1    | D10   | 198   | 66                  |
| 187. | I/O         | -    | -     | -     | -     | -     | M4    | C10   | 199   | 69                  |
| 188. | I/O         | -    | -     | -     | -     | -     | L4    | B10   | 200   | 75                  |
|      | VCC         | -    | -     | -     | -     | -     | -     | VCC*  | 201   | -                   |
| 189. | I/O (A4)    | 81   | 121   | 134   | 146   | 174   | M2    | A10   | 202   | 78                  |
| 190. | I/O (A5)    | 82   | 122   | 135   | 147   | 175   | M1    | D9    | 203   | 81                  |
| 191. | I/O         | -    | -     | -     | 148   | 176   | L3    | C9    | 205   | 87                  |
| 192. | I/O         | -    | -     | 136   | 149   | 177   | L2    | B9    | 206   | 90                  |
| 193. | I/O         | -    | 123   | 137   | 150   | 178   | L1    | A9    | 207   | 93                  |
| 194. | I/O         | -    | 124   | 138   | 151   | 179   | K1    | E9    | 208   | 99                  |
| 195. | I/O (A6)    | 83   | 125   | 139   | 152   | 180   | K2    | C8    | 209   | 102                 |
| 196. | I/O (A7)    | 84   | 126   | 140   | 153   | 181   | K3    | B8    | 210   | 105                 |
|      | GND         | 1    | 127   | 141   | 154   | 182   | K4    | GND*  | 211   | -                   |

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### Additional No Connect (N.C.) Connections for PQ208 and PQ240 Packages

| PQ208 |     |     |     |     | PQ240 |     |     |
|-------|-----|-----|-----|-----|-------|-----|-----|
| 1     | 53  | 105 | 157 | 208 | 22    | 143 | 219 |
| 3     | 54  | 107 | 158 |     | 37    | 158 |     |
| 51    | 102 | 155 | 206 |     | 83    | 195 |     |
| 52    | 104 | 156 | 207 |     | 98    | 204 |     |

**Notes:** \* Pins labeled VCC\* are internally bonded to a VCC plane within the BG225 package. The external pins are: B2, D8, H15, R8, B14, R1, H1, and R15.

Pins labeled GND\* are internally bonded to a ground plane within the BG225 package. The external pins are: A1, D12, G7, G9, H6, H8, H10, J8, K8, A8, F8, G8, H2, H7, H9, J7, J9, M8.

Boundary Scan Bit 0 = TDO.T

Boundary Scan Bit 1 = TDO.O

Boundary Scan Bit 1056 = BSCAN.UPD

### Pin Locations for XC5215 Devices

The following table may contain pinout information for unsupported device/package combinations. Please see the availability charts elsewhere in the XC5200 Series data sheet for availability information.

| Pin | Description | PQ160 | HQ208 | HQ240 | PG299 | BG225 | BG352 | Boundary Scan Order |
|-----|-------------|-------|-------|-------|-------|-------|-------|---------------------|
|     | VCC         | 142   | 183   | 212   | K1    | VCC*  | VCC*  | -                   |
| 1.  | I/O (A8)    | 143   | 184   | 213   | K2    | E8    | D14   | 138                 |
| 2.  | I/O (A9)    | 144   | 185   | 214   | K3    | B7    | C14   | 141                 |
| 3.  | I/O         | 145   | 186   | 215   | K5    | A7    | A15   | 147                 |
| 4.  | I/O         | 146   | 187   | 216   | K4    | C7    | B15   | 150                 |
| 5.  | I/O         | -     | 188   | 217   | J1    | D7    | C15   | 153                 |
| 6.  | I/O         | -     | 189   | 218   | J2    | E7    | D15   | 159                 |
| 7.  | I/O (A10)   | 147   | 190   | 220   | H1    | A6    | A16   | 162                 |

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



| Pin | Description     | PQ160 | HQ208 | HQ240 | PG299 | BG225 | BG352 | Boundary Scan Order |
|-----|-----------------|-------|-------|-------|-------|-------|-------|---------------------|
| 8.  | I/O (A11)       | 148   | 191   | 221   | J3    | B6    | B16   | 165                 |
| 9.  | I/O             | -     | -     | -     | H2    | -     | C17   | 171                 |
| 10. | I/O             | -     | -     | -     | G1    | -     | B18   | 174                 |
|     | VCC             | -     | -     | 222   | E1    | VCC*  | VCC*  | -                   |
| 11. | I/O             | -     | -     | 223   | H3    | C6    | C18   | 177                 |
| 12. | I/O             | -     | -     | 224   | G2    | F7    | D17   | 183                 |
| 13. | I/O             | 149   | 192   | 225   | H4    | A5    | A20   | 186                 |
| 14. | I/O             | 150   | 193   | 226   | F2    | B5    | B19   | 189                 |
|     | GND             | 151   | 194   | 227   | F1    | GND*  | GND*  | -                   |
| 15. | I/O             | -     | -     | -     | H5    | -     | C19   | 195                 |
| 16. | I/O             | -     | -     | -     | G3    | -     | D18   | 198                 |
| 17. | I/O             | -     | 195   | 228   | D1    | D6    | A21   | 201                 |
| 18. | I/O             | -     | 196   | 229   | G4    | C5    | B20   | 207                 |
| 19. | I/O             | 152   | 197   | 230   | E2    | A4    | C20   | 210                 |
| 20. | I/O             | 153   | 198   | 231   | F3    | E6    | B21   | 213                 |
| 21. | I/O (A12)       | 154   | 199   | 232   | G5    | B4    | B22   | 219                 |
| 22. | I/O (A13)       | 155   | 200   | 233   | C1    | D5    | C21   | 222                 |
| 23. | I/O             | -     | -     | -     | F4    | -     | D20   | 225                 |
| 24. | I/O             | -     | -     | -     | E3    | -     | A23   | 234                 |
| 25. | I/O             | -     | -     | 234   | D2    | A3    | D21   | 237                 |
| 26. | I/O             | -     | -     | 235   | C2    | C4    | C22   | 243                 |
| 27. | I/O             | 156   | 201   | 236   | F5    | B3    | B24   | 246                 |
| 28. | I/O             | 157   | 202   | 237   | E4    | F6    | C23   | 249                 |
| 29. | I/O (A14)       | 158   | 203   | 238   | D3    | A2    | D22   | 258                 |
| 30. | I/O (A15)       | 159   | 204   | 239   | C3    | C3    | C24   | 261                 |
|     | VCC             | 160   | 205   | 240   | A2    | VCC*  | VCC*  | -                   |
|     | GND             | 1     | 2     | 1     | B1    | GND*  | GND*  | -                   |
| 31. | GCK1 (A16, I/O) | 2     | 4     | 2     | D4    | D4    | D23   | 270                 |
| 32. | I/O (A17)       | 3     | 5     | 3     | B2    | B1    | C25   | 273                 |
| 33. | I/O             | 4     | 6     | 4     | B3    | C2    | D24   | 279                 |
| 34. | I/O             | 5     | 7     | 5     | E6    | E5    | E23   | 282                 |
| 35. | I/O (TDI)       | 6     | 8     | 6     | D5    | D3    | C26   | 285                 |
| 36. | I/O (TCK)       | 7     | 9     | 7     | C4    | C1    | E24   | 294                 |
| 37. | I/O             | -     | -     | -     | A3    | -     | F24   | 297                 |
| 38. | I/O             | -     | -     | -     | D6    | -     | E25   | 303                 |
| 39. | I/O             | 8     | 10    | 8     | E7    | D2    | D26   | 306                 |
| 40. | I/O             | 9     | 11    | 9     | B4    | G6    | G24   | 309                 |
| 41. | I/O             | -     | 12    | 10    | C5    | E4    | F25   | 315                 |
| 42. | I/O             | -     | 13    | 11    | A4    | D1    | F26   | 318                 |
| 43. | I/O             | -     | -     | 12    | D7    | E3    | H23   | 321                 |
| 44. | I/O             | -     | -     | 13    | C6    | E2    | H24   | 327                 |
| 45. | I/O             | -     | -     | -     | E8    | -     | G25   | 330                 |
| 46. | I/O             | -     | -     | -     | B5    | -     | G26   | 333                 |
|     | GND             | 10    | 14    | 14    | A5    | GND*  | GND*  | -                   |
| 47. | I/O             | 11    | 15    | 15    | B6    | F5    | J23   | 339                 |
| 48. | I/O             | 12    | 16    | 16    | D8    | E1    | J24   | 342                 |
| 49. | I/O (TMS)       | 13    | 17    | 17    | C7    | F4    | H25   | 345                 |
| 50. | I/O             | 14    | 18    | 18    | B7    | F3    | K23   | 351                 |
|     | VCC             | -     | -     | 19    | A6    | VCC*  | VCC*  | -                   |
| 51. | I/O             | -     | -     | 20    | C8    | F2    | L24   | 354                 |
| 52. | I/O             | -     | -     | 21    | E9    | F1    | K25   | 357                 |
| 53. | I/O             | -     | -     | -     | B8    | -     | L25   | 363                 |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

| Pin | Description | PQ160 | HQ208 | HQ240 | PG299 | BG225 | BG352 | Boundary Scan Order |
|-----|-------------|-------|-------|-------|-------|-------|-------|---------------------|
| 54. | I/O         | -     | -     | -     | A8    | -     | L26   | 366                 |
| 55. | I/O         | -     | 19    | 23    | C9    | G4    | M23   | 369                 |
| 56. | I/O         | -     | 20    | 24    | B9    | G3    | M24   | 375                 |
| 57. | I/O         | 15    | 21    | 25    | E10   | G2    | M25   | 378                 |
| 58. | I/O         | 16    | 22    | 26    | A9    | G1    | M26   | 381                 |
| 59. | I/O         | 17    | 23    | 27    | D10   | G5    | N24   | 390                 |
| 60. | I/O         | 18    | 24    | 28    | C10   | H3    | N25   | 393                 |
|     | GND         | 19    | 25    | 29    | A10   | GND*  | GND*  | -                   |
|     | VCC         | 20    | 26    | 30    | A11   | VCC*  | VCC*  | -                   |
| 61. | I/O         | 21    | 27    | 31    | B10   | H4    | N26   | 399                 |
| 62. | I/O         | 22    | 28    | 32    | B11   | H5    | P25   | 402                 |
| 63. | I/O         | 23    | 29    | 33    | C11   | J2    | P23   | 405                 |
| 64. | I/O         | 24    | 30    | 34    | E11   | J1    | P24   | 411                 |
| 65. | I/O         | -     | 31    | 35    | D11   | J3    | R26   | 414                 |
| 66. | I/O         | -     | 32    | 36    | A12   | J4    | R25   | 417                 |
| 67. | I/O         | -     | -     | -     | B12   | -     | R24   | 423                 |
| 68. | I/O         | -     | -     | -     | A13   | -     | R23   | 426                 |
| 69. | I/O         | -     | -     | 38    | E12   | J5    | T26   | 429                 |
| 70. | I/O         | -     | -     | 39    | B13   | K1    | T25   | 435                 |
|     | VCC         | -     | -     | 40    | A16   | VCC*  | VCC*  | -                   |
| 71. | I/O         | 25    | 33    | 41    | A14   | K2    | U24   | 438                 |
| 72. | I/O         | 26    | 34    | 42    | C13   | K3    | V25   | 441                 |
| 73. | I/O         | 27    | 35    | 43    | B14   | J6    | V24   | 447                 |
| 74. | I/O         | 28    | 36    | 44    | D13   | L1    | U23   | 450                 |
|     | GND         | 29    | 37    | 45    | A15   | GND*  | GND*  | -                   |
| 75. | I/O         | -     | -     | -     | B15   | -     | Y26   | 453                 |
| 76. | I/O         | -     | -     | -     | E13   | -     | W25   | 459                 |
| 77. | I/O         | -     | -     | 46    | C14   | L2    | W24   | 462                 |
| 78. | I/O         | -     | -     | 47    | A17   | K4    | V23   | 465                 |
| 79. | I/O         | -     | 38    | 48    | D14   | L3    | AA26  | 471                 |
| 80. | I/O         | -     | 39    | 49    | B16   | M1    | Y25   | 474                 |
| 81. | I/O         | 30    | 40    | 50    | C15   | K5    | Y24   | 477                 |
| 82. | I/O         | 31    | 41    | 51    | E14   | M2    | AA25  | 483                 |
| 83. | I/O         | -     | -     | -     | A18   | -     | AB25  | 486                 |
| 84. | I/O         | -     | -     | -     | D15   | -     | AA24  | 489                 |
| 85. | I/O         | 32    | 42    | 52    | C16   | L4    | Y23   | 495                 |
| 86. | I/O         | 33    | 43    | 53    | B17   | N1    | AC26  | 498                 |
| 87. | I/O         | 34    | 44    | 54    | B18   | M3    | AA23  | 501                 |
| 88. | I/O         | 35    | 45    | 55    | E15   | N2    | AB24  | 507                 |
| 89. | I/O         | 36    | 46    | 56    | D16   | K6    | AD25  | 510                 |
| 90. | I/O         | 37    | 47    | 57    | C17   | P1    | AC24  | 513                 |
| 91. | M1 (I/O)    | 38    | 48    | 58    | A20   | N3    | AB23  | 522                 |
|     | GND         | 39    | 49    | 59    | A19   | GND*  | GND*  | -                   |
| 92. | M0 (I/O)    | 40    | 50    | 60    | C18   | P2    | AD24  | 525                 |
|     | VCC         | 41    | 55    | 61    | B20   | VCC*  | VCC*  | -                   |
| 93. | M2 (I/O)    | 42    | 56    | 62    | D17   | M4    | AC23  | 528                 |
| 94. | GCK2 (I/O)  | 43    | 57    | 63    | B19   | R2    | AE24  | 531                 |
| 95. | I/O (HDC)   | 44    | 58    | 64    | C19   | P3    | AD23  | 540                 |
| 96. | I/O         | 45    | 59    | 65    | F16   | L5    | AC22  | 543                 |
| 97. | I/O         | 46    | 60    | 66    | E17   | N4    | AF24  | 546                 |
| 98. | I/O         | 47    | 61    | 67    | D18   | R3    | AD22  | 552                 |
| 99. | I/O (LDC)   | 48    | 62    | 68    | C20   | P4    | AE23  | 555                 |

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## XC5200 Series Field Programmable Gate Arrays



| Pin  | Description     | PQ160 | HQ208 | HQ240 | PG299 | BG225 | BG352 | Boundary Scan Order |
|------|-----------------|-------|-------|-------|-------|-------|-------|---------------------|
| 100. | I/O             | -     | -     | -     | F17   | -     | AE22  | 558                 |
| 101. | I/O             | -     | -     | -     | G16   | -     | AF23  | 564                 |
| 102. | I/O             | 49    | 63    | 69    | D19   | K7    | AD20  | 567                 |
| 103. | I/O             | 50    | 64    | 70    | E18   | M5    | AE21  | 570                 |
| 104. | I/O             | -     | 65    | 71    | D20   | R4    | AF21  | 576                 |
| 105. | I/O             | -     | 66    | 72    | G17   | N5    | AC19  | 579                 |
| 106. | I/O             | -     | -     | 73    | F18   | P5    | AD19  | 582                 |
| 107. | I/O             | -     | -     | 74    | H16   | L6    | AE20  | 588                 |
| 108. | I/O             | -     | -     | -     | E19   | -     | AF20  | 591                 |
| 109. | I/O             | -     | -     | -     | F19   | -     | AC18  | 594                 |
|      | GND             | 51    | 67    | 75    | E20   | GND*  | GND*  | -                   |
| 110. | I/O             | 52    | 68    | 76    | H17   | R5    | AD18  | 600                 |
| 111. | I/O             | 53    | 69    | 77    | G18   | M6    | AE19  | 603                 |
| 112. | I/O             | 54    | 70    | 78    | G19   | N6    | AC17  | 606                 |
| 113. | I/O             | 55    | 71    | 79    | H18   | P6    | AD17  | 612                 |
|      | VCC             | -     | -     | 80    | F20   | VCC*  | VCC*  | -                   |
| 114. | I/O             | -     | 72    | 81    | J16   | R6    | AE17  | 615                 |
| 115. | I/O             | -     | 73    | 82    | G20   | M7    | AE16  | 618                 |
| 116. | I/O             | -     | -     | -     | H20   | -     | AF16  | 624                 |
| 117. | I/O             | -     | -     | -     | J18   | -     | AC15  | 627                 |
| 118. | I/O             | -     | -     | 84    | J19   | N7    | AD15  | 630                 |
| 119. | I/O             | -     | -     | 85    | K16   | P7    | AE15  | 636                 |
| 120. | I/O             | 56    | 74    | 86    | J20   | R7    | AF15  | 639                 |
| 121. | I/O             | 57    | 75    | 87    | K17   | L7    | AD14  | 642                 |
| 122. | I/O             | 58    | 76    | 88    | K18   | N8    | AE14  | 648                 |
| 123. | I/O (ERR, INIT) | 59    | 77    | 89    | K19   | P8    | AF14  | 651                 |
|      | VCC             | 60    | 78    | 90    | L20   | VCC*  | VCC*  | -                   |
|      | GND             | 61    | 79    | 91    | K20   | GND*  | GND*  | -                   |
| 124. | I/O             | 62    | 80    | 92    | L19   | L8    | AE13  | 660                 |
| 125. | I/O             | 63    | 81    | 93    | L18   | P9    | AC13  | 663                 |
| 126. | I/O             | 64    | 82    | 94    | L16   | R9    | AD13  | 672                 |
| 127. | I/O             | 65    | 83    | 95    | L17   | N9    | AF12  | 675                 |
| 128. | I/O             | -     | 84    | 96    | M20   | M9    | AE12  | 678                 |
| 129. | I/O             | -     | 85    | 97    | M19   | L9    | AD12  | 684                 |
| 130. | I/O             | -     | -     | -     | N20   | -     | AC12  | 687                 |
| 131. | I/O             | -     | -     | -     | M18   | -     | AF11  | 690                 |
| 132. | I/O             | -     | -     | 99    | N19   | R10   | AE11  | 696                 |
| 133. | I/O             | -     | -     | 100   | P20   | P10   | AD11  | 699                 |
|      | VCC             | -     | -     | 101   | T20   | VCC*  | VCC*  | -                   |
| 134. | I/O             | 66    | 86    | 102   | N18   | N10   | AE9   | 702                 |
| 135. | I/O             | 67    | 87    | 103   | P19   | K9    | AD9   | 708                 |
| 136. | I/O             | 68    | 88    | 104   | N17   | R11   | AC10  | 711                 |
| 137. | I/O             | 69    | 89    | 105   | R19   | P11   | AF7   | 714                 |
|      | GND             | 70    | 90    | 106   | R20   | GND*  | GND*  | -                   |
| 138. | I/O             | -     | -     | -     | N16   | -     | AE8   | 720                 |
| 139. | I/O             | -     | -     | -     | P18   | -     | AD8   | 723                 |
| 140. | I/O             | -     | -     | 107   | U20   | M10   | AC9   | 726                 |
| 141. | I/O             | -     | -     | 108   | P17   | N11   | AF6   | 732                 |
| 142. | I/O             | -     | 91    | 109   | T19   | R12   | AE7   | 735                 |
| 143. | I/O             | -     | 92    | 110   | R18   | L10   | AD7   | 738                 |
| 144. | I/O             | 71    | 93    | 111   | P16   | P12   | AE6   | 744                 |
| 145. | I/O             | 72    | 94    | 112   | V20   | M11   | AE5   | 747                 |

# Product Obsolete or Under Obsolescence



## XC5200 Series Field Programmable Gate Arrays

| Pin  | Description | PQ160 | HQ208 | HQ240 | PG299 | BG225 | BG352 | Boundary Scan Order |
|------|-------------|-------|-------|-------|-------|-------|-------|---------------------|
| 146. | I/O         | -     | -     | -     | R17   | -     | AD6   | 750                 |
| 147. | I/O         | -     | -     | -     | T18   | -     | AC7   | 756                 |
| 148. | I/O         | 73    | 95    | 113   | U19   | R13   | AF4   | 759                 |
| 149. | I/O         | 74    | 96    | 114   | V19   | N12   | AF3   | 768                 |
| 150. | I/O         | 75    | 97    | 115   | R16   | P13   | AD5   | 771                 |
| 151. | I/O         | 76    | 98    | 116   | T17   | K10   | AE3   | 774                 |
| 152. | I/O         | 77    | 99    | 117   | U18   | R14   | AD4   | 780                 |
| 153. | I/O         | 78    | 100   | 118   | X20   | N13   | AC5   | 783                 |
|      | GND         | 79    | 101   | 119   | W20   | GND*  | GND*  | -                   |
|      | DONE        | 80    | 103   | 120   | V18   | P14   | AD3   | -                   |
|      | VCC         | 81    | 106   | 121   | X19   | VCC*  | VCC*  | -                   |
|      | PROG        | 82    | 108   | 122   | U17   | M12   | AC4   | -                   |
| 154. | I/O (D7)    | 83    | 109   | 123   | W19   | P15   | AD2   | 792                 |
| 155. | GCK3 (I/O)  | 84    | 110   | 124   | W18   | N14   | AC3   | 795                 |
| 156. | I/O         | 85    | 111   | 125   | T15   | L11   | AB4   | 804                 |
| 157. | I/O         | 86    | 112   | 126   | U16   | M13   | AD1   | 807                 |
| 158. | I/O         | -     | -     | 127   | V17   | N15   | AA4   | 810                 |
| 159. | I/O         | -     | -     | 128   | X18   | M14   | AA3   | 816                 |
| 160. | I/O         | -     | -     | -     | U15   | -     | AB2   | 819                 |
| 161. | I/O         | -     | -     | -     | T14   | -     | AC1   | 828                 |
| 162. | I/O (D6)    | 87    | 113   | 129   | W17   | J10   | Y3    | 831                 |
| 163. | I/O         | 88    | 114   | 130   | V16   | L12   | AA2   | 834                 |
| 164. | I/O         | 89    | 115   | 131   | X17   | M15   | AA1   | 840                 |
| 165. | I/O         | 90    | 116   | 132   | U14   | L13   | W4    | 843                 |
| 166. | I/O         | -     | 117   | 133   | V15   | L14   | W3    | 846                 |
| 167. | I/O         | -     | 118   | 134   | T13   | K11   | Y2    | 852                 |
| 168. | I/O         | -     | -     | -     | W16   | -     | Y1    | 855                 |
| 169. | I/O         | -     | -     | -     | W15   | -     | V4    | 858                 |
|      | GND         | 91    | 119   | 135   | X16   | GND*  | GND*  | -                   |
| 170. | I/O         | -     | -     | 136   | U13   | L15   | V3    | 864                 |
| 171. | I/O         | -     | -     | 137   | V14   | K12   | W2    | 867                 |
| 172. | I/O         | 92    | 120   | 138   | W14   | K13   | U4    | 870                 |
| 173. | I/O         | 93    | 121   | 139   | V13   | K14   | U3    | 876                 |
|      | VCC         | -     | -     | 140   | X15   | VCC*  | VCC*  | -                   |
| 174. | I/O (D5)    | 94    | 122   | 141   | T12   | K15   | V2    | 879                 |
| 175. | I/O (CS0)   | 95    | 123   | 142   | X14   | J12   | V1    | 882                 |
| 176. | I/O         | -     | -     | -     | X13   | -     | T1    | 888                 |
| 177. | I/O         | -     | -     | -     | V12   | -     | R4    | 891                 |
| 178. | I/O         | -     | 124   | 144   | W12   | J13   | R3    | 894                 |
| 179. | I/O         | -     | 125   | 145   | T11   | J14   | R2    | 900                 |
| 180. | I/O         | 96    | 126   | 146   | X12   | J15   | R1    | 903                 |
| 181. | I/O         | 97    | 127   | 147   | U11   | J11   | P3    | 906                 |
| 182. | I/O (D4)    | 98    | 128   | 148   | V11   | H13   | P2    | 912                 |
| 183. | I/O         | 99    | 129   | 149   | W11   | H14   | P1    | 915                 |
|      | VCC         | 100   | 130   | 150   | X10   | VCC*  | VCC*  | -                   |
|      | GND         | 101   | 131   | 151   | X11   | GND*  | GND*  | -                   |
| 184. | I/O (D3)    | 102   | 132   | 152   | W10   | H12   | N2    | 924                 |
| 185. | I/O (RS)    | 103   | 133   | 153   | V10   | H11   | N4    | 927                 |
| 186. | I/O         | 104   | 134   | 154   | T10   | G14   | N3    | 936                 |
| 187. | I/O         | 105   | 135   | 155   | U10   | G15   | M1    | 939                 |
| 188. | I/O         | -     | 136   | 156   | X9    | G13   | M2    | 942                 |
| 189. | I/O         | -     | 137   | 157   | W9    | G12   | M3    | 948                 |

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## XC5200 Series Field Programmable Gate Arrays



| Pin  | Description         | PQ160 | HQ208 | HQ240 | PG299 | BG225 | BG352 | Boundary Scan Order |
|------|---------------------|-------|-------|-------|-------|-------|-------|---------------------|
| 190. | I/O                 | -     | -     | -     | X8    | -     | M4    | 951                 |
| 191. | I/O                 | -     | -     | -     | V9    | -     | L1    | 954                 |
| 192. | I/O (D2)            | 106   | 138   | 159   | W8    | G11   | J1    | 960                 |
| 193. | I/O                 | 107   | 139   | 160   | X7    | F15   | K3    | 963                 |
|      | VCC                 | -     | -     | 161   | X5    | VCC*  | VCC*  |                     |
| 194. | I/O                 | 108   | 140   | 162   | V8    | F14   | J2    | 966                 |
| 195. | I/O                 | 109   | 141   | 163   | W7    | F13   | J3    | 972                 |
| 196. | I/O                 | -     | -     | 164   | U8    | G10   | K4    | 975                 |
| 197. | I/O                 | -     | -     | 165   | W6    | E15   | G1    | 978                 |
|      | GND                 | 110   | 142   | 166   | X6    | GND*  | GND*  |                     |
| 198. | I/O                 | -     | -     | -     | T8    | -     | H2    | 984                 |
| 199. | I/O                 | -     | -     | -     | V7    | -     | H3    | 987                 |
| 200. | I/O                 | -     | -     | 167   | X4    | E14   | J4    | 990                 |
| 201. | I/O                 | -     | -     | 168   | U7    | F12   | F1    | 996                 |
| 202. | I/O                 | -     | 143   | 169   | W5    | E13   | G2    | 999                 |
| 203. | I/O                 | -     | 144   | 170   | V6    | D15   | G3    | 1002                |
| 204. | I/O                 | 111   | 145   | 171   | T7    | F11   | F2    | 1008                |
| 205. | I/O                 | 112   | 146   | 172   | X3    | D14   | E2    | 1011                |
| 206. | I/O (D1)            | 113   | 147   | 173   | U6    | E12   | F3    | 1014                |
| 207. | I/O (RCLK-BUSY/RDY) | 114   | 148   | 174   | V5    | C15   | G4    | 1020                |
| 208. | I/O                 | -     | -     | -     | W4    | -     | D2    | 1023                |
| 209. | I/O                 | -     | -     | -     | W3    | -     | F4    | 1032                |
| 210. | I/O                 | 115   | 149   | 175   | T6    | D13   | E3    | 1035                |
| 211. | I/O                 | 116   | 150   | 176   | U5    | C14   | C2    | 1038                |
| 212. | I/O (D0, DIN)       | 117   | 151   | 177   | V4    | F10   | D3    | 1044                |
| 213. | I/O (DOUT)          | 118   | 152   | 178   | X1    | B15   | E4    | 1047                |
|      | CCLK                | 119   | 153   | 179   | V3    | C13   | C3    | -                   |
|      | VCC                 | 120   | 154   | 180   | W1    | VCC*  | VCC*  | -                   |
| 214. | I/O (TDO)           | 121   | 159   | 181   | U4    | A15   | D4    | 0                   |
|      | GND                 | 122   | 160   | 182   | X2    | GND*  | GND*  | -                   |
| 215. | I/O (A0, WS)        | 123   | 161   | 183   | W2    | A14   | B3    | 9                   |
| 216. | GCK4 (A1, I/O)      | 124   | 162   | 184   | V2    | B13   | C4    | 15                  |
| 217. | I/O                 | 125   | 163   | 185   | R5    | E11   | D5    | 18                  |
| 218. | I/O                 | 126   | 164   | 186   | T4    | C12   | A3    | 21                  |
| 219. | I/O (A2, CS1)       | 127   | 165   | 187   | U3    | A13   | D6    | 27                  |
| 220. | I/O (A3)            | 128   | 166   | 188   | V1    | B12   | C6    | 30                  |
| 221. | I/O                 | -     | -     | -     | R4    | -     | B5    | 33                  |
| 222. | I/O                 | -     | -     | -     | P5    | -     | A4    | 39                  |
| 223. | I/O                 | -     | -     | 189   | U2    | F9    | C7    | 42                  |
| 224. | I/O                 | -     | -     | 190   | T3    | D11   | B6    | 45                  |
| 225. | I/O                 | 129   | 167   | 191   | U1    | A12   | A6    | 51                  |
| 226. | I/O                 | 130   | 168   | 192   | P4    | C11   | D8    | 54                  |
| 227. | I/O                 | -     | 169   | 193   | R3    | B11   | B7    | 57                  |
| 228. | I/O                 | -     | 170   | 194   | N5    | E10   | A7    | 63                  |
| 229. | I/O                 | -     | -     | 195   | T2    | -     | D9    | 66                  |
| 230. | I/O                 | -     | -     | -     | R2    | -     | C9    | 69                  |
|      | GND                 | 131   | 171   | 196   | T1    | GND*  | GND*  | -                   |
| 231. | I/O                 | 132   | 172   | 197   | N4    | A11   | B8    | 75                  |
| 232. | I/O                 | 133   | 173   | 198   | P3    | D10   | D10   | 78                  |
| 233. | I/O                 | -     | -     | 199   | P2    | C10   | C10   | 81                  |
| 234. | I/O                 | -     | -     | 200   | N3    | B10   | B9    | 87                  |
|      | VCC                 | -     | -     | 201   | R1    | VCC*  | VCC*  | -                   |

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## XC5200 Series Field Programmable Gate Arrays

| Pin  | Description | PQ160 | HQ208 | HQ240 | PG299 | BG225 | BG352 | Boundary Scan Order |
|------|-------------|-------|-------|-------|-------|-------|-------|---------------------|
| 235. | I/O         | -     | -     | -     | M5    | -     | B11   | 90                  |
| 236. | I/O         | -     | -     | -     | P1    | -     | A11   | 93                  |
| 237. | I/O (A4)    | 134   | 174   | 202   | N1    | A10   | D12   | 99                  |
| 238. | I/O (A5)    | 135   | 175   | 203   | M3    | D9    | C12   | 102                 |
| 239. | I/O         | -     | 176   | 205   | M2    | C9    | B12   | 105                 |
| 240. | I/O         | 136   | 177   | 206   | L5    | B9    | A12   | 111                 |
| 241. | I/O         | 137   | 178   | 207   | M1    | A9    | C13   | 114                 |
| 242. | I/O         | 138   | 179   | 208   | L4    | E9    | B13   | 117                 |
| 243. | I/O (A6)    | 139   | 180   | 209   | L3    | C8    | A13   | 126                 |
| 244. | I/O (A7)    | 140   | 181   | 210   | L2    | B8    | B14   | 129                 |
|      | GND         | 141   | 182   | 211   | L1    | GND*  | GND*  | -                   |

### Additional No Connect (N.C.) Connections for HQ208 and HQ240 Packages

| HQ208 |     | HQ240 |
|-------|-----|-------|
| 206   | 102 | 219   |
| 207   | 104 | 22    |
| 208   | 105 | 37    |
| 1     | 107 | 83    |
| 3     | 155 | 98    |
| 51    | 156 | 143   |
| 52    | 157 | 158   |
| 53    | 158 | 204   |
| 54    | -   | -     |

**Notes:** \* Pins labeled VCC\* are internally bonded to a VCC plane within the BG225 and BG352 packages. The external pins for the BG225 are: B2, D8, H15, R8, B14, R1, H1, and R15. The external pins for the BG352 are: A10, A17, B2, B25, D13, D19, D7, G23, H4, K1, K26, N23, P4, U1, U26, W23, Y4, AC14, AC20, AC8, AE2, AE25, AF10, and AF17.  
Pins labeled GND\* are internally bonded to a ground plane within the BG225 and BG352 packages. The external pins for the BG225 are: A1, D12, G7, G9, H6, H8, H10, J8, K8, A8, F8, G8, H2, H7, H9, J7, J9, M8. The external pins for the BG352 are: A1, A2, A5, A8, A14, A19, A22, A25, A26, B1, B26, E1, E26, H1, H26, N1, P26, W1, W26, AB1, AB26, AE1, AE26, AF1, AF13, AF19, AF2, AF22, AF25, AF26, AF5, AF8.

Boundary Scan Bit 0 = TDO.T  
Boundary Scan Bit 1 = TDO.O  
Boundary Scan Bit 1056 = BSCAN.UPD

# Product Obsolete or Under Obsolescence

## XC5200 Series Field Programmable Gate Arrays



### Product Availability

|        | PINS | TYPE | CODE | 64          | 84          | 100         | 100         | 144         | 156        | 160         | 176         | 191        | 208            | 208         | 223        | 225        | 240            | 240         | 299        | 352        |
|--------|------|------|------|-------------|-------------|-------------|-------------|-------------|------------|-------------|-------------|------------|----------------|-------------|------------|------------|----------------|-------------|------------|------------|
|        |      |      |      | Plast. VQFP | Plast. PLCC | Plast. PQFP | Plast. VQFP | Plast. TQFP | Ceram. PGA | Plast. PQFP | Plast. TQFP | Ceram. PGA | High-Perf. QFP | Plast. PQFP | Ceram. PGA | Plast. BGA | High-Perf. QFP | Plast. PQFP | Ceram. PGA | Plast. BGA |
|        |      |      |      | VQ64*       | PC84        | PQ100       | VQ100       | TQ144       | PG156      | PQ160       | TQ176       | PG191      | HQ208          | PQ208       | PG223      | BG225      | HQ240          | PQ240       | PG299      | BG352      |
| XC5202 | -6   | CI   | CI   | CI          | CI          | CI          | CI          | CI          | CI         |             |             |            |                |             |            |            |                |             |            |            |
|        | -5   | CI   | CI   | CI          | CI          | CI          | CI          | CI          | CI         |             |             |            |                |             |            |            |                |             |            |            |
|        | -4   | C    | C    | C           | C           | C           | C           | C           | C          |             |             |            |                |             |            |            |                |             |            |            |
|        | -3   | C    | C    | C           | C           | C           | C           | C           | C          |             |             |            |                |             |            |            |                |             |            |            |
| XC5204 | -6   |      | CI   | CI          | CI          | CI          | CI          | CI          | CI         |             |             |            |                |             |            |            |                |             |            |            |
|        | -5   |      | CI   | CI          | CI          | CI          | CI          | CI          | CI         |             |             |            |                |             |            |            |                |             |            |            |
|        | -4   |      | C    | C           | C           | C           | C           | C           | C          |             |             |            |                |             |            |            |                |             |            |            |
|        | -3   |      | C    | C           | C           | C           | C           | C           | C          |             |             |            |                |             |            |            |                |             |            |            |
| XC5206 | -6   |      | CI   | CI          | CI          | CI          |             | CI          | CI         | CI          |             | CI         |                |             |            |            |                |             |            |            |
|        | -5   |      | CI   | CI          | CI          | CI          |             | CI          | CI         | CI          |             | CI         |                |             |            |            |                |             |            |            |
|        | -4   |      | C    | C           | C           | C           |             | C           | C          | C           |             | C          |                |             |            |            |                |             |            |            |
|        | -3   |      | C    | C           | C           | C           |             | C           | C          | C           |             | C          |                |             |            |            |                |             |            |            |
| XC5210 | -6   |      | CI   |             |             | CI          |             | CI          | CI         | CI          |             |            | CI             | CI          | CI         |            |                | CI          |            |            |
|        | -5   |      | CI   |             |             | CI          |             | CI          | CI         | CI          |             |            | CI             | CI          | CI         |            |                | CI          |            |            |
|        | -4   |      | C    |             |             | C           |             | C           | C          | C           |             |            | C              | C           | C          |            |                | C           |            |            |
|        | -3   |      | C    |             |             | C           |             | C           | C          | C           |             |            | C              | C           | C          |            |                | C           |            |            |
| XC5215 | -6   |      |      |             |             |             |             | CI          |            |             |             |            | CI             |             |            | CI         | CI             |             | CI         | CI         |
|        | -5   |      |      |             |             |             |             | C           |            |             |             |            | C              |             |            | C          | C              |             | C          | C          |
|        | -4   |      |      |             |             |             |             | C           |            |             |             |            | C              |             |            | C          | C              |             | C          | C          |
|        | -3   |      |      |             |             |             |             | C           |            |             |             |            | C              |             |            | C          | C              |             | C          | C          |

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C = Commercial  $T_J = 0^\circ$  to  $+85^\circ\text{C}$

I = Industrial  $T_J = -40^\circ\text{C}$  to  $+100^\circ\text{C}$

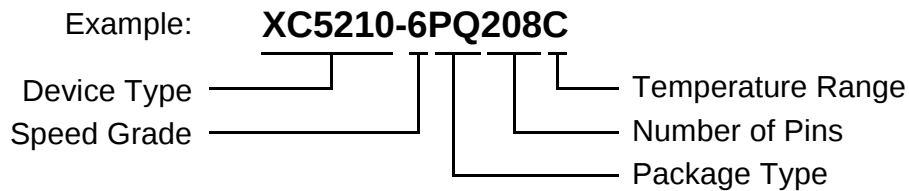
\* VQ64 package supports Master Serial, Slave Serial, and Express configuration modes only.

### User I/O Per Package

| Device | Max I/O | Package Type |      |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |  |
|--------|---------|--------------|------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|--|
|        |         | VQ64         | PC84 | PQ100 | VQ100 | TQ144 | PG156 | PQ160 | TQ176 | PG191 | HQ208 | PQ208 | PG223 | BG225 | HQ240 | PQ240 | PG299 | BG352 |  |
| XC5202 | 84      | 52           | 65   | 81    | 81    | 84    | 84    |       |       |       |       |       |       |       |       |       |       |       |  |
| XC5204 | 124     |              | 65   | 81    | 81    | 117   | 124   | 124   |       |       |       |       |       |       |       |       |       |       |  |
| XC5206 | 148     |              | 65   | 81    | 81    | 117   |       | 133   | 148   | 148   |       | 148   |       |       |       |       |       |       |  |
| XC5210 | 196     |              | 65   |       |       | 117   |       | 133   | 149   |       |       | 164   | 196   | 196   |       | 196   |       |       |  |
| XC5215 | 244     |              |      |       |       |       |       | 133   |       |       | 164   |       |       | 196   | 197   |       | 244   | 244   |  |

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### Ordering Information



# Product Obsolete or Under Obsolescence



## Revisions

| Version | Description                                               |
|---------|-----------------------------------------------------------|
| 12/97   | Rev 5.0 added -3, -4 specification                        |
| 7/98    | Rev 5.1 added Spartan family to comparison, removed HQ304 |
| 11/98   | Rev 5.2 All specifications made final.                    |



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.